

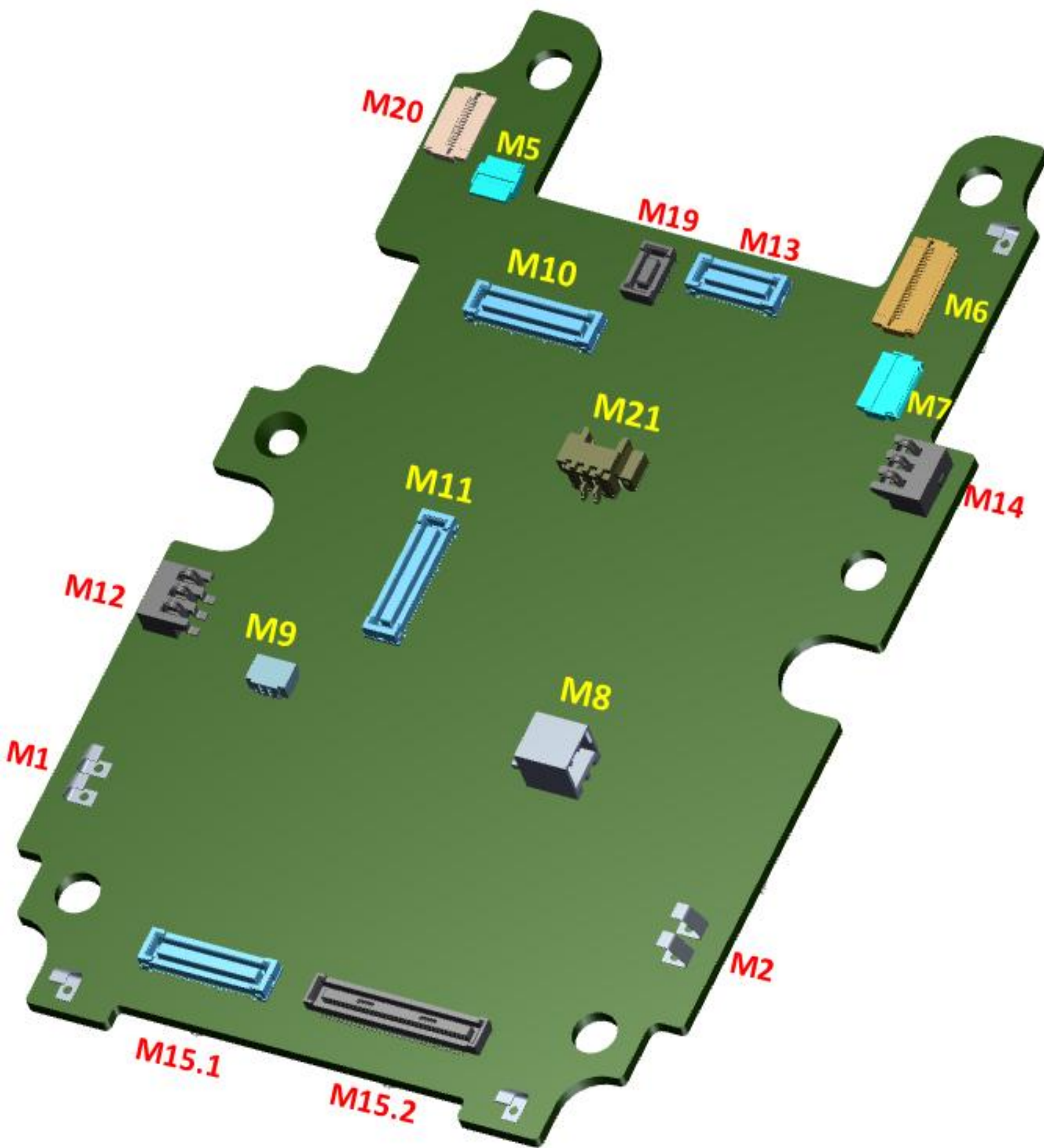
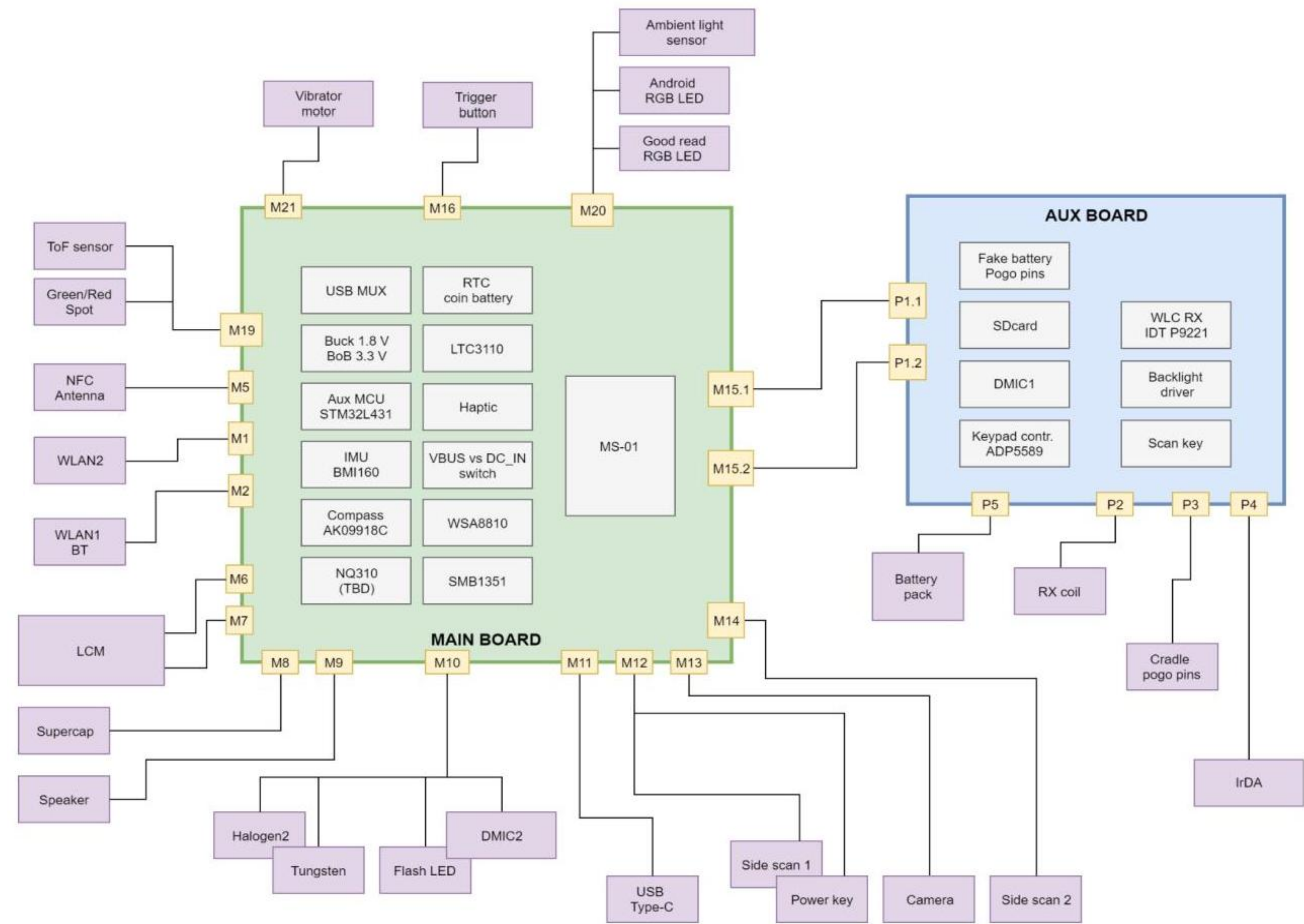
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## c

NEXT ASSY	USED ON

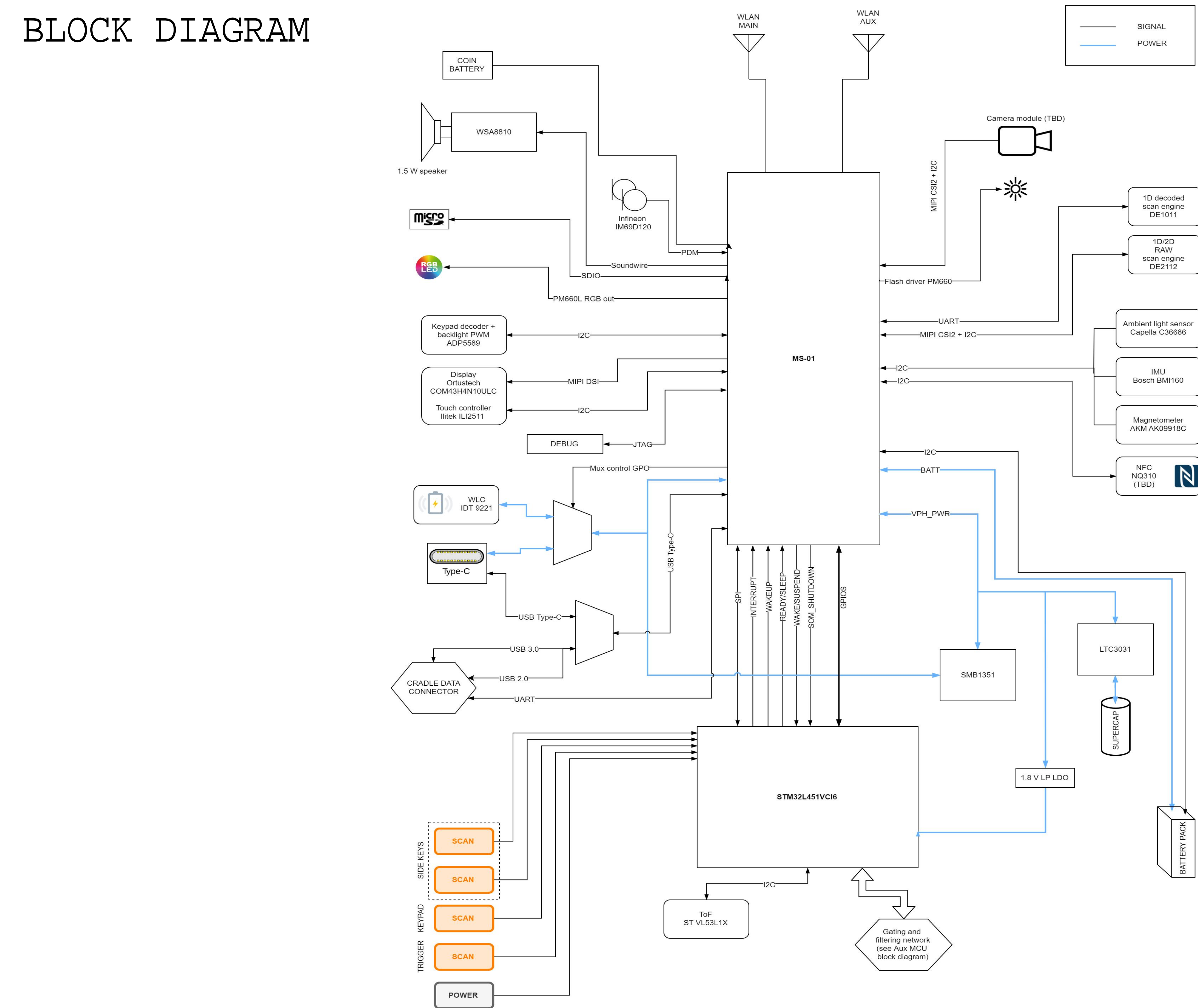
BOARD LEVEL BLOCK DIAGRAM

REVISIONS							
REV	ZONE	No.	DESCRIPTION			E.C.	BY
			SEE SHEET 1				
						APVD.	DATE





BLOCK DIAGRAM



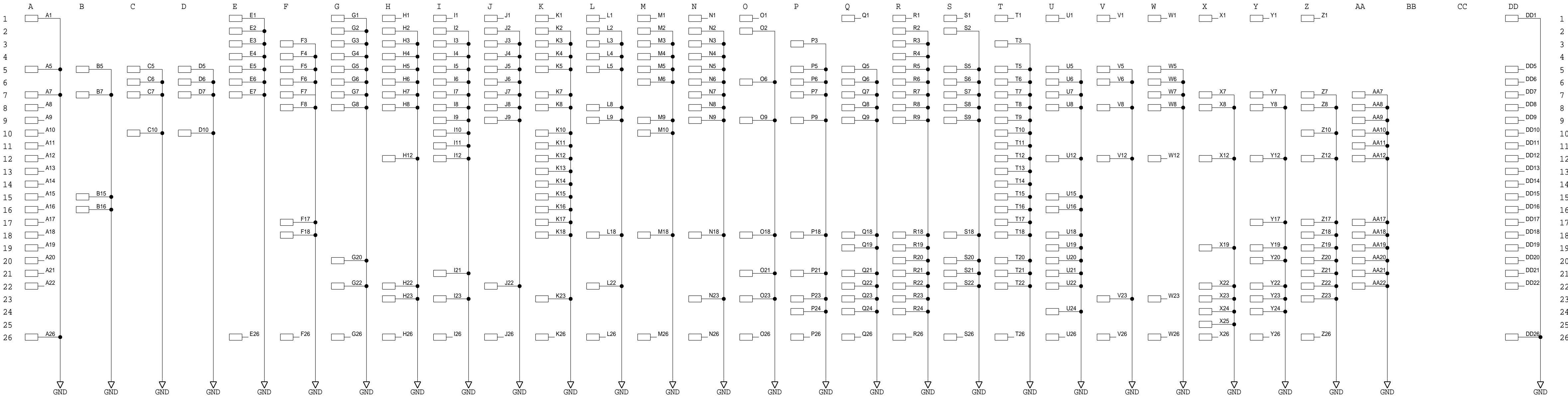
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SOM660 WAN MODULE GND AND DUMMY PAD

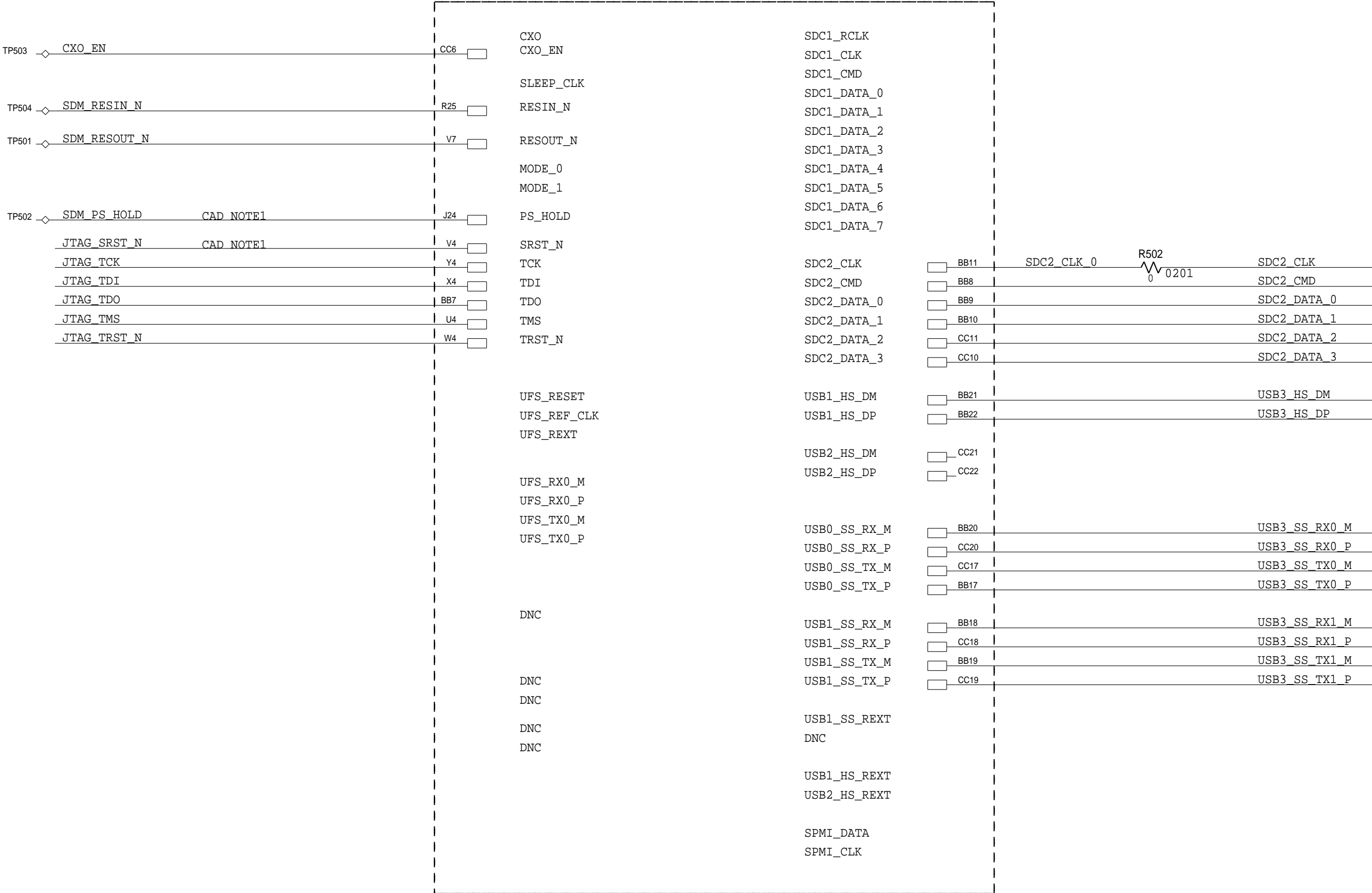
REVISIONS							
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U401  
DUMMY\_PAD  
GND

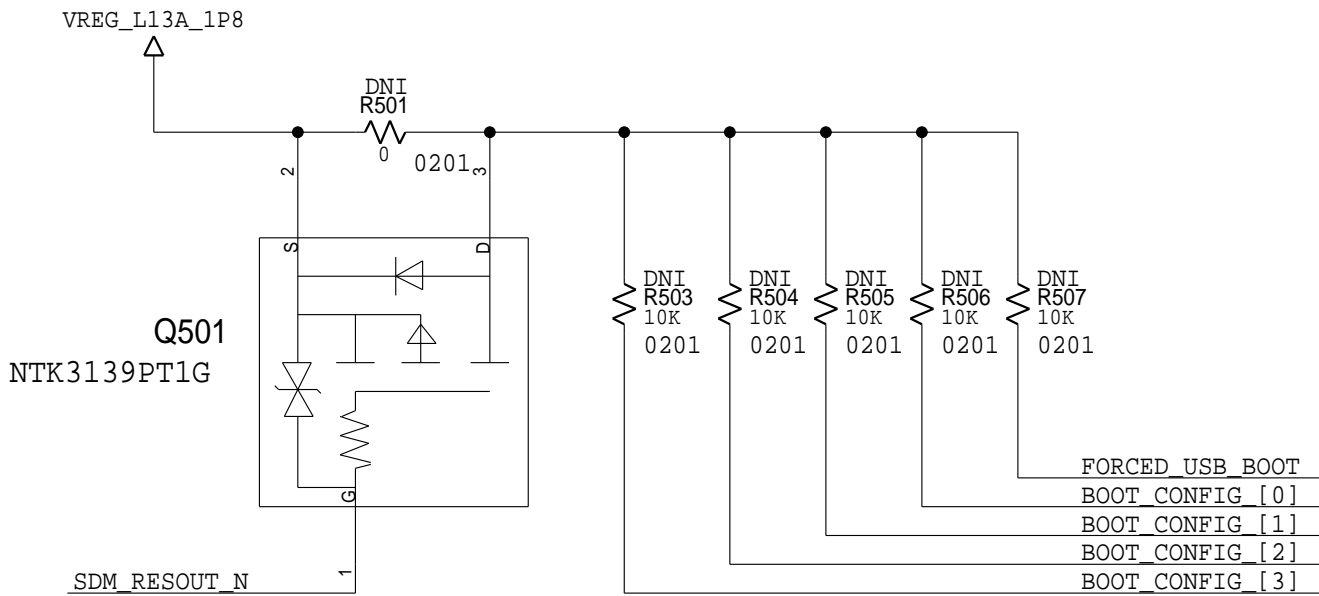


SDM660: CONTROL

REVISIONS							
REV	ZONE	No.	DESCRIPTION			E.C.	BY
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							DATE



BOOT CONFIG



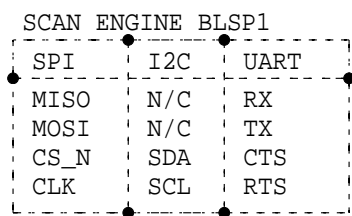
SOM GPIO\_57  
SOM GPIO\_96  
SOM GPIO\_97  
SOM GPIO\_98  
SOM GPIO\_60

FASTBOOT_SEL[3:0]	BOOT OPTIONS
0b0000	eMMC @SDC1 -> SD @SDC2 -> USB
0b0001	SD @SDC2 -> eMMC @SDC1
0b0010	SD @SDC2
0b0011	USB
0b0100	UFS HS-G1
0b0101	SD @SDC2 -> UFS

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SDM660: GPIOS

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			SEE SHEET 1			
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SCAN ENGINE  
SPI, I2C, UART

DEBUG UART

SMB&NFC&TOUCH I2C

BATTERY I2C

TOUCH I2C

BT/FM HCI UART

SMB1351 STATE

MCU SPI

WSA8810 SWR

AUX BOARD I2C

CRADLE UART

CAM\_MCLK

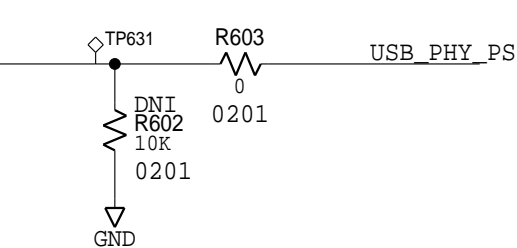
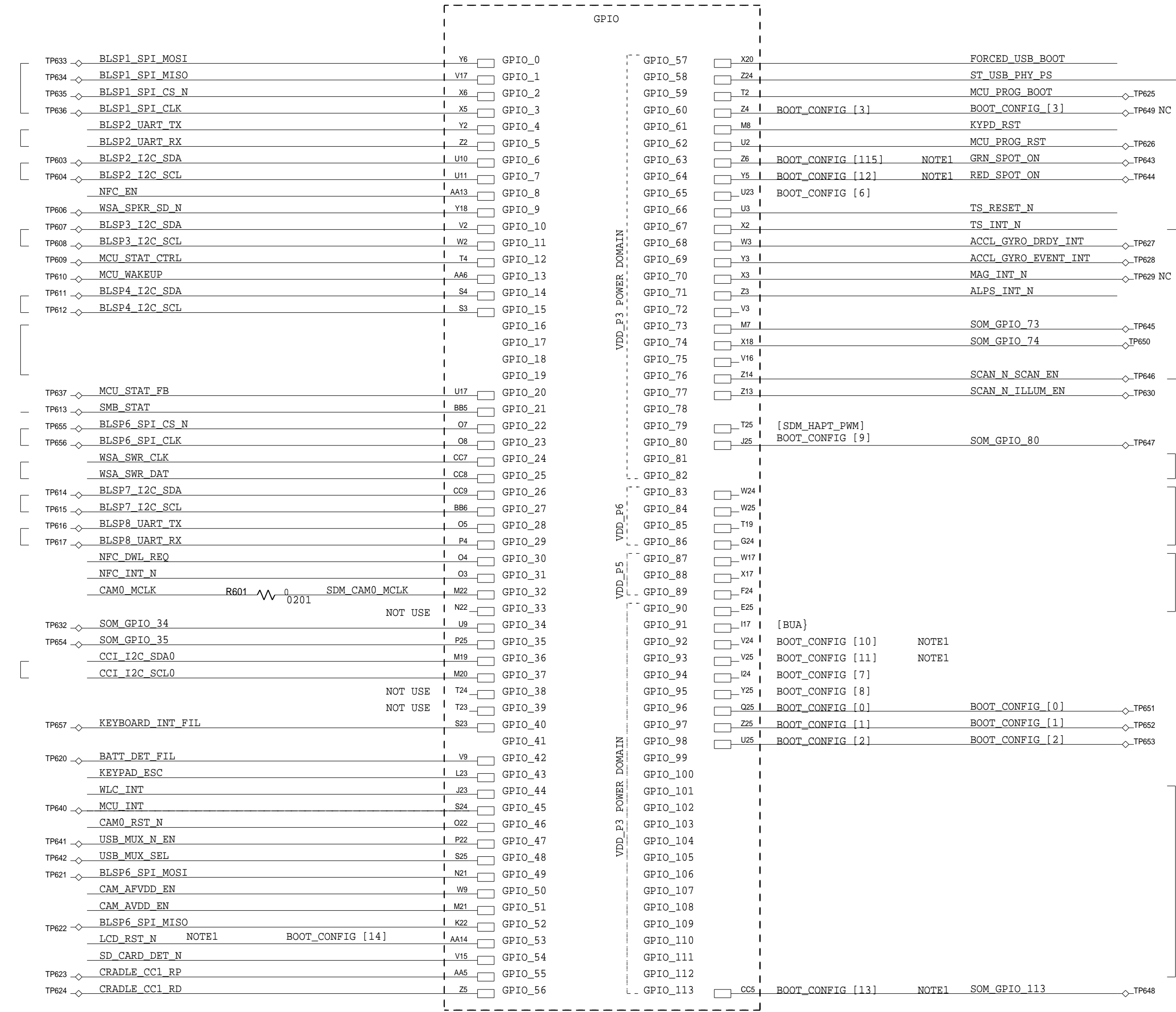
CAMERA I2C

SW NOTE:  
WLC\_INT  
DEFAULT PU OR NP

SW NOTE:  
MCU\_INT  
DEFAULT PU OR NP

MCU SPI

MCU SPI



SENSOR LOW POWER ISLAND (SLPI)  
SNAPDRAGON SENSORS CORE (SSC)

WCI UART

UIM2 NC IN SX5

UIM1 NC IN SX5

RPFE

RESISTOR	TYPE C	MICRO USB
R602	DNI	MOUNT
R603	MOUNT	DNI

NOTE1: ENSURE THAT THERE ARE NO EXTERNAL PULLS ON THE GPIOS (53, 63, 64, 92, 93,113)  
THE EXTERNAL PULLS CAN FORCE THE SDM DEVICE TO ENTER SECURE BOOT OR TO SELECT A DIFFERENT BOOT DEVICE.

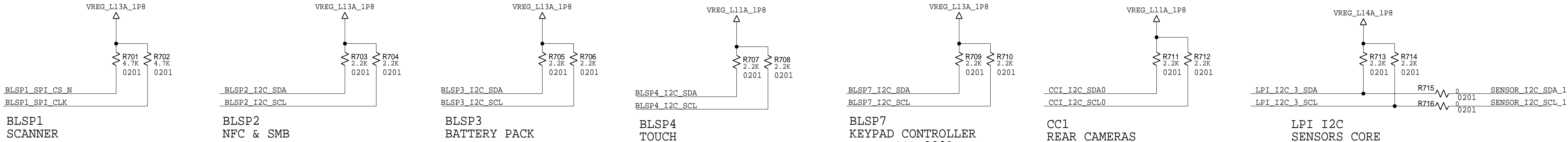
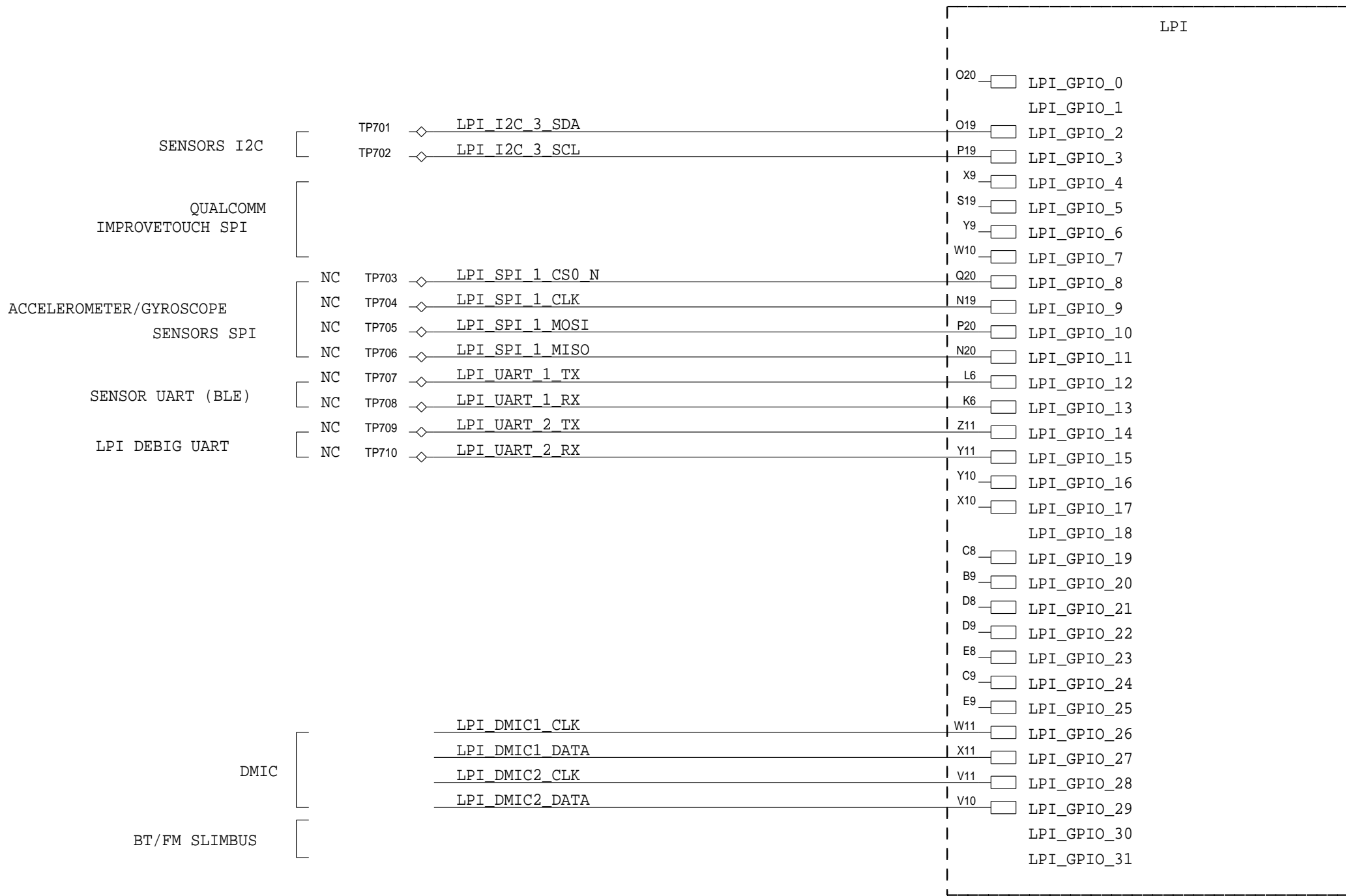
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D		V1D
Thu May 02 18:09:18 2019		SHEET 6 OF 45

SDM660: LPI GPIOs

REVISIONS						
REV	ZONE	/No.	DESCRIPTION		E.C.	BY
			SEE SHEET 1			
					APVD.	DATE



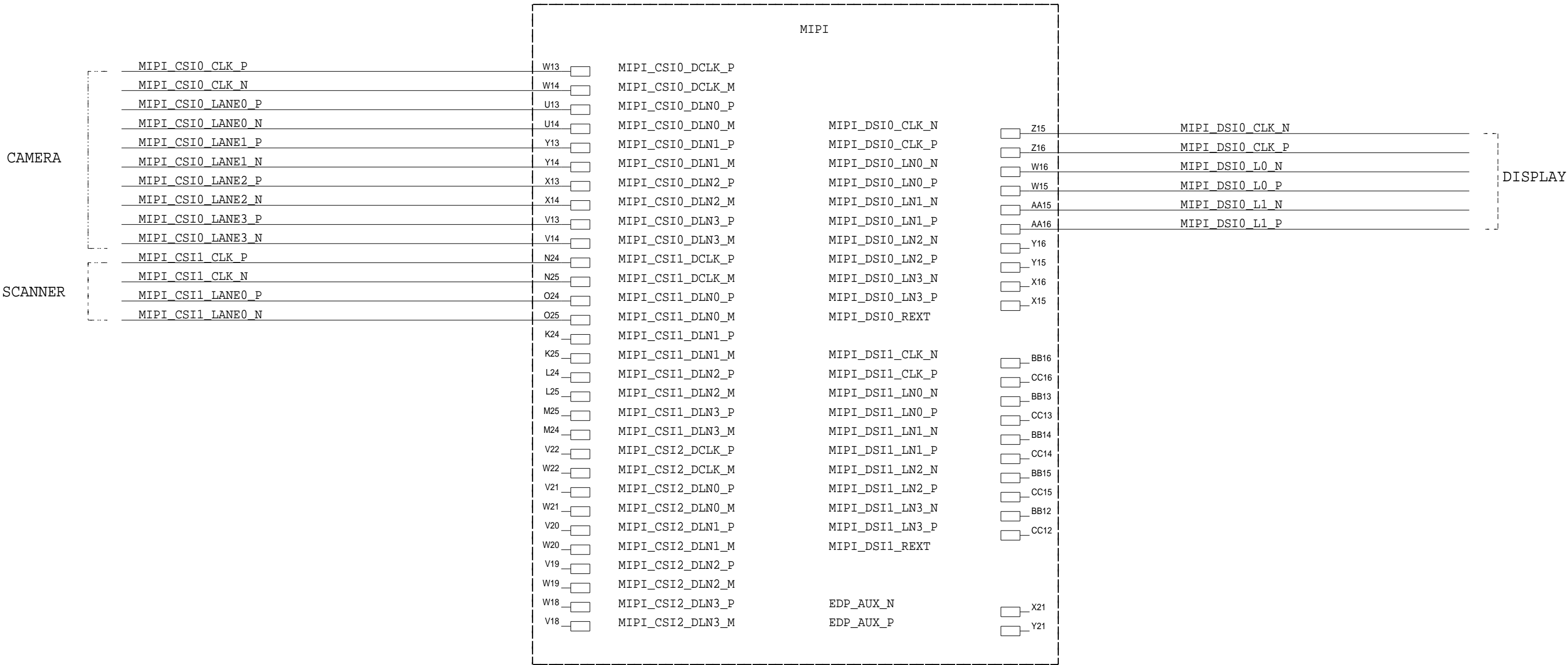
P9221 ADDRESS: 0X61  
ADP5589 0X34

ALS ADDRESS: 0X60  
GYRO ADDRESS: 0X68  
E-COMPASS ADDRESS: 0X0C

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SDM660: MIPI-CSI/DSI

REVISIONS							
REV	ZONE	△No.	DESCRIPTION			E.C.	BY
			SEE SHEET 1				APVD.
							DATE



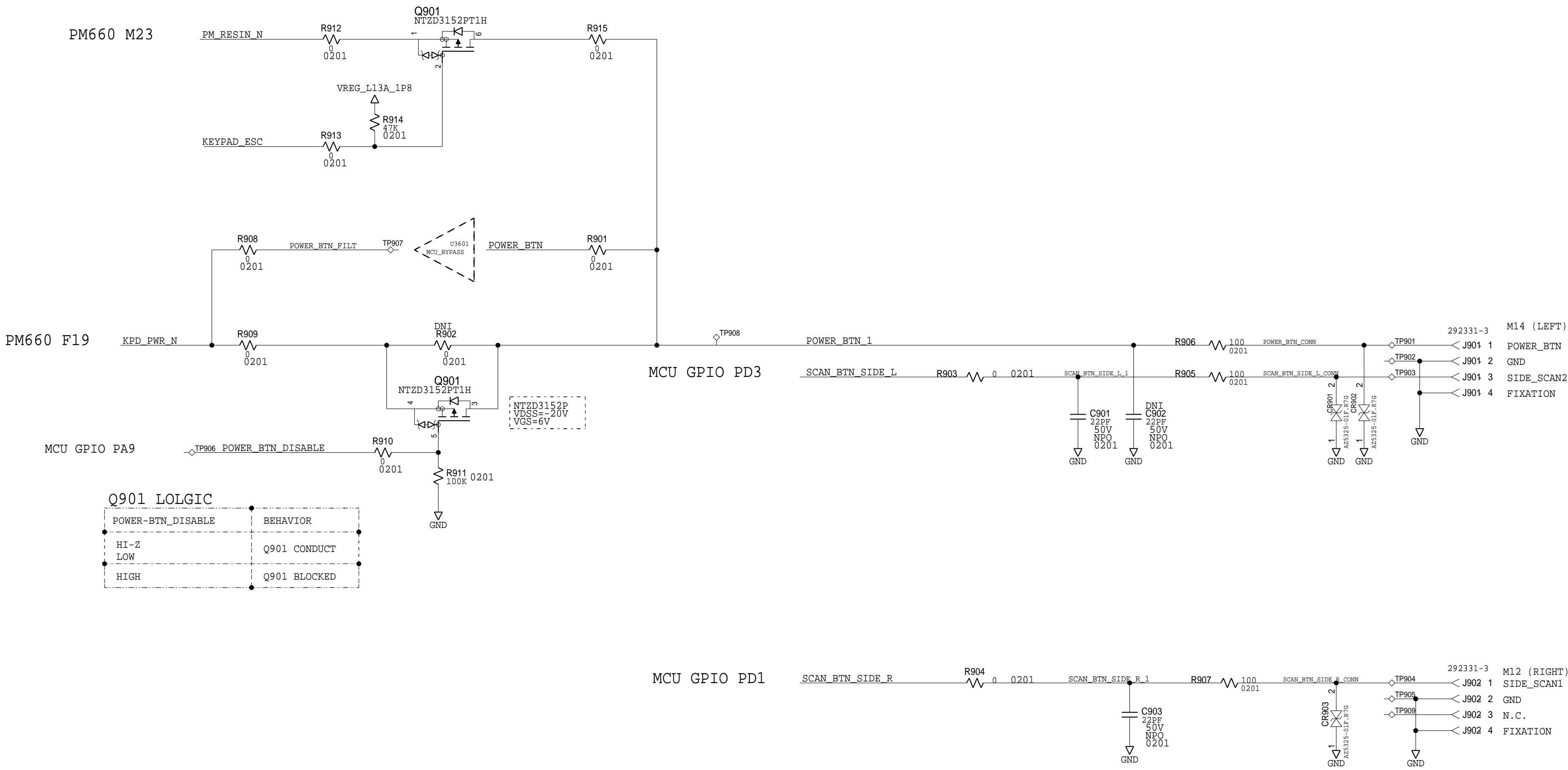
NOTE:IF BEST EMI PRACTICES ARE FOLLOWED FOR MIPI CSI/DSI SIGNALS, THERE IS NO NEED FOR COMMON MODE CHOKE FILTERS. YOU MAY CHOOSE TO HAVE PLACEHOLDERS FOR COMMON MODE DEPENDING UPON YOUR DESIGN CONSTRAINTS.

EXTREME CARE MUST BE TAKEN THAT NO STUBS ARE CREATED BY DOING SO.



SIDE KEY(M12,M14)

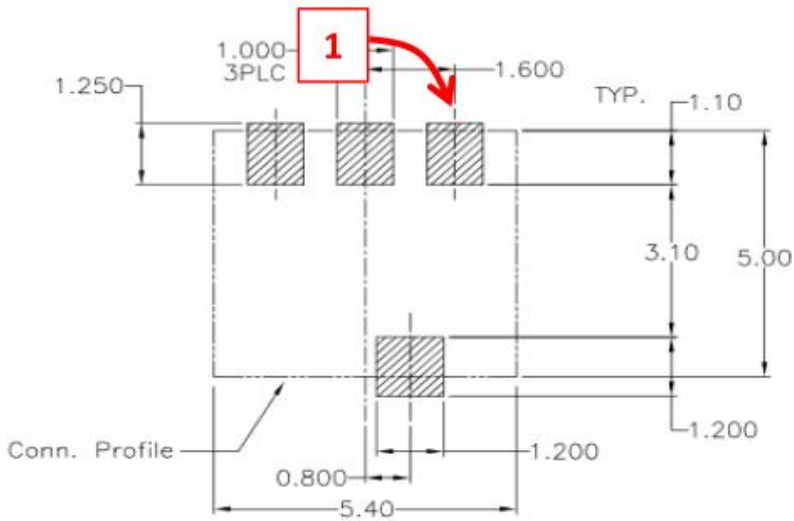
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REV	ZONE	No.	DESCRIPTION		E.C.	BY
			SEE SHEET 1			APVD.
						DATE




SIDE\_SCAN+PWR\_KEY

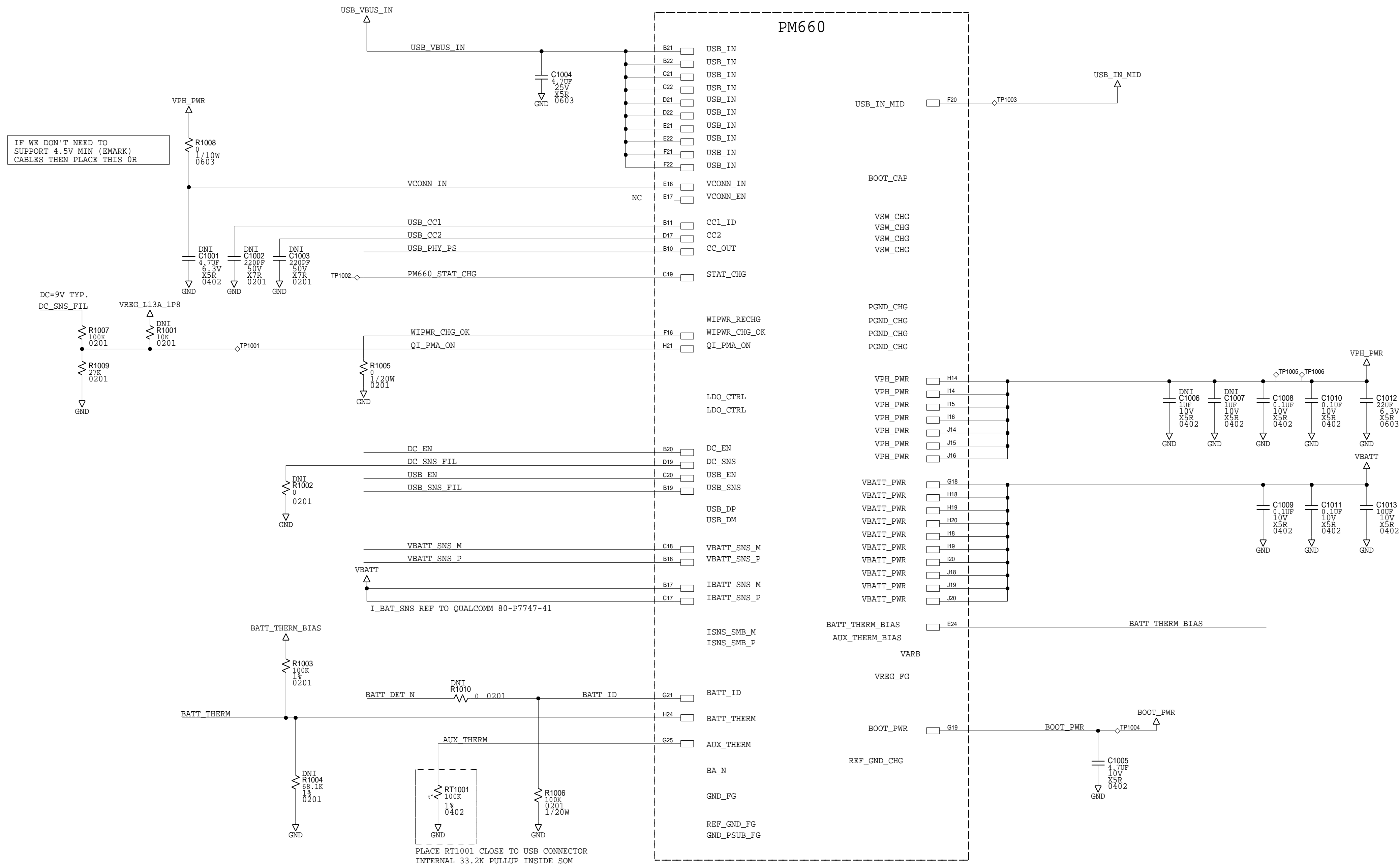


TE 292331-3



## PM660: CHARGER

REVISIONS							
REV	ZONE		DESCRIPTION	E.C.	BY	APVD.	DATE
			SEE SHEET 1				




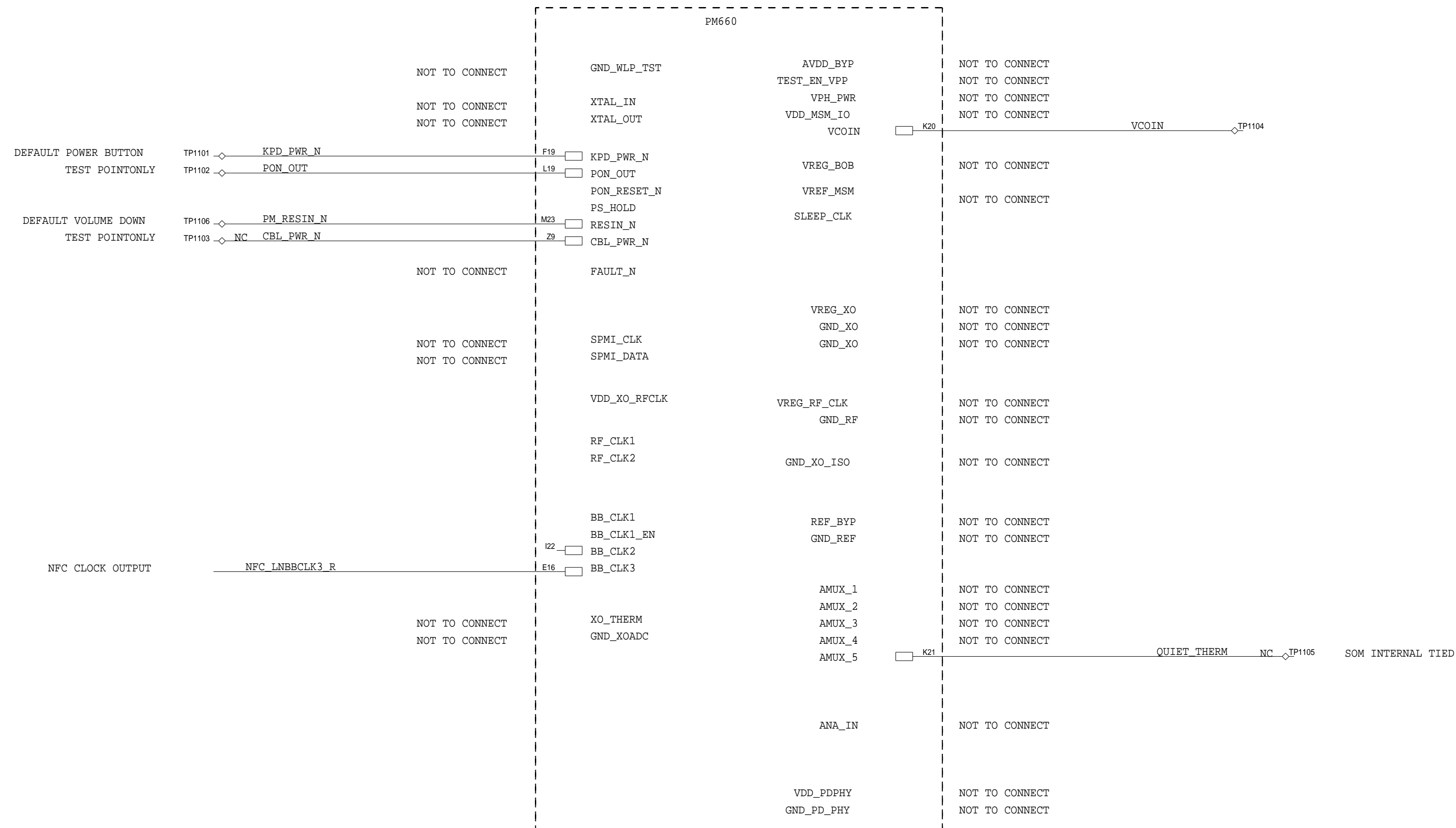
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## PM660: CONTROL/CLOCKS

REVISIONS							
REV	ZONE		DESCRIPTION	E.C.	BY	APVD.	DATE
			SEE SHEET 1				




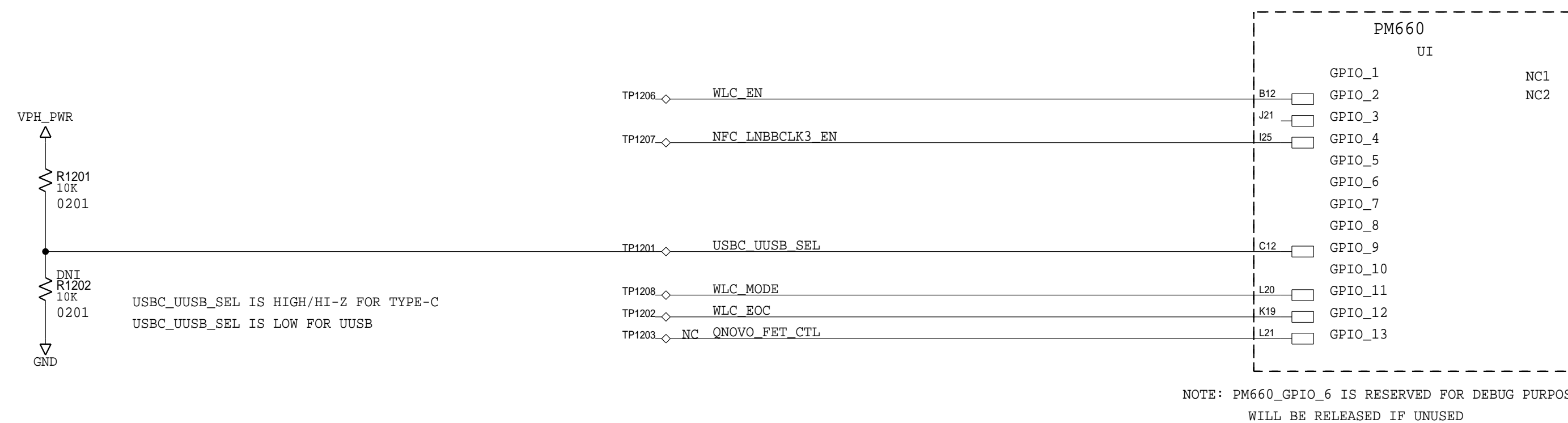
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SIZE D	DWG. NO.	REV V1D
Fri May 03 10:49:03 2019		SHEET 11 OF 45

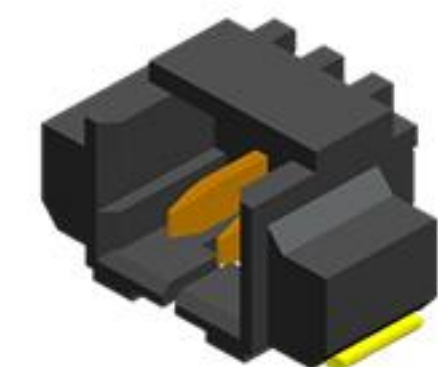
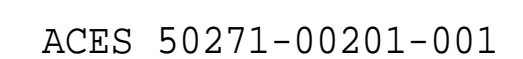
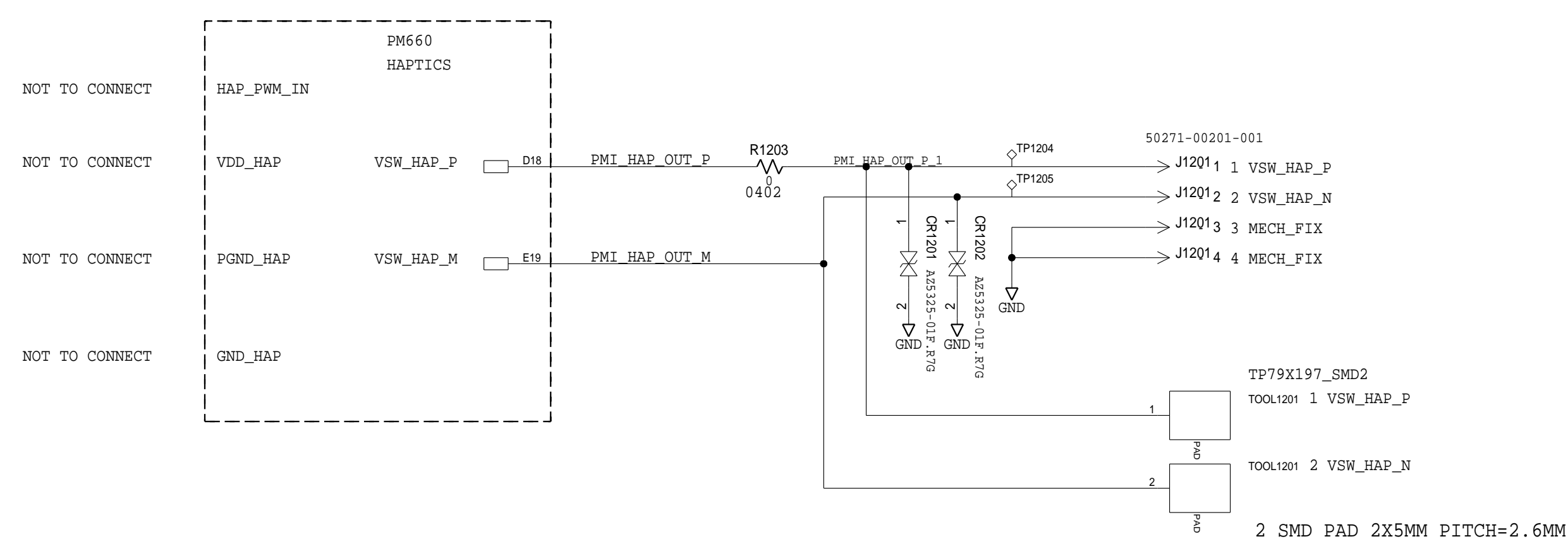
## PM660:GP I O S

REVISIONS							
REV	ZONE		DESCRIPTION	E.C.	BY	APVD.	DATE
			SEE SHEET 1				



PM660 GPIO Configuration For QRD660			
GPIO_1	OPTION1	GPIO_8	SLB
GPIO_2	DIV_CLK2	GPIO_9	uUSB_TYPEC
GPIO_3	DIV_CLK1	GPIO_10	WCSS_VCTRL
GPIO_4	NFC_CLK_REQ	GPIO_11	HOMEKEY_FP_PM_INT
GPIO_5	WLAN_SW_CTRL	GPIO_12	WIPWR_MODE
GPIO_6	SLEP_CLK	GPIO_13	PM_A_GPIO_13
GPIO_7	UIM_BATT_ALARM		

## PM660:HAPTICS(M21)



TP79X197\_SMD2

TOOL1201 1 VSW\_HAP\_P

TOOL1201 2 VSW\_HAP\_N

2 SMD PAD 2X5MM PITCH=2.6MM

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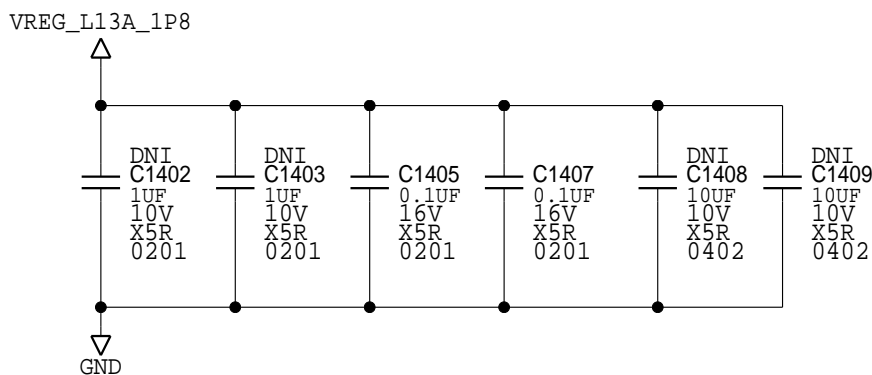
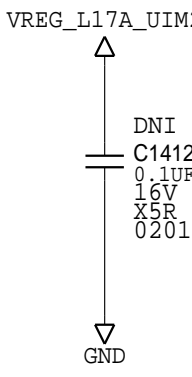
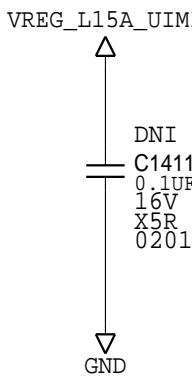
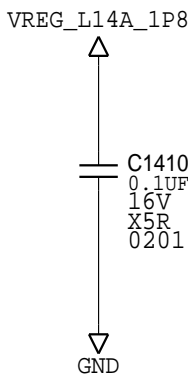
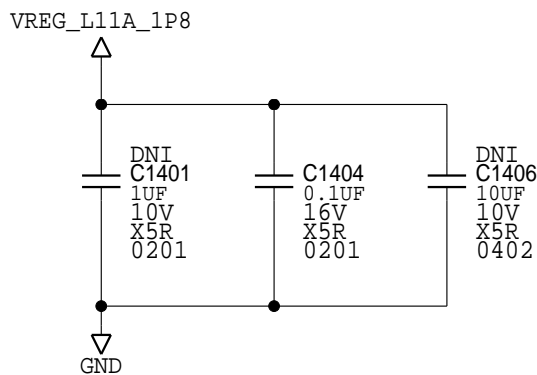
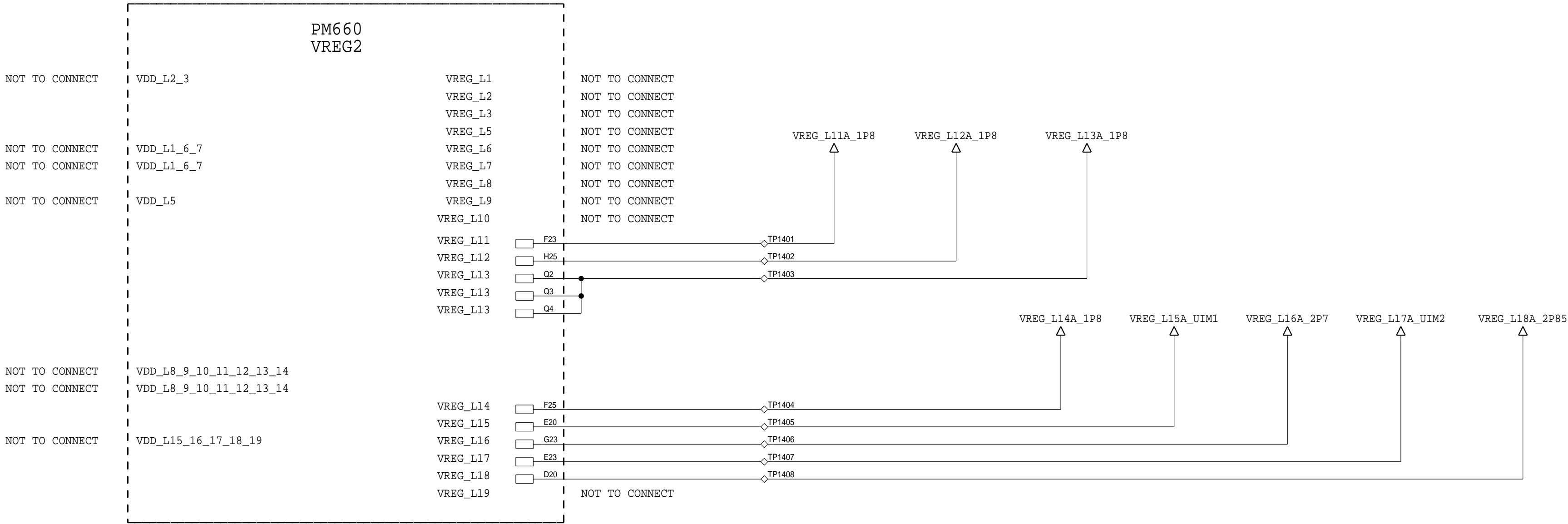
SIZE D	DWG. NO.	REV V1D
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PM660:LDO


REVISIONS							
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			SEE SHEET 1				APVD.
							DATE

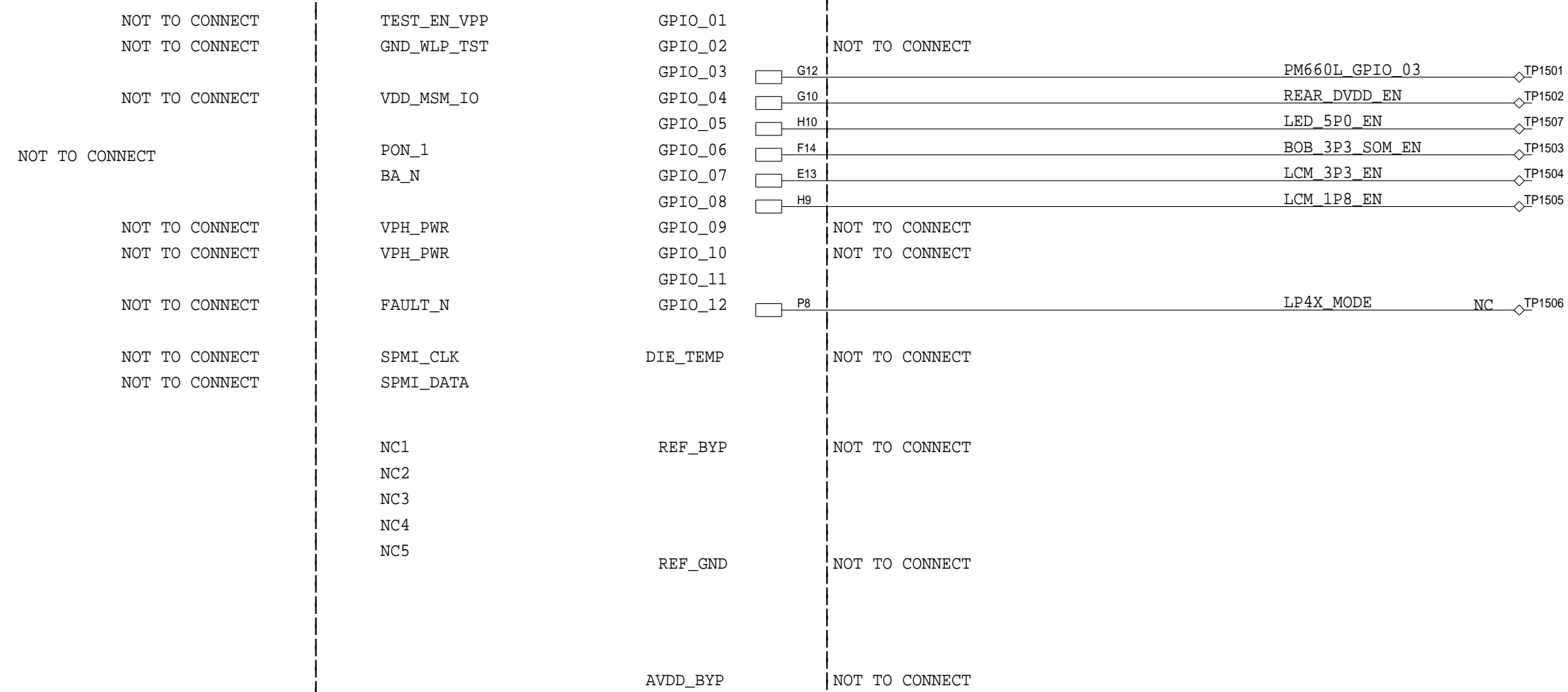


PSEUDO CAPLESS LDOS  
(LD08A , LD09A, LD011A , LD012A , LD014A , LD015A , LD016A , LD017A , LD018A , LD019A )

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PM660L:GPIOs

REVISIONS							
REV	ZONE		DESCRIPTION	E.C.	BY	APVD.	DATE
			SEE SHEET 1				



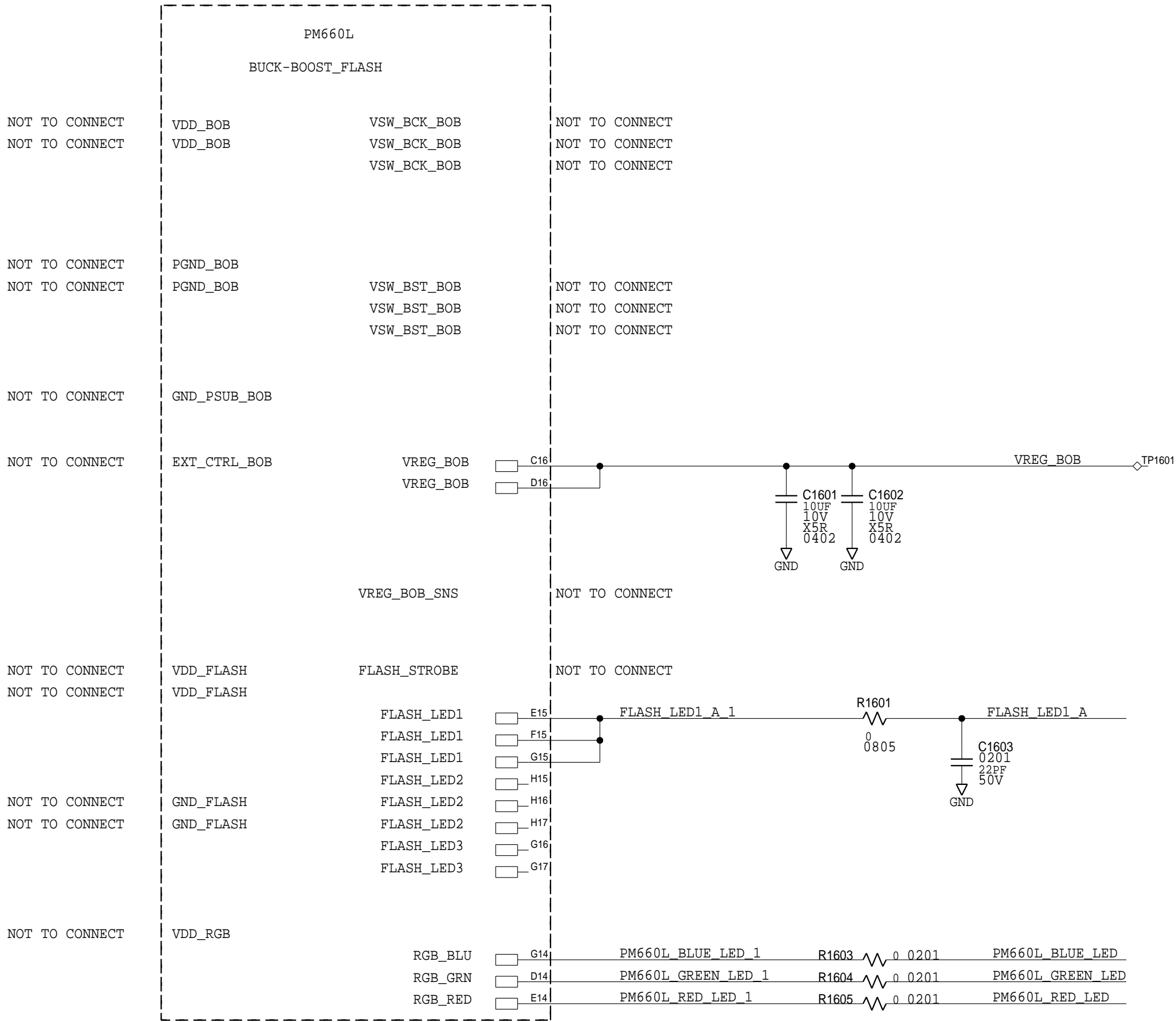
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SIZE D	DWG. NO.	REV V1D
Fri May 03 10:51:26 2019		SHEET 15 OF 45

PM660L:BOB\_FLASH

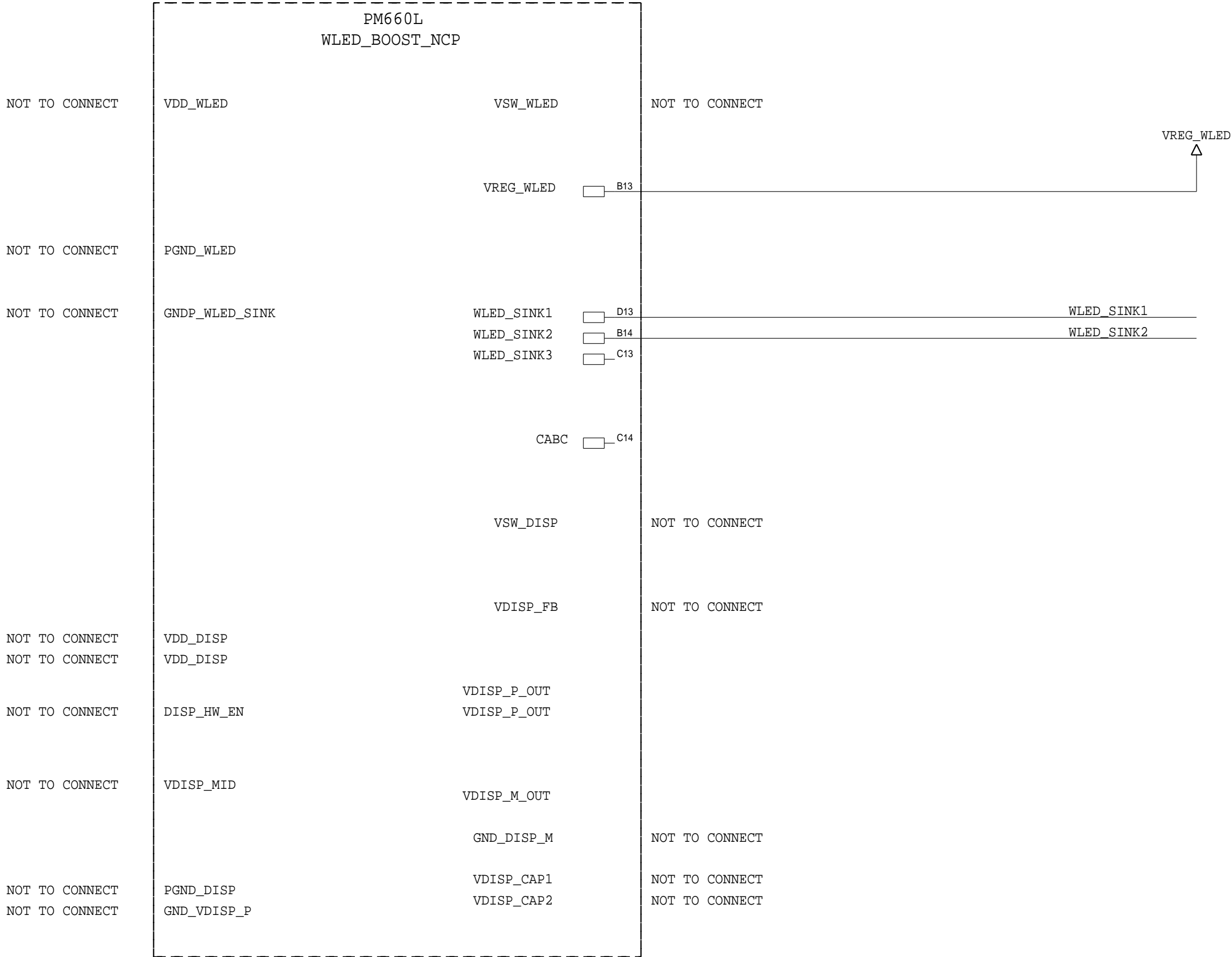
REVISIONS							
REV	ZONE	△No.	DESCRIPTION			E.C.	BY
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							DATE



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SIZE	DWG. NO.		REV
D			V1D
Fri May 03 10:51:47 2019		SHEET	16 OF 45

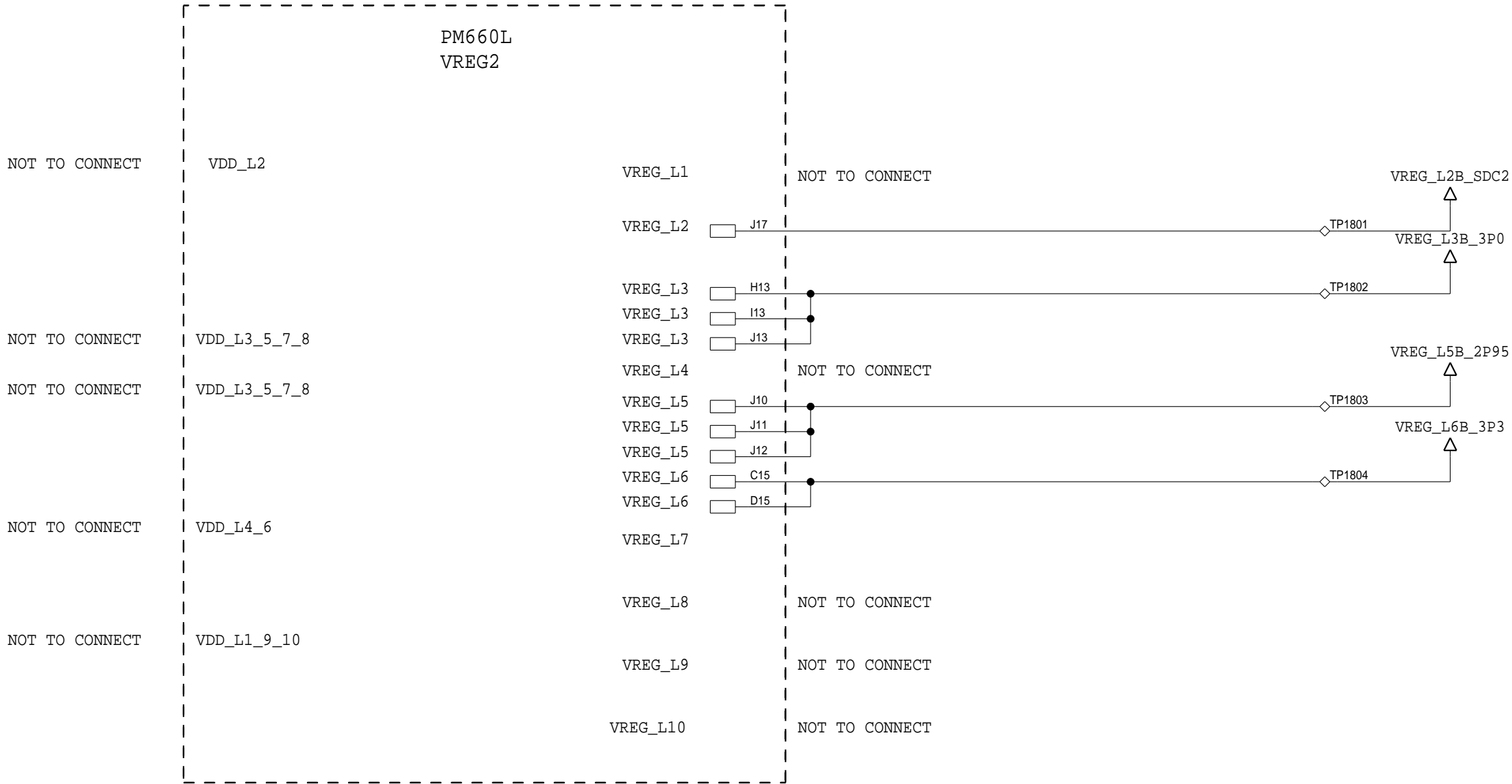
PM660L:WLED\_LAB/IBB

REVISIONS							
REV	ZONE	△No.	DESCRIPTION			E.C.	BY
			SEE SHEET 1				APVD.
							DATE



PM660L:LDOS

REVISIONS							
REV	ZONE	△No.	DESCRIPTION			E.C.	BY
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							DATE

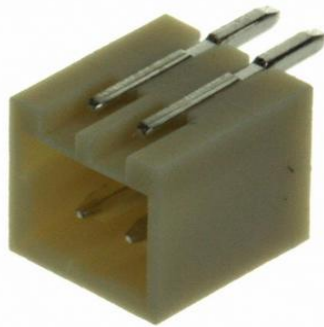


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SUPERCAP (M9)

REVISIONS						
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SUPERCAP CONN

5-1775444-2  
< J1901 1 SCAP\_POS

< J1901 2 SCAP\_NEG

V<sub>CAP</sub>=2.595V

$$V_{CAP} = 1.095V \cdot \left( 1 + \frac{R_{TOP}}{R_{BOT}} \right)$$

SCAP\_MODE  
HIGH=PWM MODE  
LOW=BURST MODE

SCAP\_RUN  
HIGH=RUN  
LOW=DISABLE

U1901  
LTC3110IUF#TRPBF

SGND TIE TOGETHER FIRST

CAP CHARGE CURRENT SETTING  
PLACE R1939 R1940 C1906 C1918 CLOSE TO IC U1901

BIT0	BIT1	IVSYS
HI-Z	HI-Z	0.2A
0	0	0.2A
0	1	1A
1	0	0.55A
1	1	1A


$$I_{VSYS} = \frac{3k\Omega}{R_{PROG}}$$

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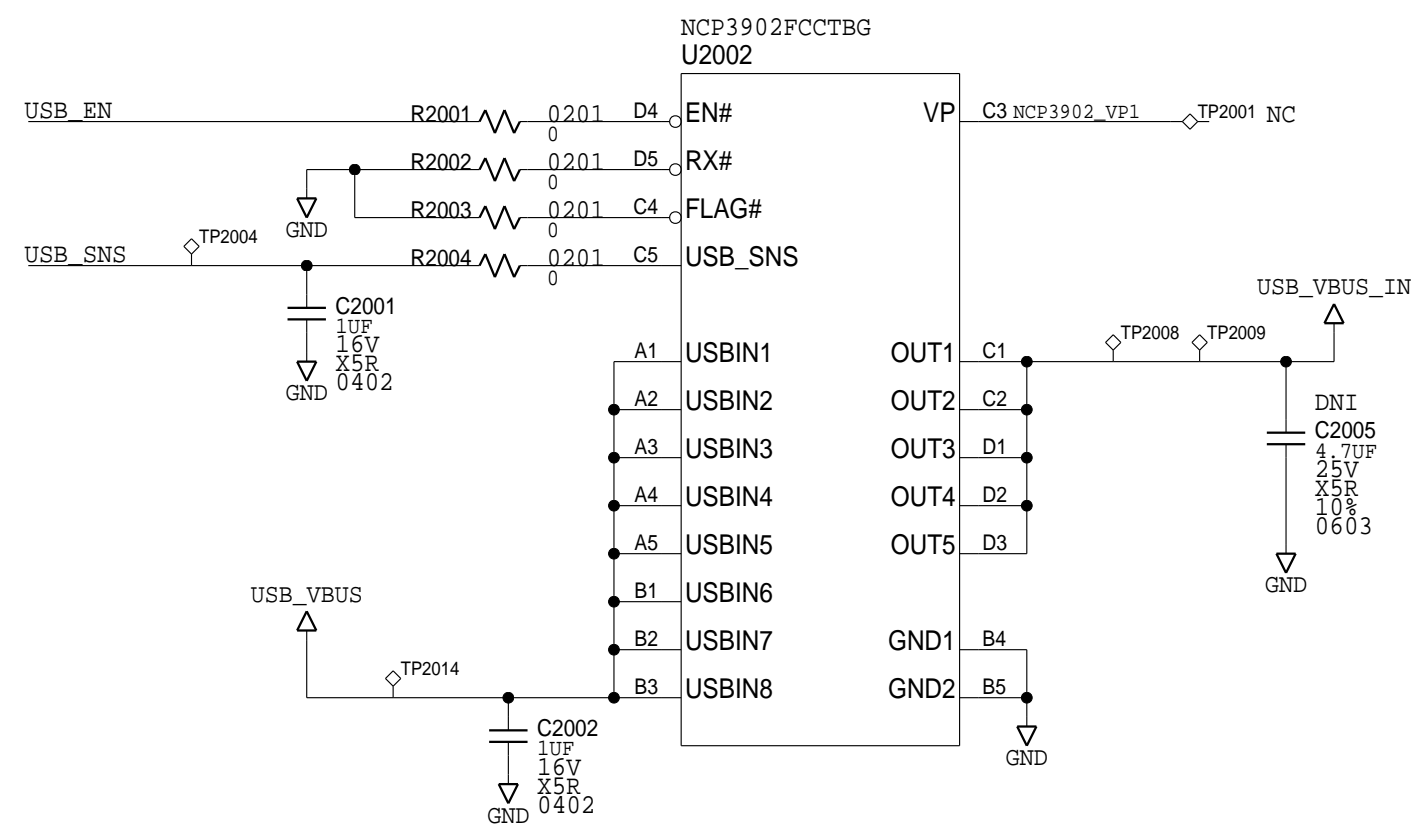
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D		V1D
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# NCP3902 POWER MUX

REVISIONS							
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			SEE SHEET 1				

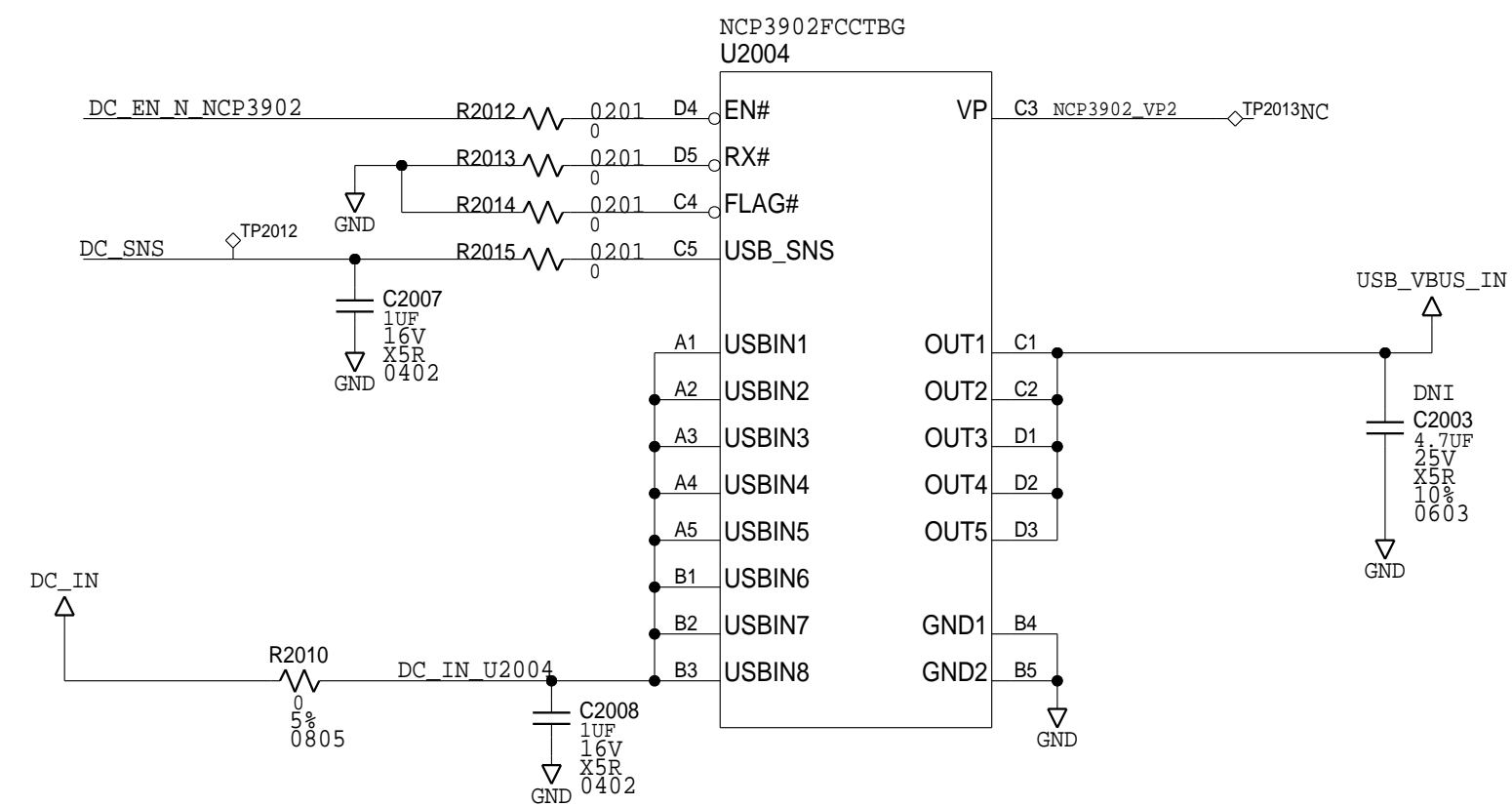
## USB POWER MUX



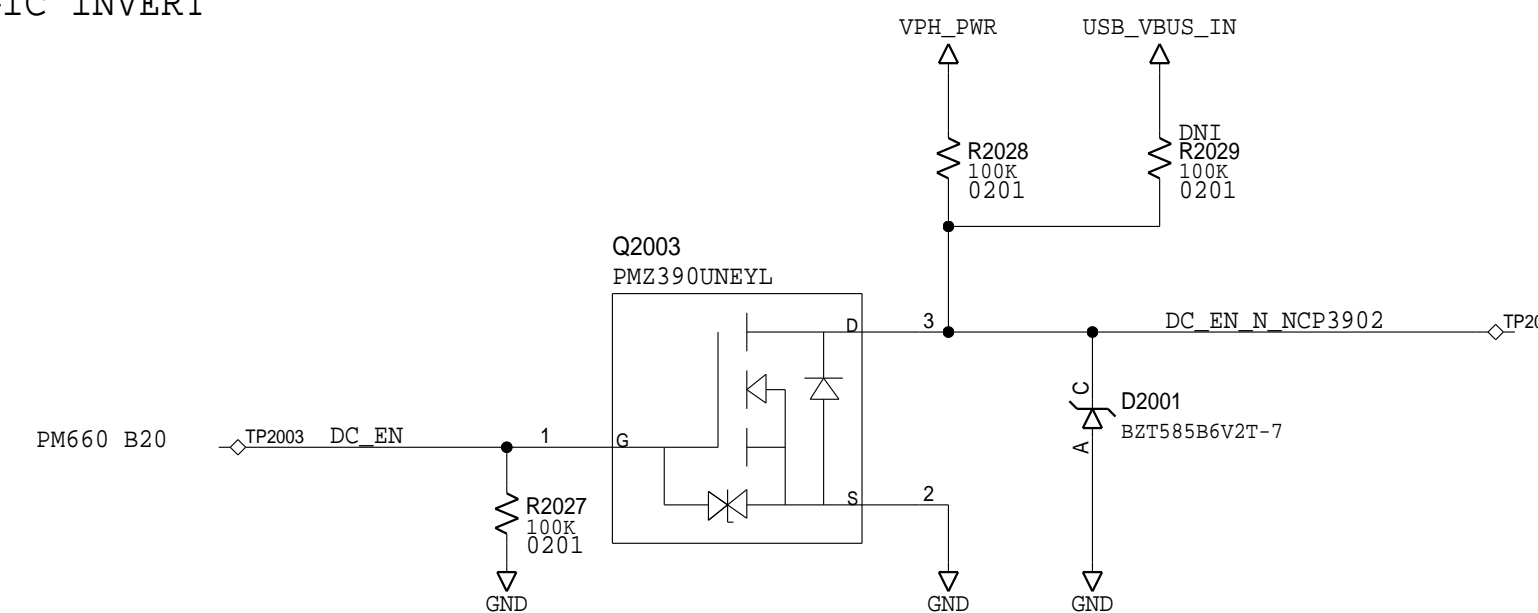
NCP3902 VP SETTING	
VP PIN	OVP THRESHOLD
FLOATING	13V
GND	17V

NCP3902 SWITCH		
NET NAME	LOGIC	BEHAVIOR
NCP3902_EN#	LOW	USBIN CONDUCT TO OUT
	HIGH	OUT DISCONNECT OUT DISCHARGE

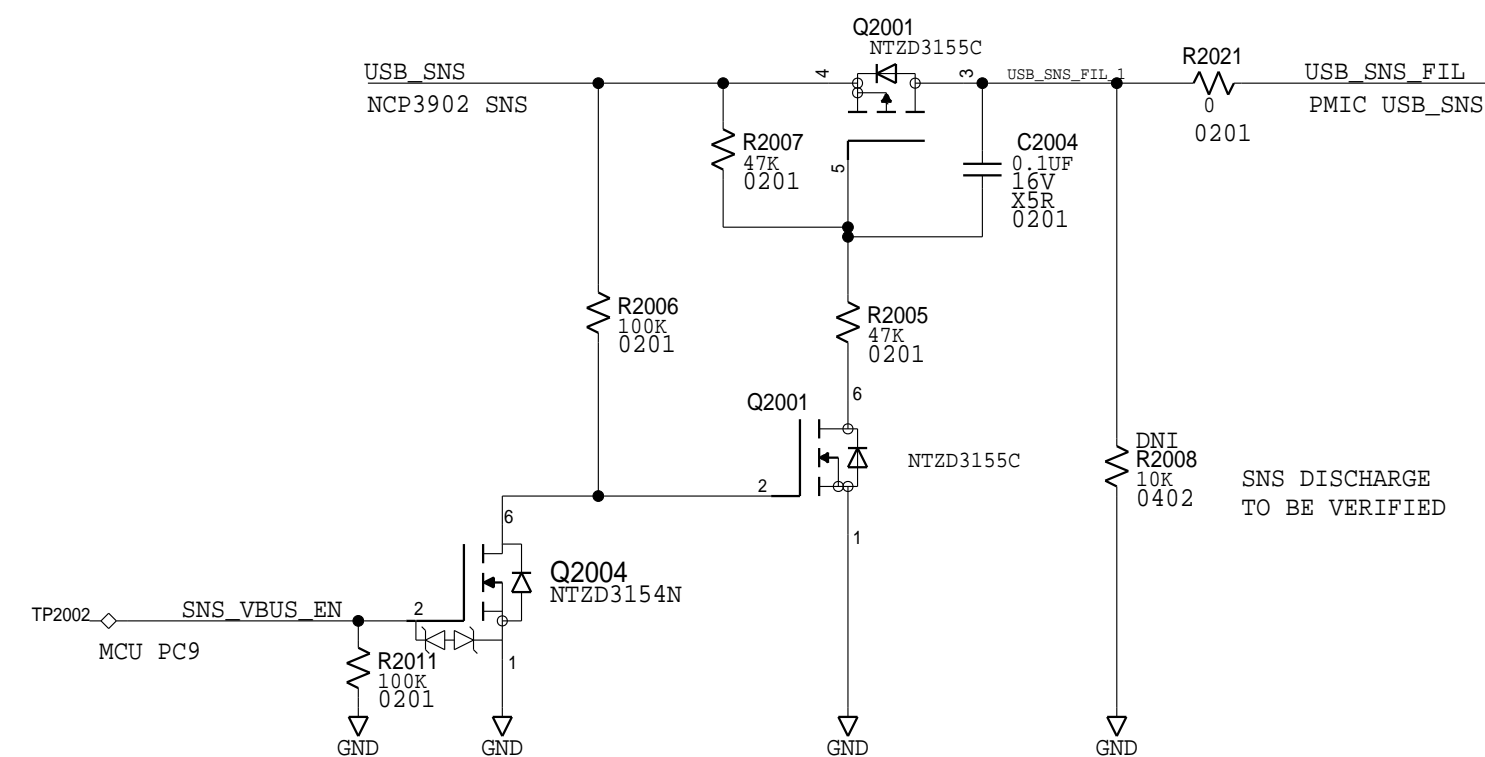
## DC POWER MUX



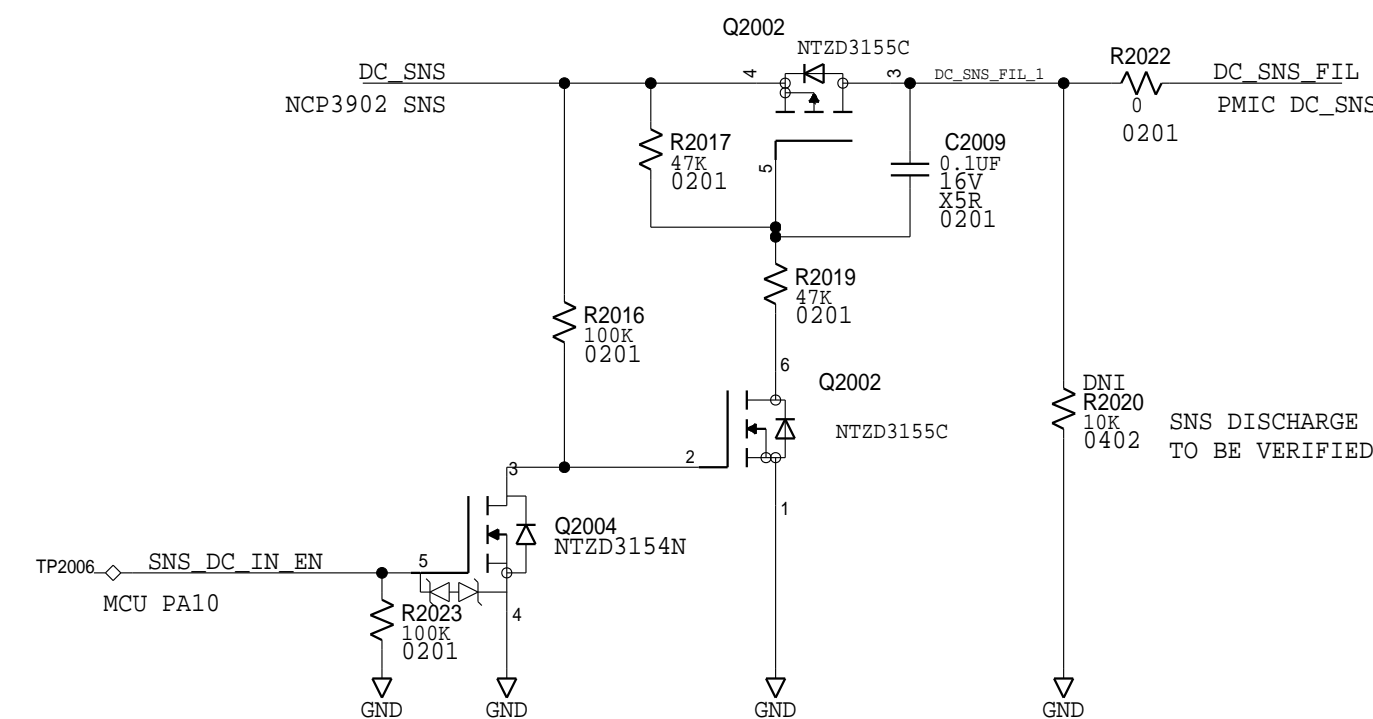
## DC\_EN LOGIC INVERT



SNS BYPASS BY MCU



NET NAME	LOGIC	BEHAVIOR
SNS_VBUS_EN	LOW HI-Z	Q2001 CONDUCT Q2002 CONDUCT
SNS_DC_IN_EN	HIGH	Q2001 BLOCK Q2002 BLOCK

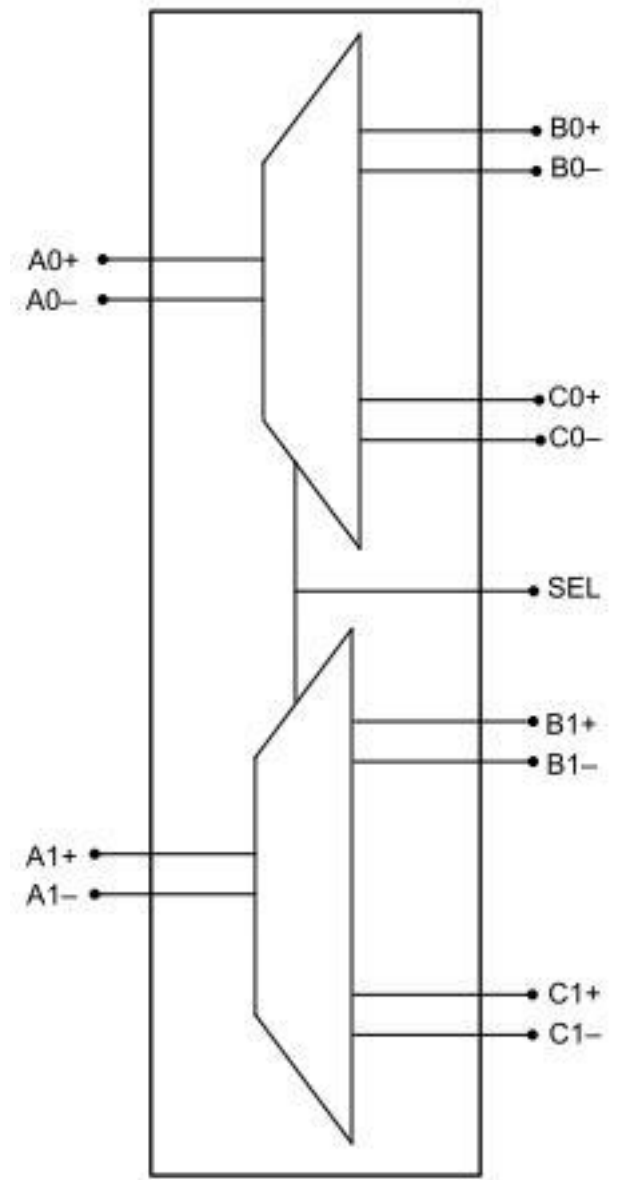


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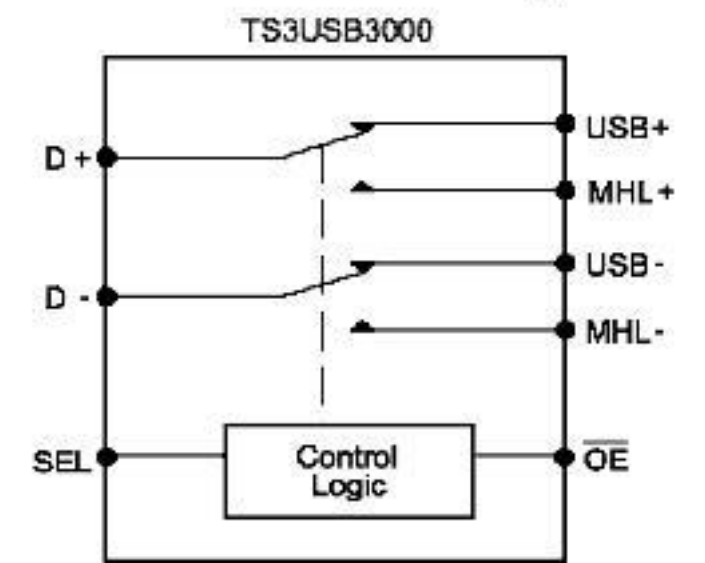
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SIZE D	DWG. NO.	REV V1D
Fri May 03 11:36:07 2019		SHEET 20 OF 45

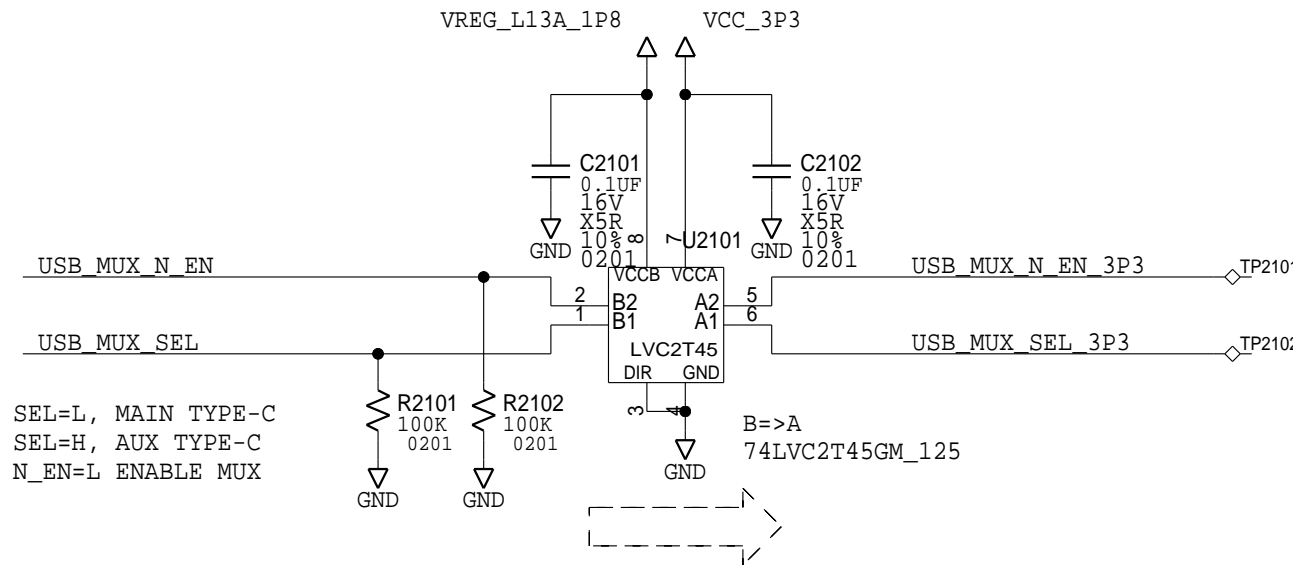
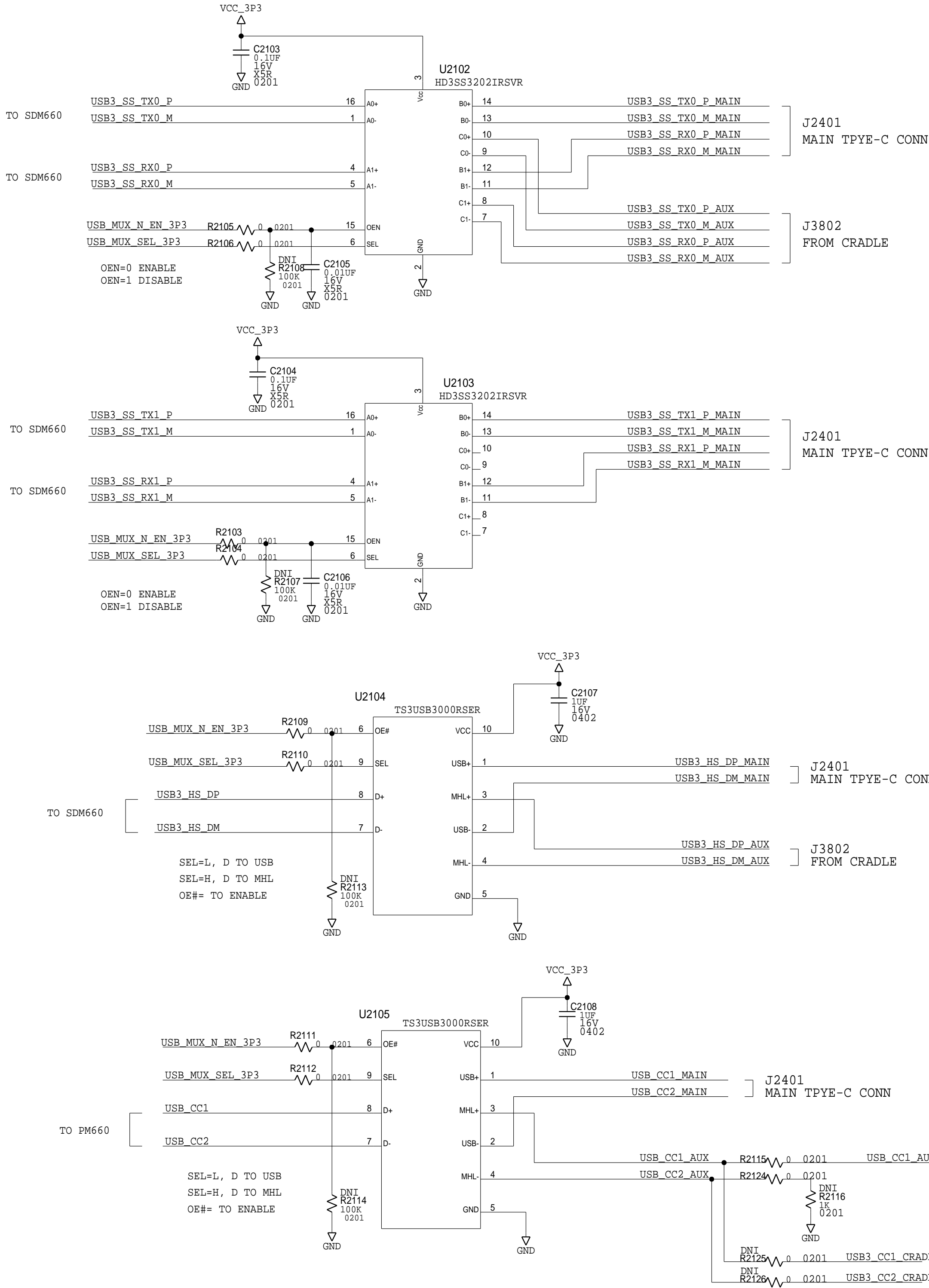
USB MUX



PORT A CHANNEL	PORT B OR PORT C CHANNEL CONNECTED TO PORT A CHANNEL	
	SEL = L	SEL = H
A0p	B0p	C0p
A0n	B0n	C0n
A1p	B1p	C1p
A1n	B1n	C1n



SEL	OE	SWITCH STATUS
X	High	Both USB and MHL switches in High-Z
Low	Low	D+/D- to USB+/USB-
High	Low	D+/D- to MHL+/MHL-



H = HIGH voltage level;  
L = LOW voltage level;  
Z = high-impedance OFF-state.

State	DIR CTRL	I/O-1	I/O-2	Description
1	H	output	input	system-1 data to system-2
2	H	Z	Z	system-2 is getting ready to send data to system-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on bus hold
3	L	Z	Z	DIR bit is set LOW. I/O-1 and I/O-2 still are disabled. The bus-line state depends on bus hold
4	L	input	output	system-2 data to system-1

Table 4-20 Source CC Termination (Rp) Requirements

Source Advertisement	Current Source to 1.7 ~ 5.5 V	Resistor pull-up to 4.75 ~ 5.5 V	Resistor pull-up to 3.3 V ± 5%
Default USB Power	80 µA ± 20%	56 kΩ ± 20% (Note 1)	36 kΩ ± 20%
1.5 A @ 5 V	180 µA ± 8%	22 kΩ ± 5%	12 kΩ ± 5%
3.0 A @ 5 V	330 µA ± 8%	10 kΩ ± 5%	4.7 kΩ ± 5%

Table 4-21 Sink CC Termination (Rd) Requirements

Rd Implementation	Nominal value	Can detect power capability?	Max voltage on pin
± 20% voltage clamp <sup>1</sup>	1.1 V	No	1.32 V
± 20% resistor to GND	5.1 kΩ	No	2.18 V
± 10% resistor to GND	5.1 kΩ	Yes	2.04 V


CRADLE	CC1	CONFIG
RP	RD	REMARK
L	L	NOT ATTACHED
L	H	SDM660 HOST
H	L	SDM660 SLAVE
H	H	NOT ALLOWED

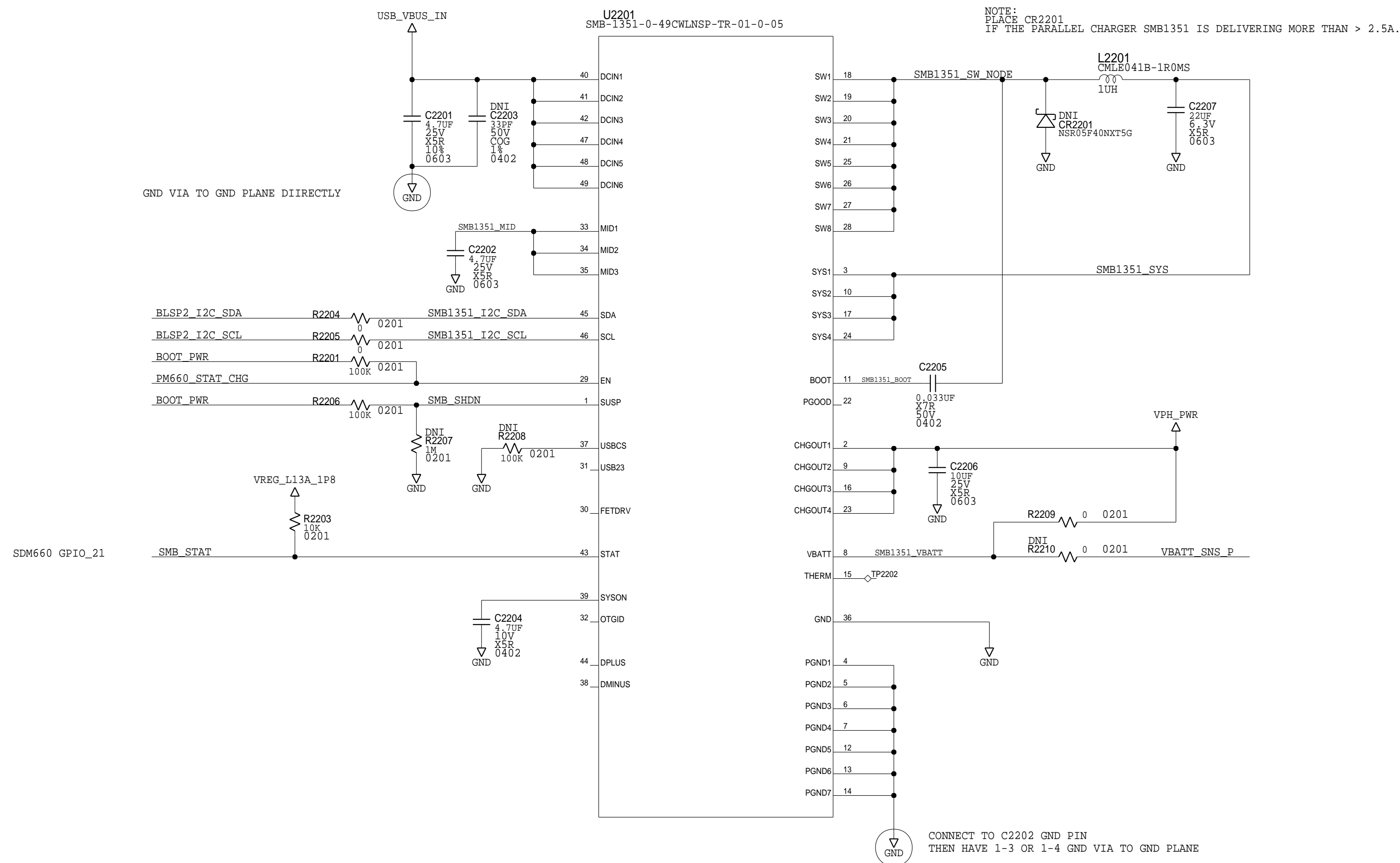
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D		V1D
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SMB1351

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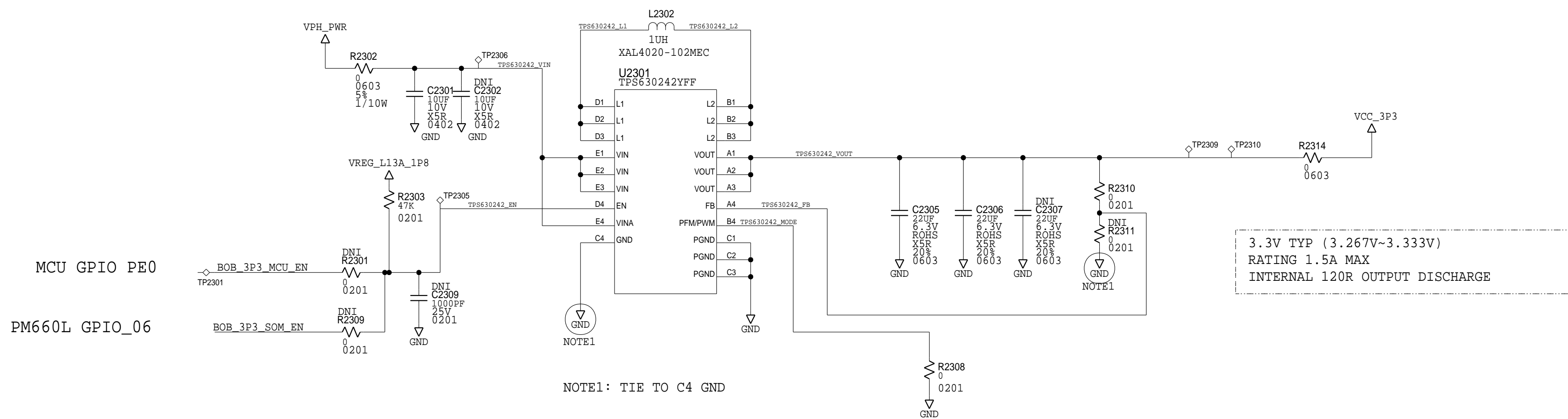
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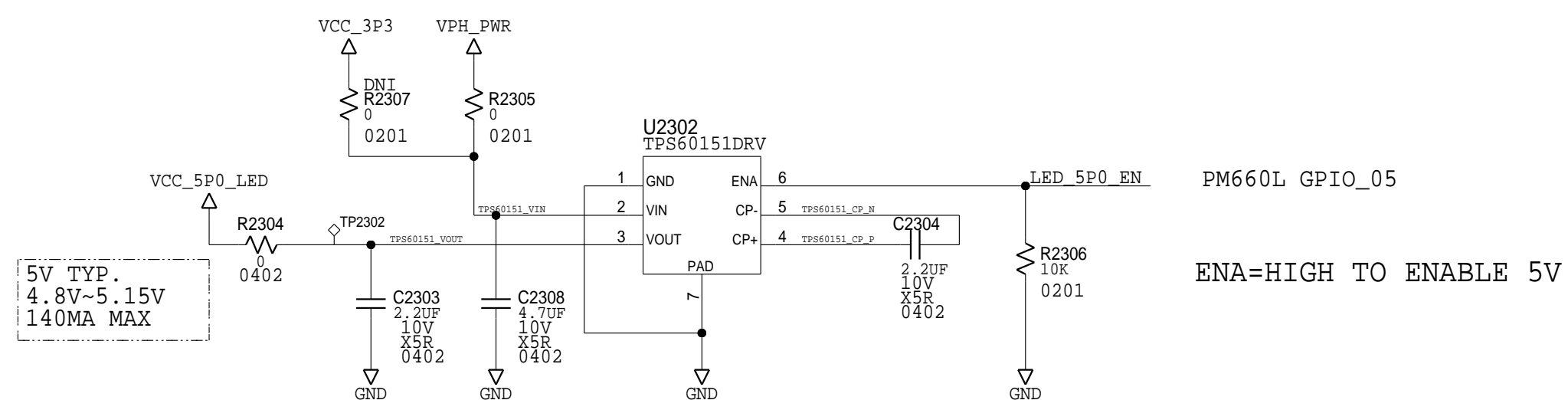
SIZE D	DWG. NO.	REV V1D
Fri May 03 11:44:30 2019		SHEET 22 OF 45



## POWER RAIL



## 3V3 BUCK-BOOST TPS60242



## 5V0 CHARGE PUMP TPS60151

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## D



A

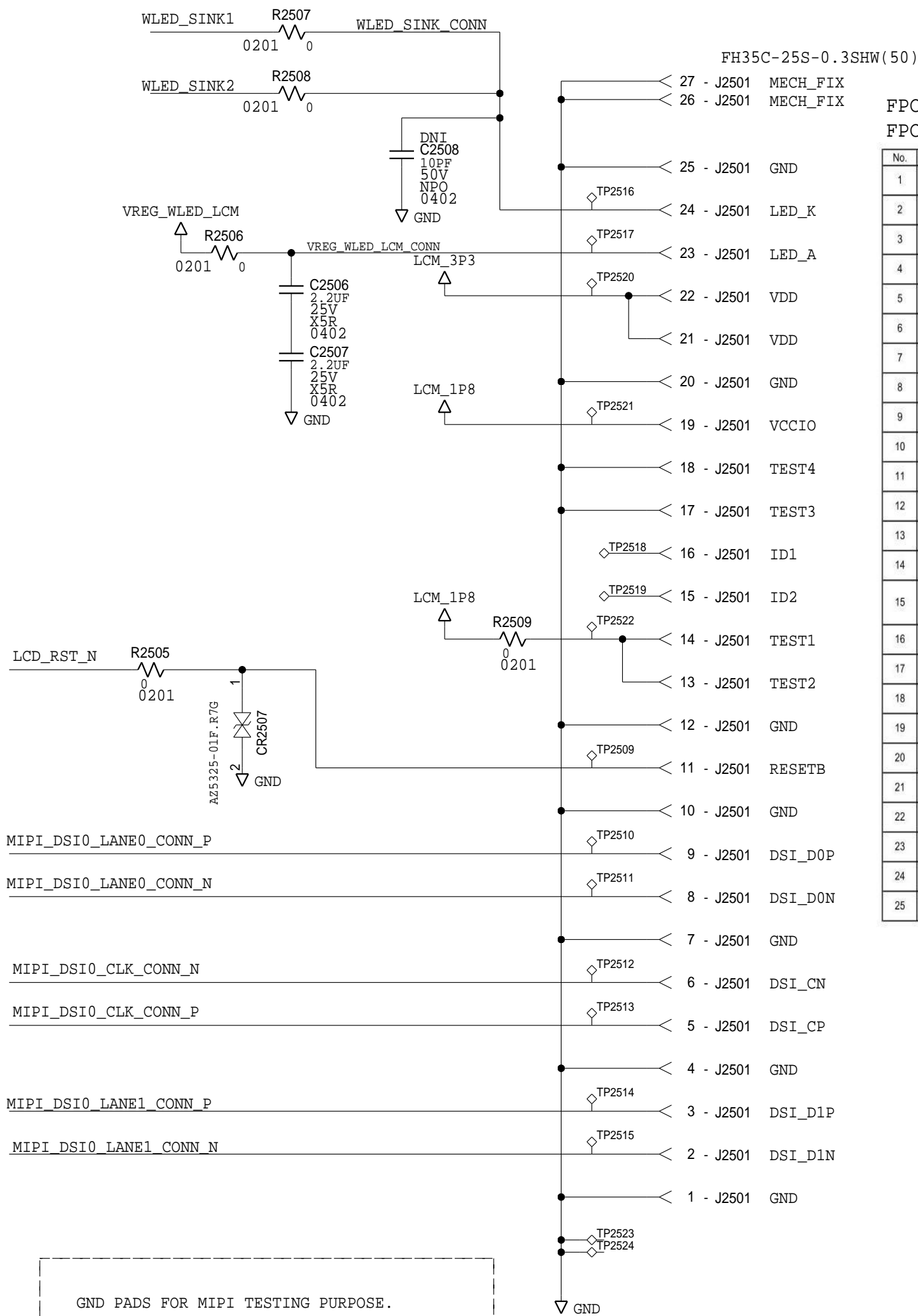
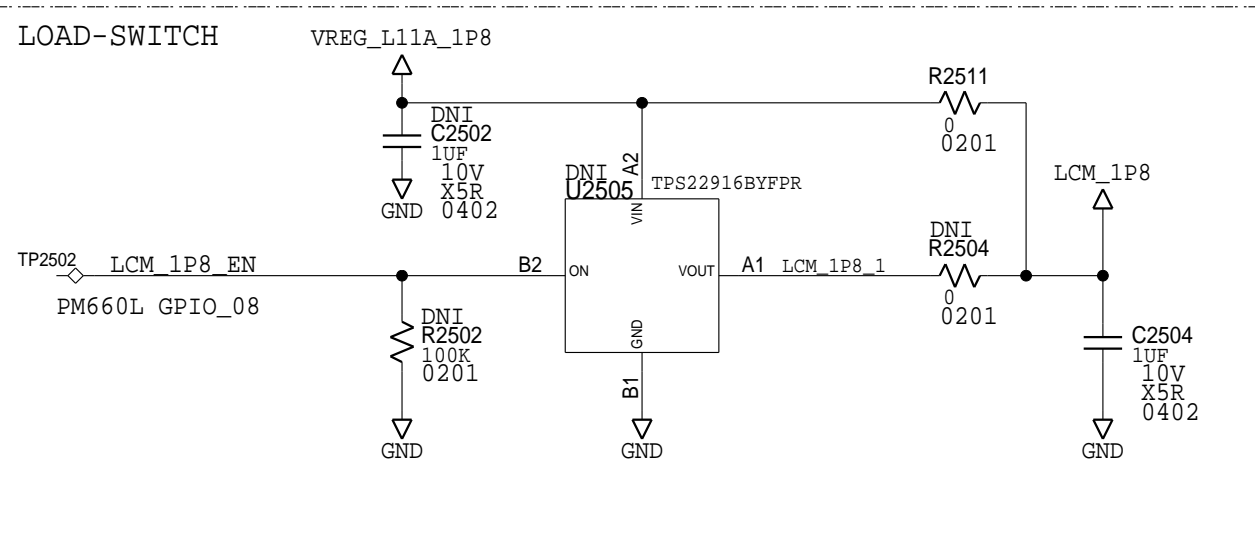
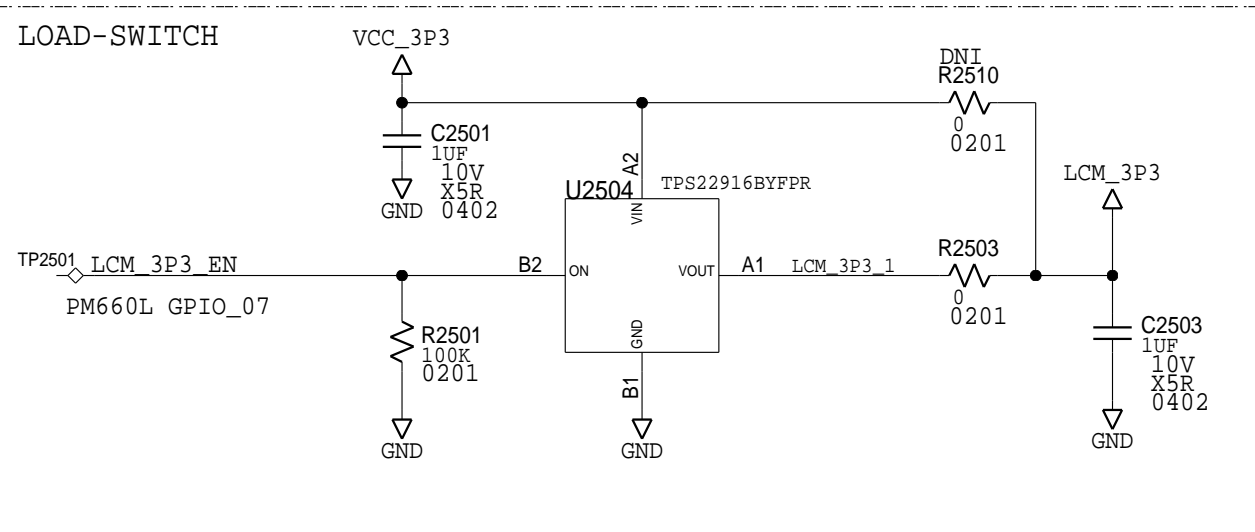
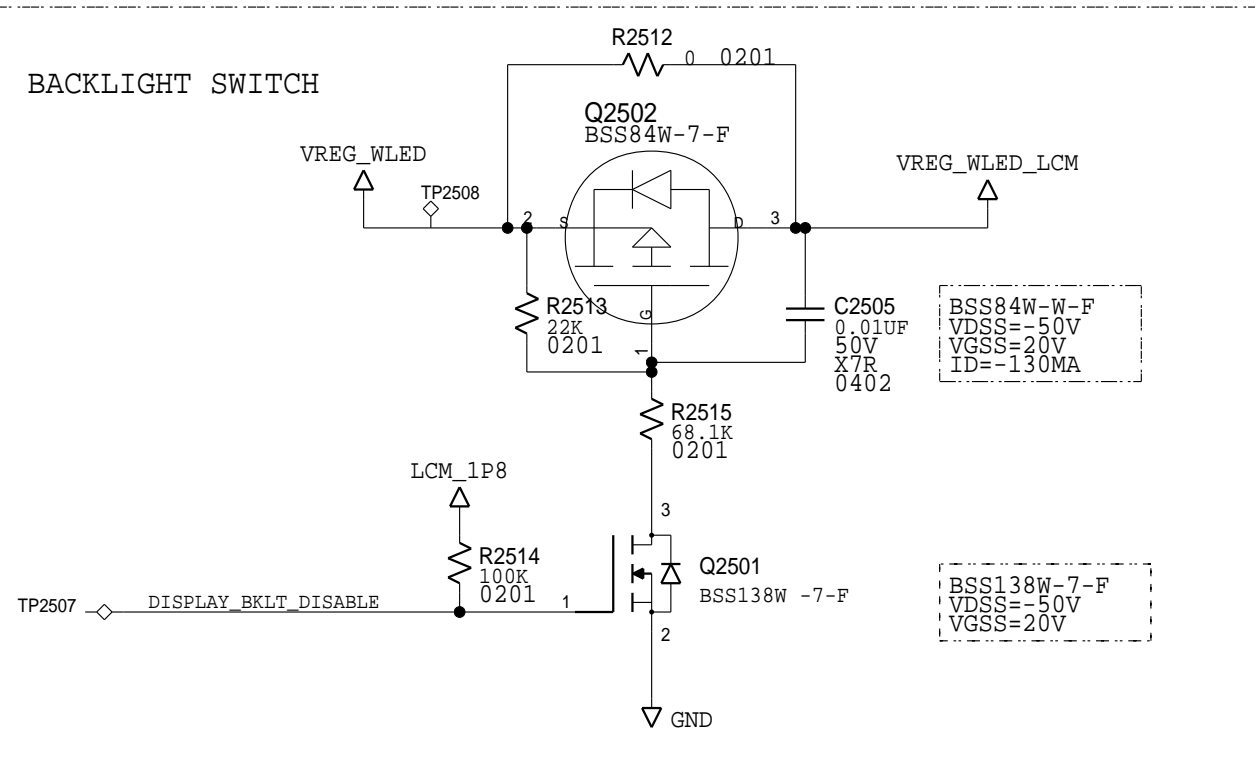
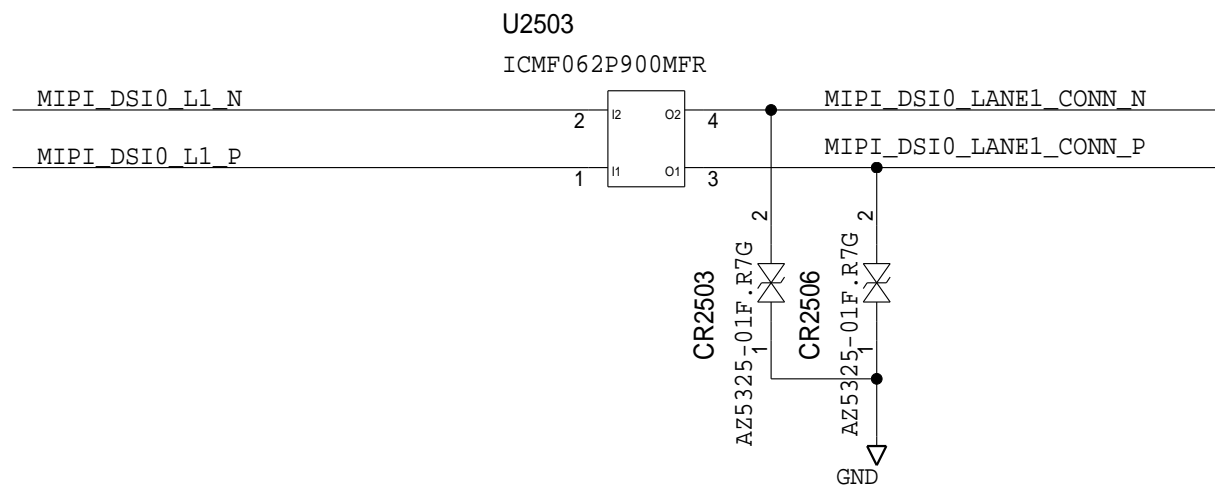
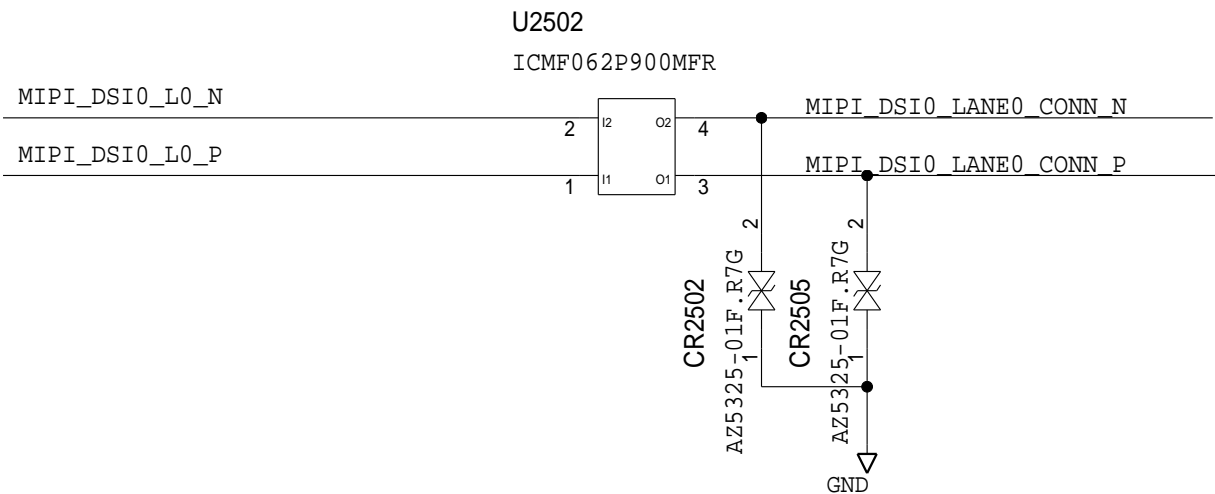
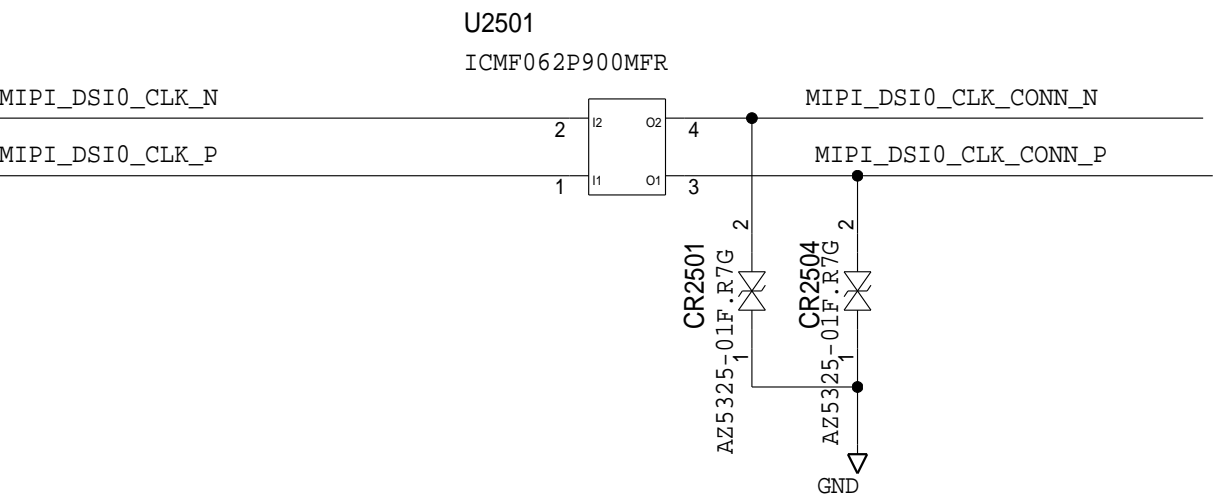
SIZE D	DWG. NO.	REV V1D
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Tue Apr 30 15:04:35 2019

HEET 24 OF 45

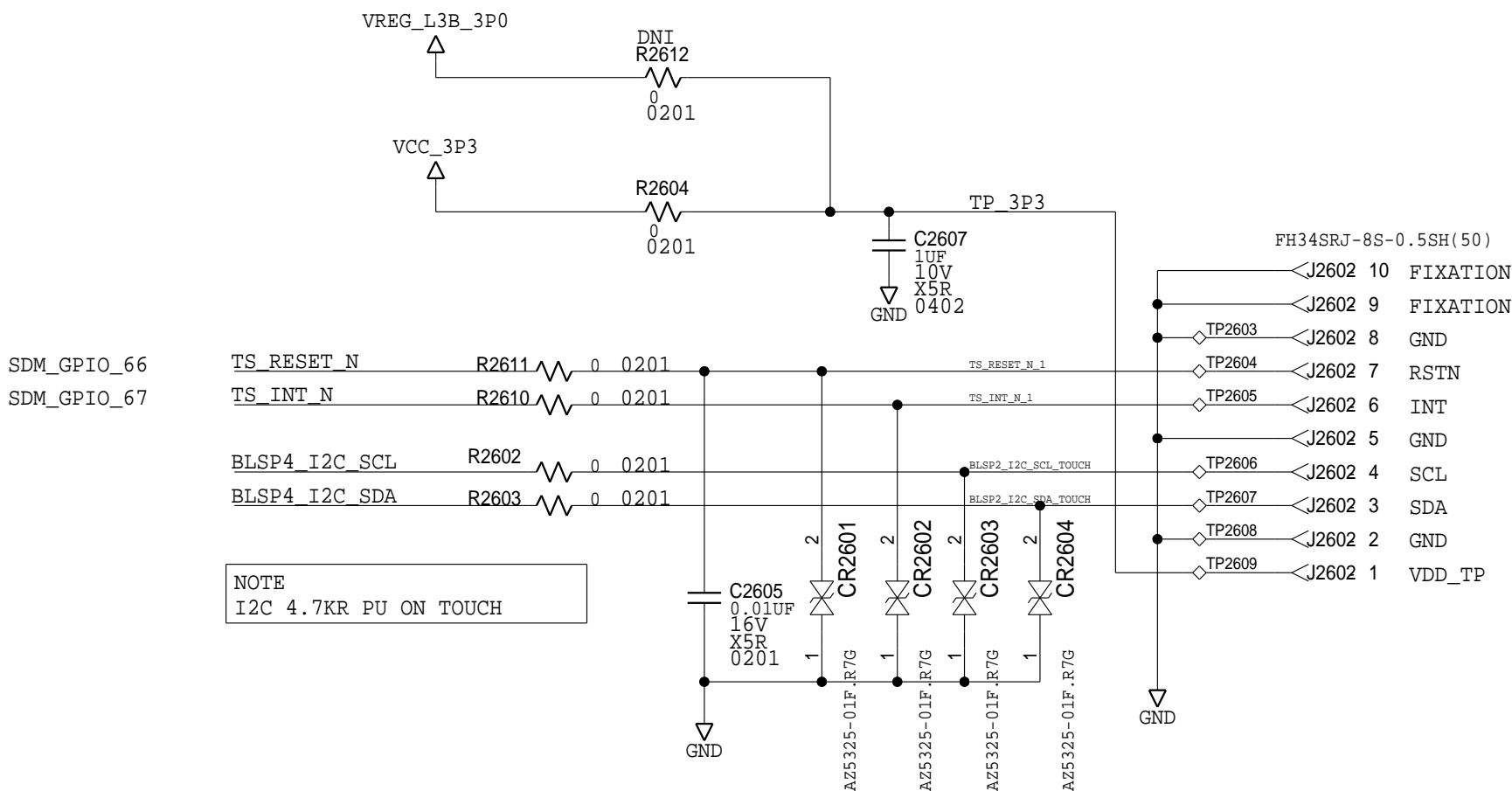
DISPLAY INTERFACE(M6)

REVISIONS						
REV	ZONE	No.	DESCRIPTION		E.C.	BY
			SEE SHEET 1			
					APVD.	DATE



TOUCH PANNEL(M7)

REVISIONS							
REV	ZONE	No.	DESCRIPTION			E.C.	BY
			SEE SHEET 1				APVD.
							DATE



FPC PIN1 MAPPED TO CONN PIN8  
FPC PINOUT

TP_FPC				
No.	Symbol	Details	Remark	IO
1	GND	Ground	GND	P
2	RSTN	External hardware reset input	I/O = 1.8V (TYP) .Low active	I
3	INT	Interrupt output	I/O = 1.8V (TYP)	O
4	GND	Ground	GND	P
5	SCL	I2C interface, clock input	I/O = 1.8V (TYP) .Note1	I/O
6	SDA	I2C interface, data input	I/O = 1.8V (TYP) .Note1	I/O
7	GND	Ground	GND	P
8	VDD_TP	Power Supply	VDD_TP = 3.3V (TYP)	P

Note1: - Pull high to 1.8V.  
This is implemented in the FPC circuit.

Connector: Hirose FH34SRJ-8S-0.55H

Item	Symbol	Min	Typ.	Max	Unit	Condition
Operation current	I <sub>op</sub>		100		mA	Active Mode @ 21.5"

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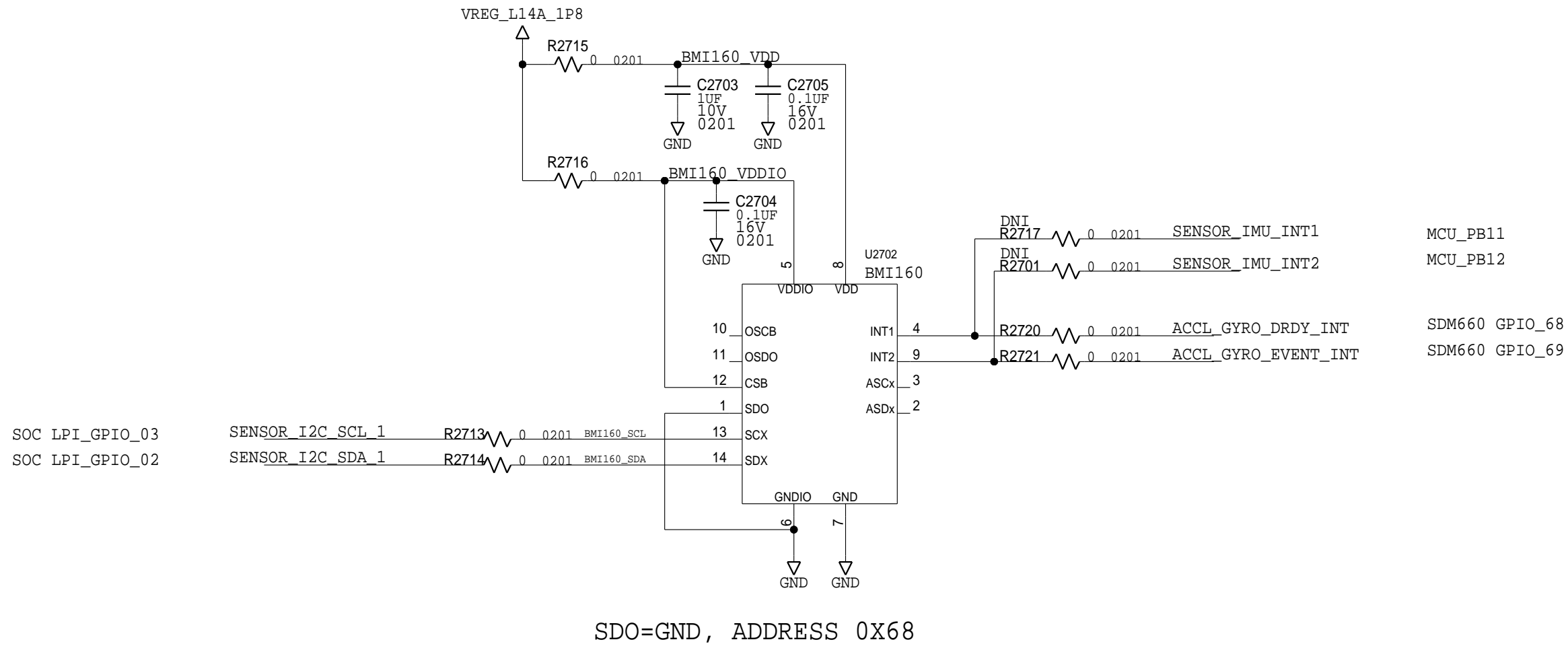
SIZE	DWG. NO.	REV
D		V1D
Thu May 02 19:30:21 2019		SHEET 26 OF 45

SENSOR

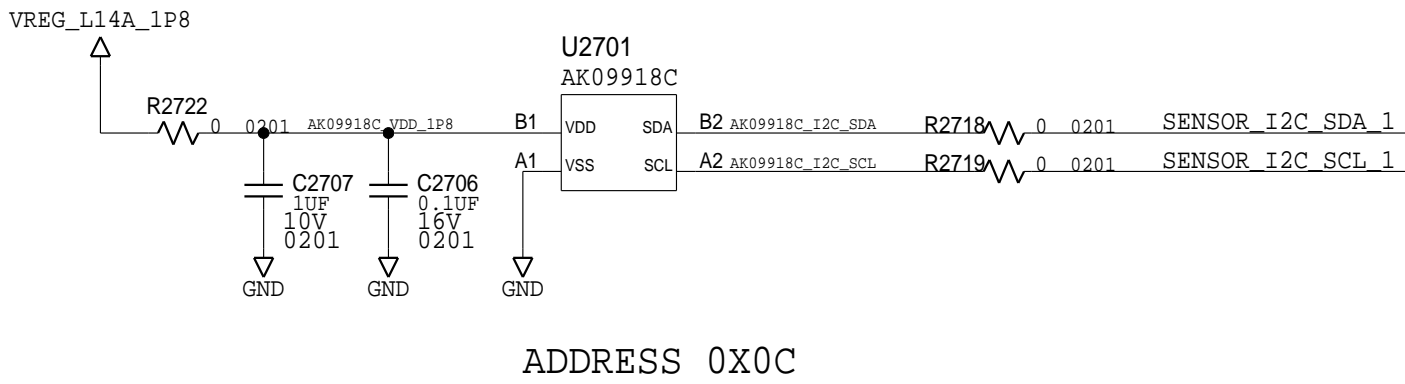
PROXIMITY SENSOR AND ALS

SENSOR ON NOTIFICATION FPC  
CM36686M30E  
ADDRESS 0X60

GYRO ,G-SENSOR



E-COMPASS



REVISIONS							
REV	ZONE	No.	DESCRIPTION			E.C.	BY
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							DATE

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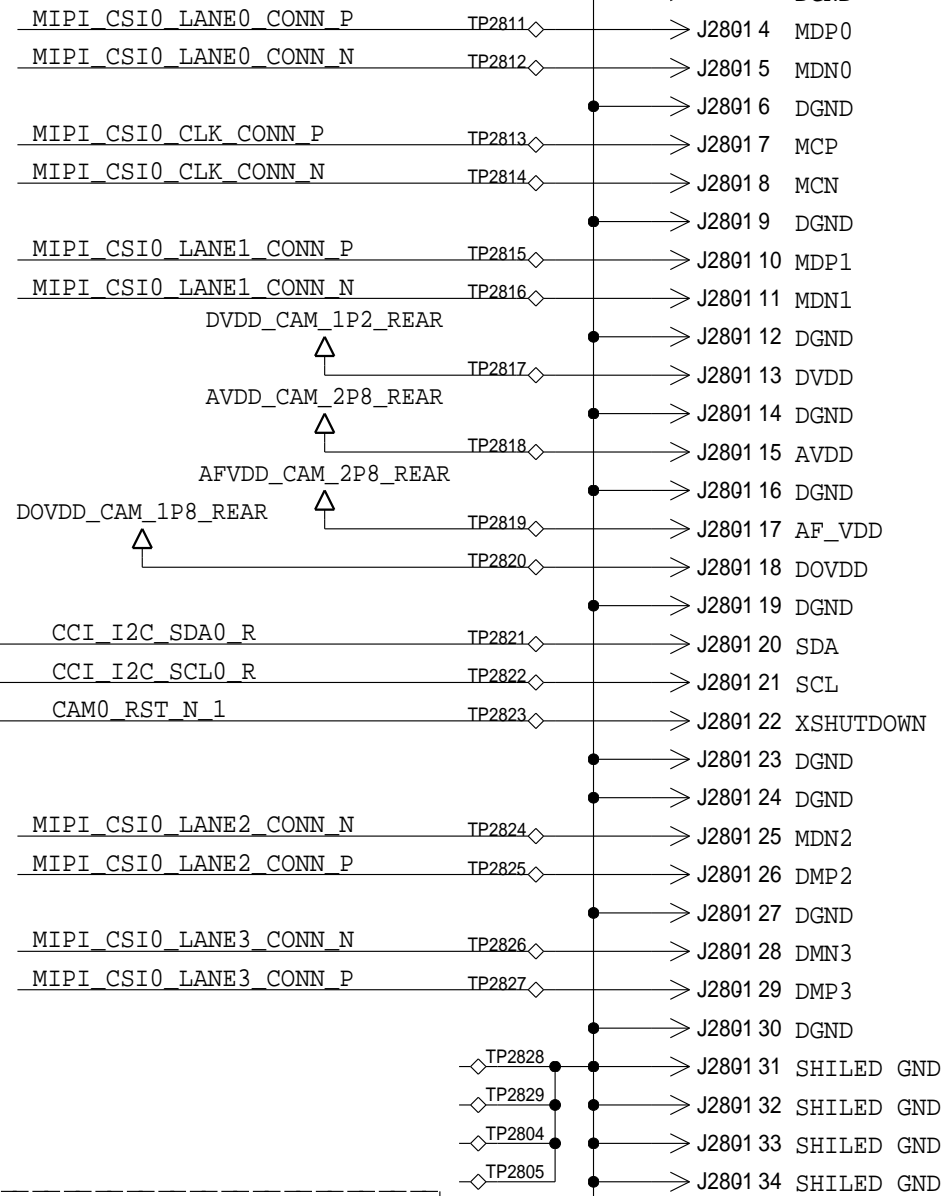
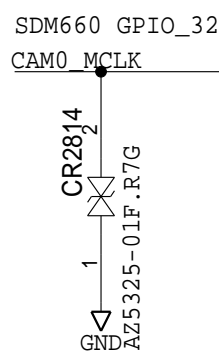
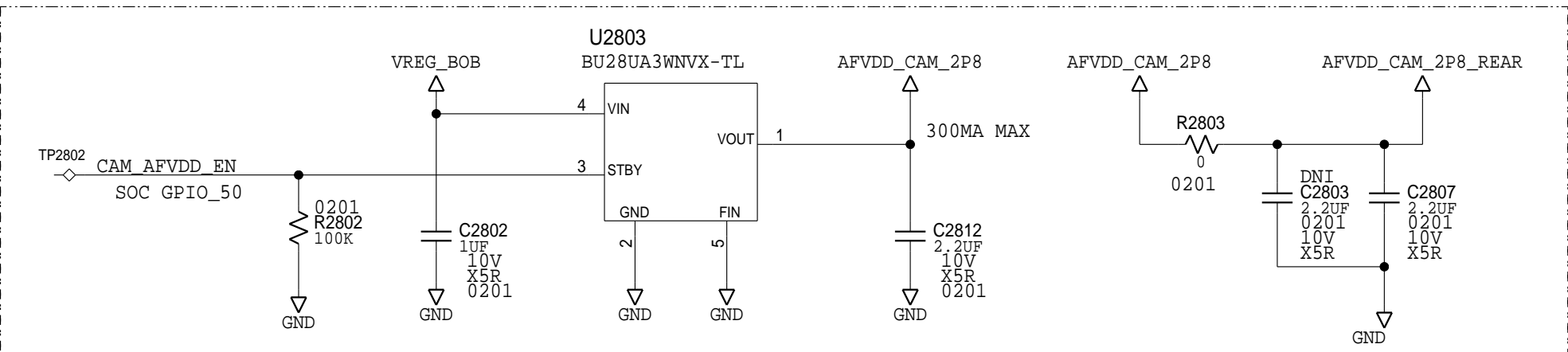
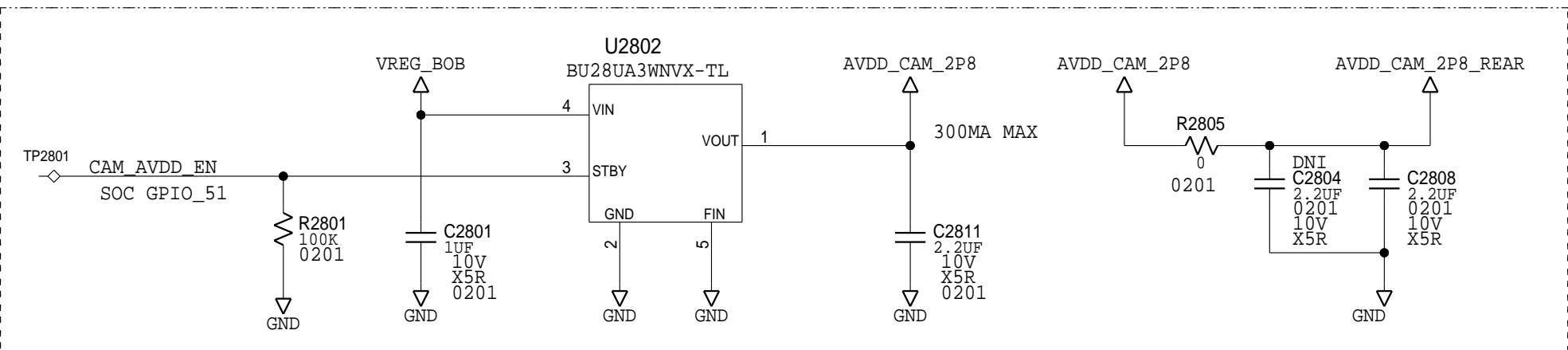
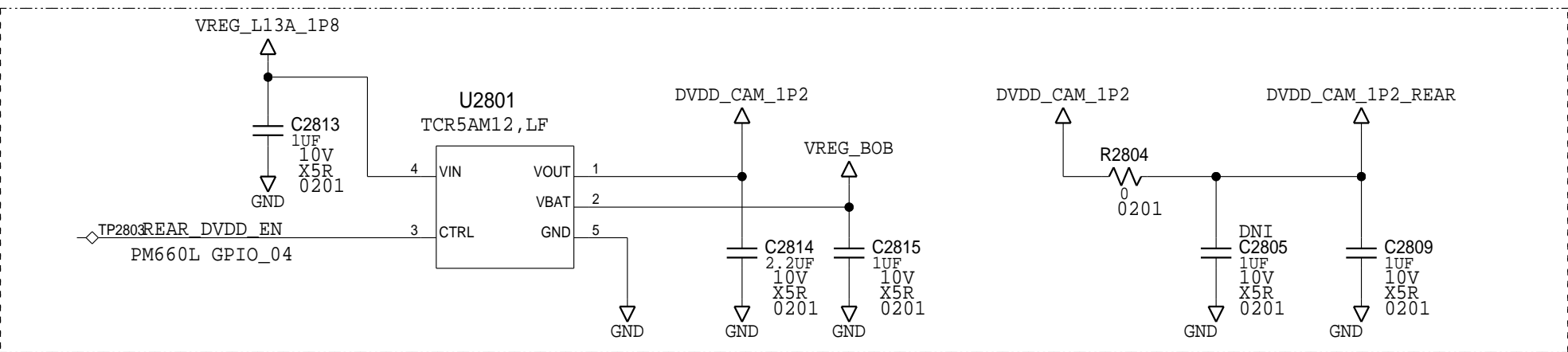
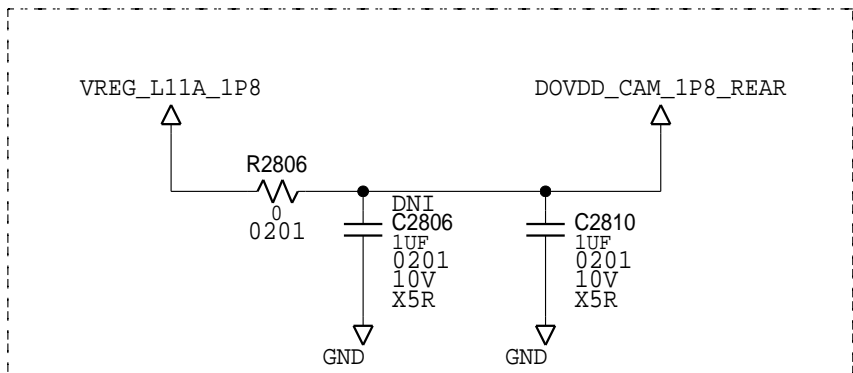
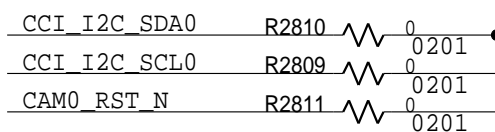
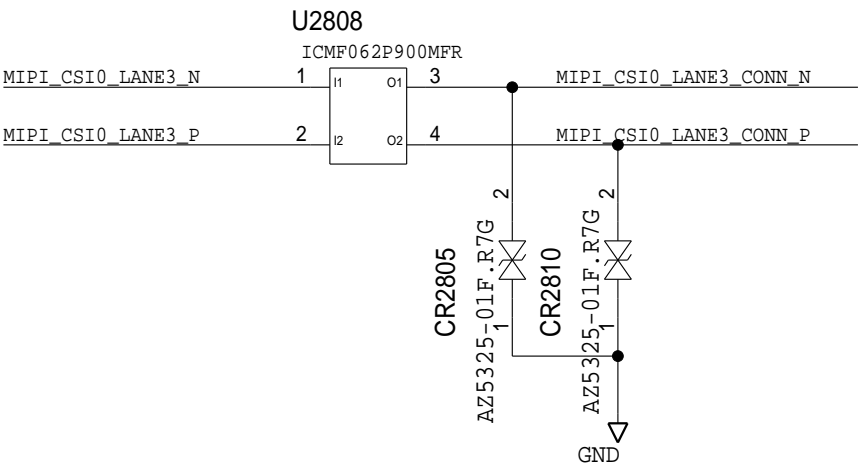
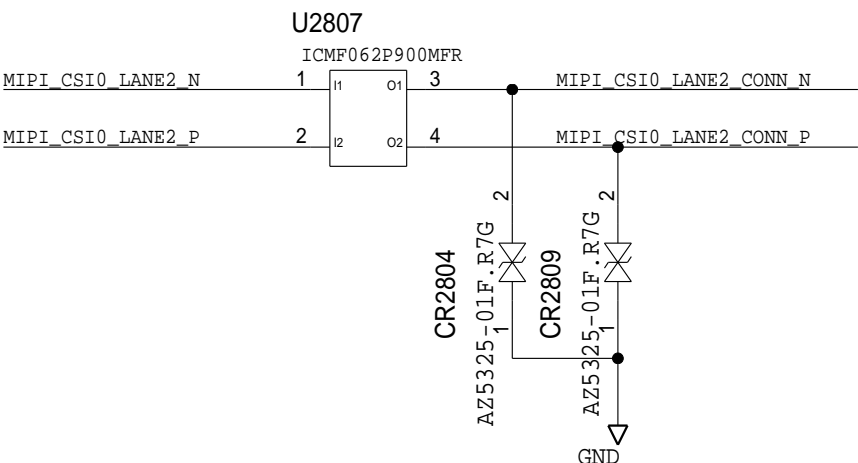
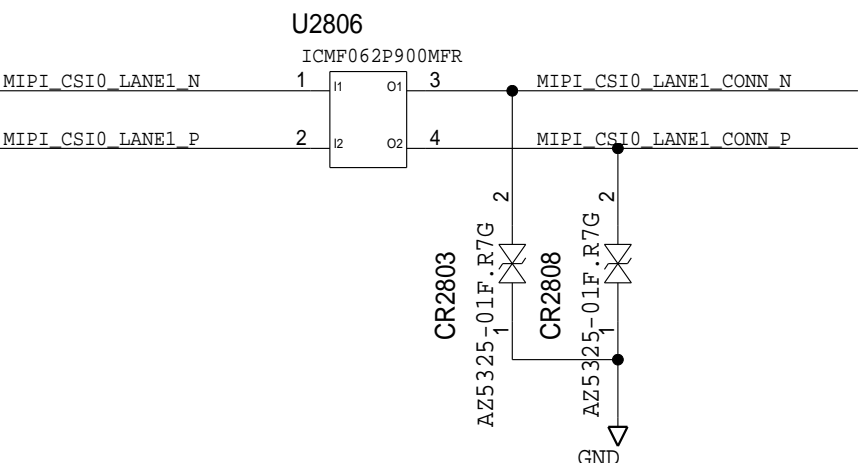
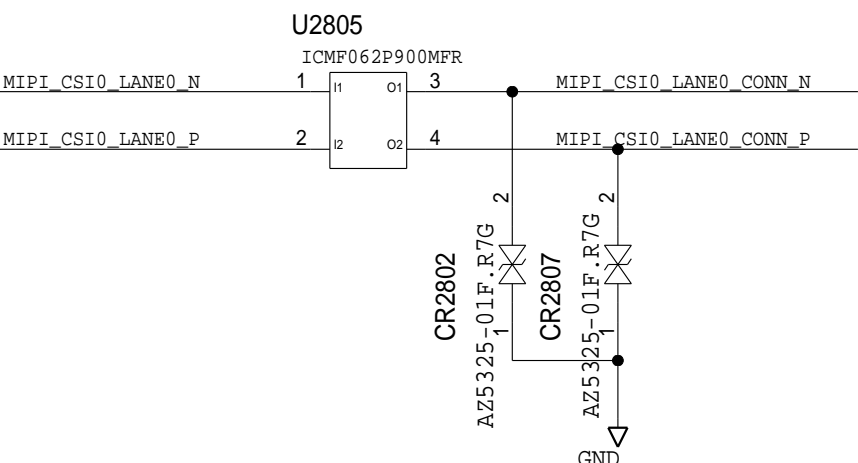
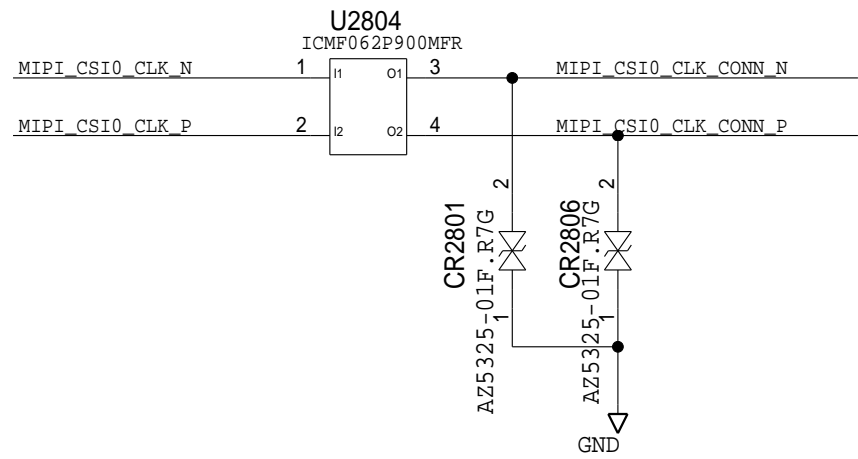
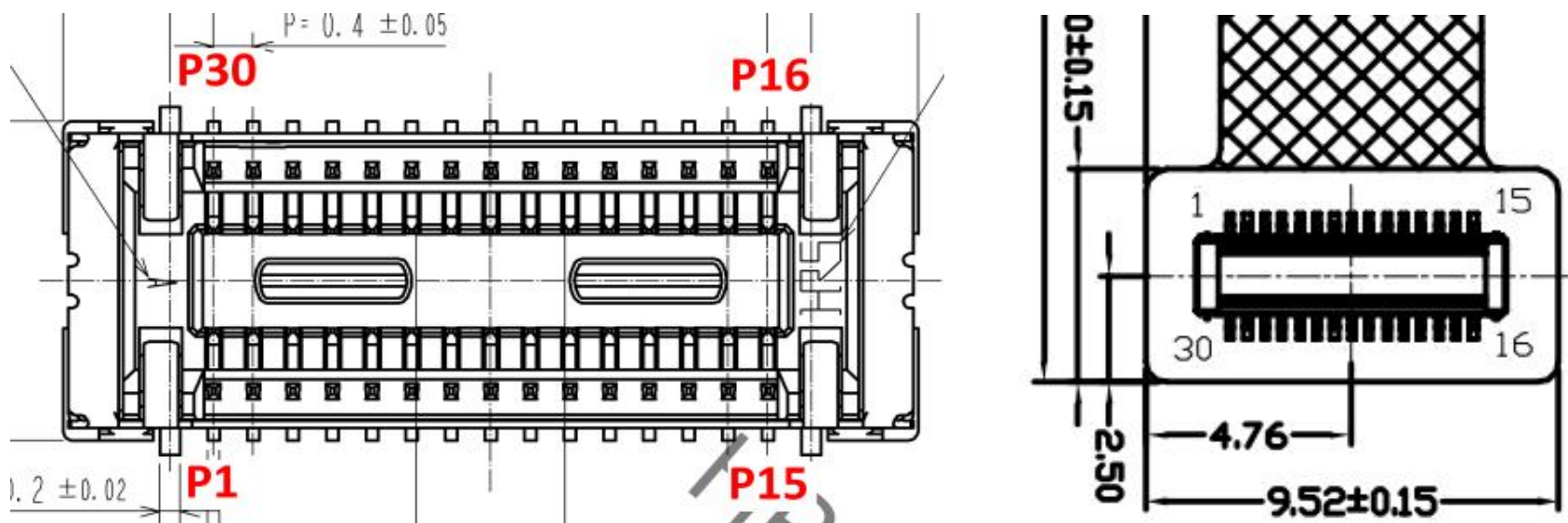
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SIZE	DWG. NO.	REV
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Fri May 03 11:42:59 2019		SHEET 27 OF 45



CAMERA (M13)

REVISIONS						
REV	ZONE	No.	DESCRIPTION		E.C.	BY
			SEE SHEET 1		APVD.	DATE



1	DGND
2	MCLK
3	DGND
4	MDP0
5	MDN0
6	DGND
7	MCP
8	MCN
9	DGND
10	MDP1
11	MDN1
12	DGND
13	DVDD
14	DGND
15	AVDD
16	DGND
17	AF_VDD
18	DOVDD
19	DGND
20	SDA
21	SCL
22	XSHUTDOWN
23	DGND
24	DGND
25	MDN2
26	MDP2
27	DGND
28	DMN3
29	MDP3
30	DGND

GND PADS FOR MIPI TESTING PURPOSE.  
PLACE THEM NEXT TO MIPI SIGNALS.

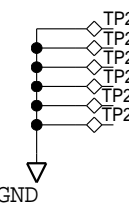


table 7-3 DC characteristics (-30°C < T<sub>j</sub> < 85°C)

symbol	parameter	min	typ	max <sup>a</sup>	unit
supply					
V <sub>DD-A</sub>	supply voltage (analog)	2.7	2.8	3.0	V
V <sub>DD-D</sub>	supply voltage (digital core for 2-lane MIPI up to 900 Mbps/lane)	1.14	1.2	1.26	V
V <sub>DD-IO</sub>	supply voltage (digital I/O)	1.7	1.8	1.9	V
I <sub>DD-A</sub>	active (operating) current <sup>b</sup>		36	45	mA
I <sub>DD-IO</sub>			3	4	mA
I <sub>DD-D</sub> <sup>c</sup>			106	140	mA
I <sub>BDS-SCCB</sub>	standby current <sup>d</sup>		1	20	mA
I <sub>BDS-XSHUTDN</sub>			2	20	μA

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			SEE SHEET 1				
						APVD.	DATE

D

C

B

A

D

C

B

A

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SIZE	DWG. NO.		REV
D			V1D
Tue Feb 26 14:55:36 2019		SHEET	29 OF 45

## D



A

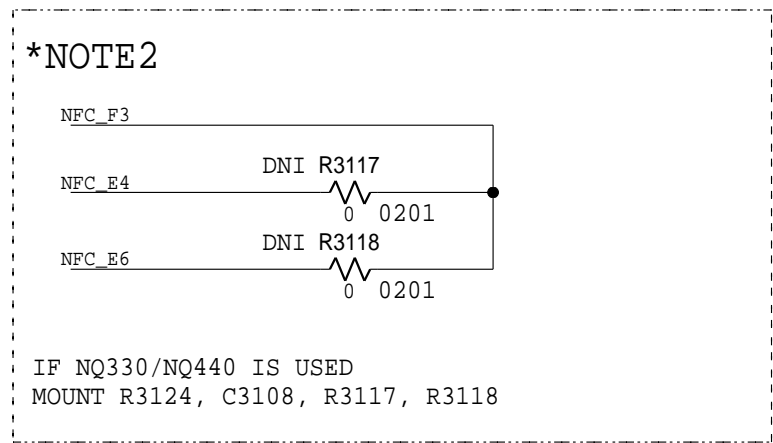
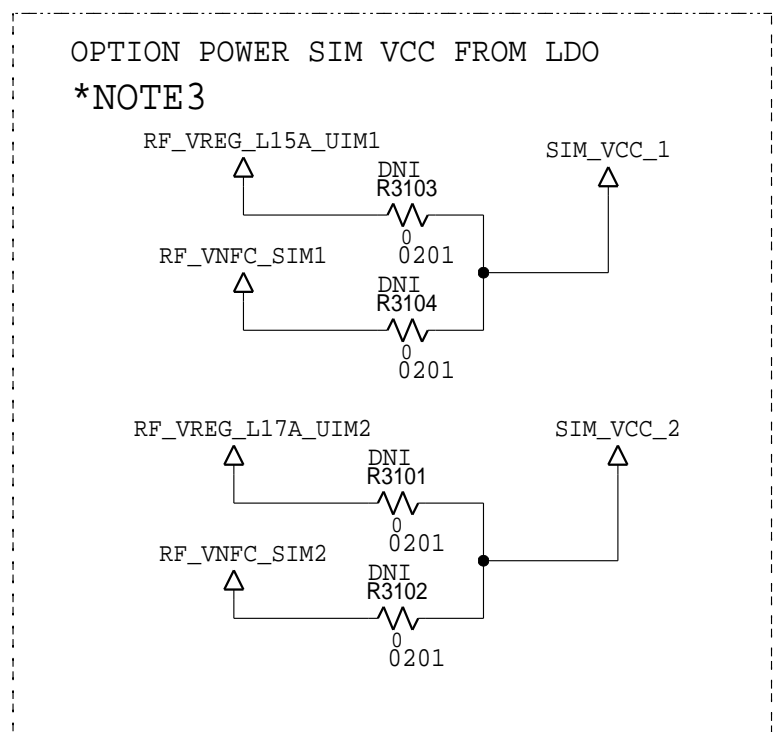
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USI CONFIDENTIAL			
MS-01 PRO DEV. BOARD			
SIZE	DWG. NO.	REV	
D		V1D	
Fri Apr 19 17:29:16 2019		SHEET	30 OF 45

# NFC

REVISIONS						
REV	ZONE	No.	DESCRIPTION	E.C.	BY	APVD.
			SEE SHEET 1			

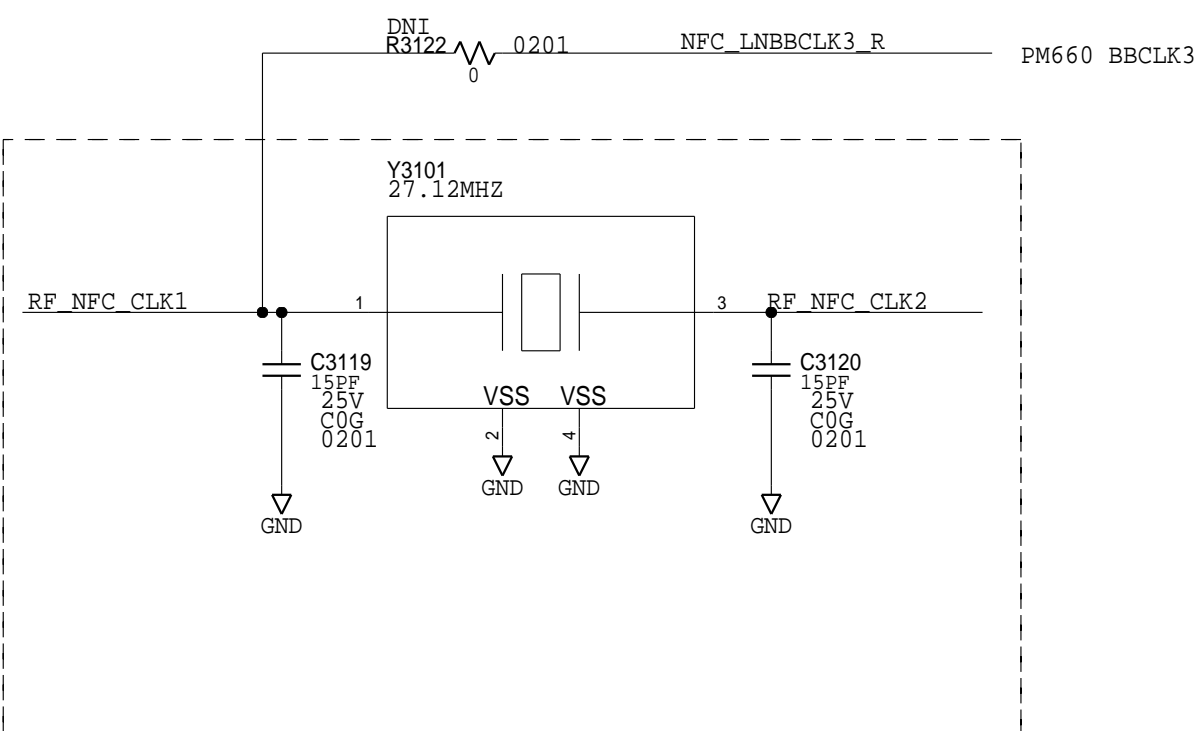
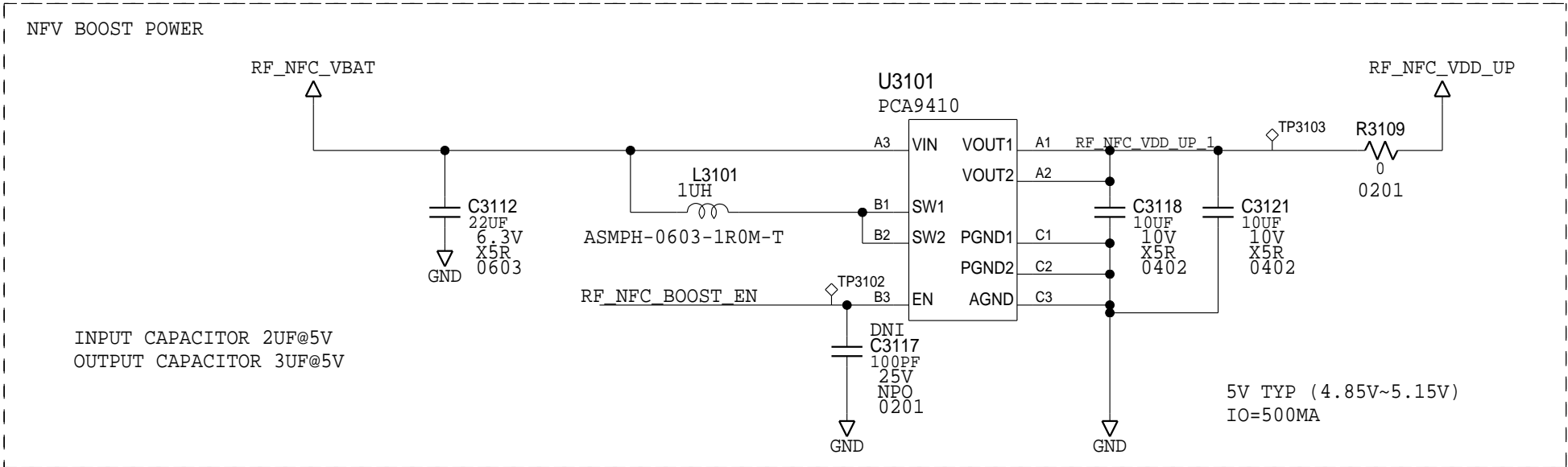
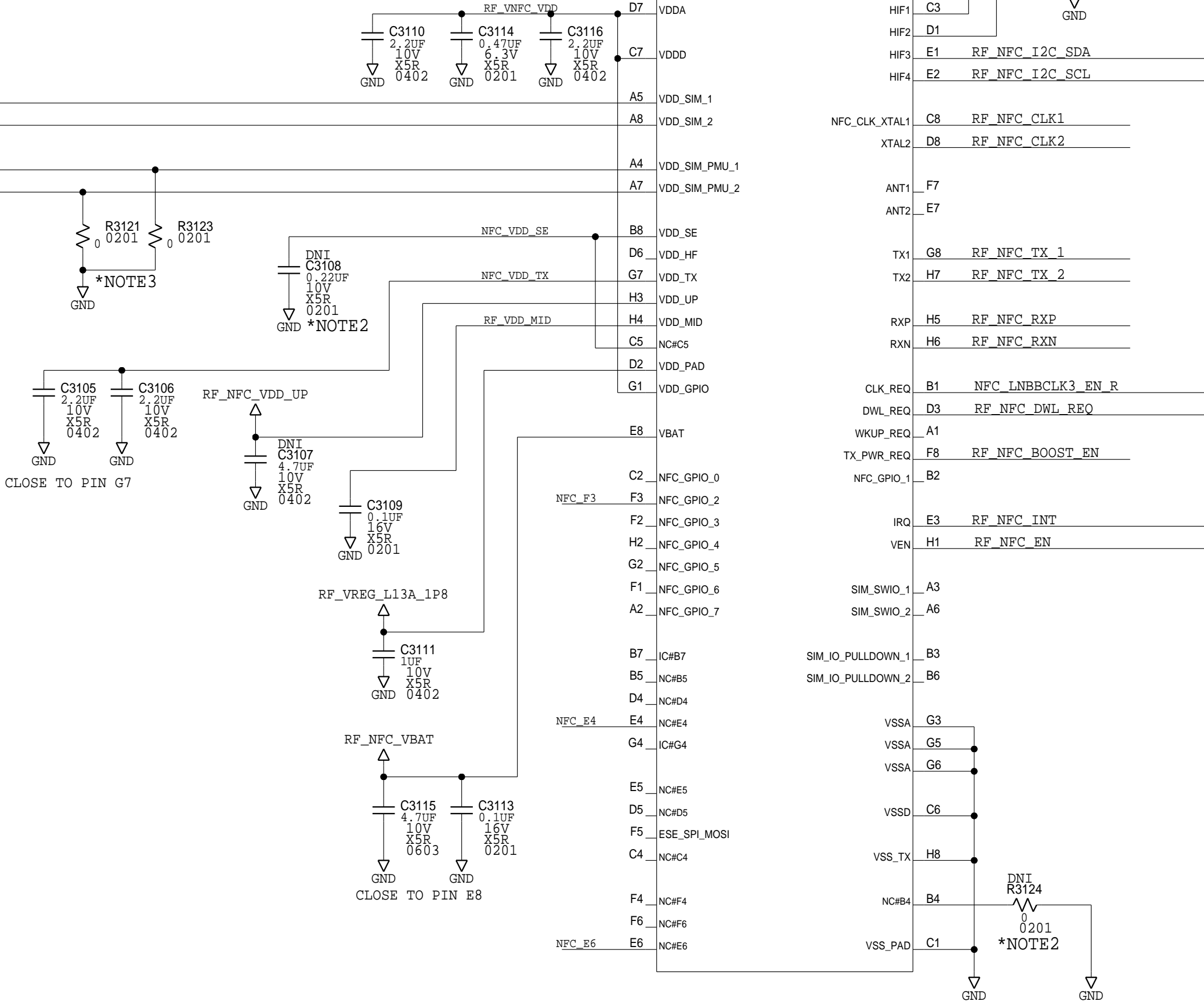
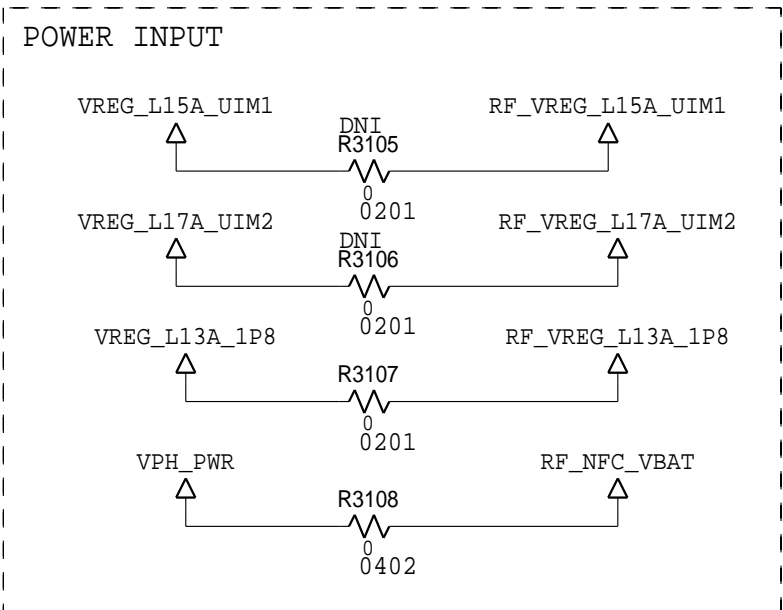
Table 12. I<sup>2</sup>C-bus interface addressing

HIF2	HIF1	I <sup>2</sup> C-bus address (R/W = 0, write)	I <sup>2</sup> C-bus address (R/W = 1, read)
0	0	0x50	0x51
0	1	0x52	0x53
1	0	0x54	0x55
1	1	0x56	0x57



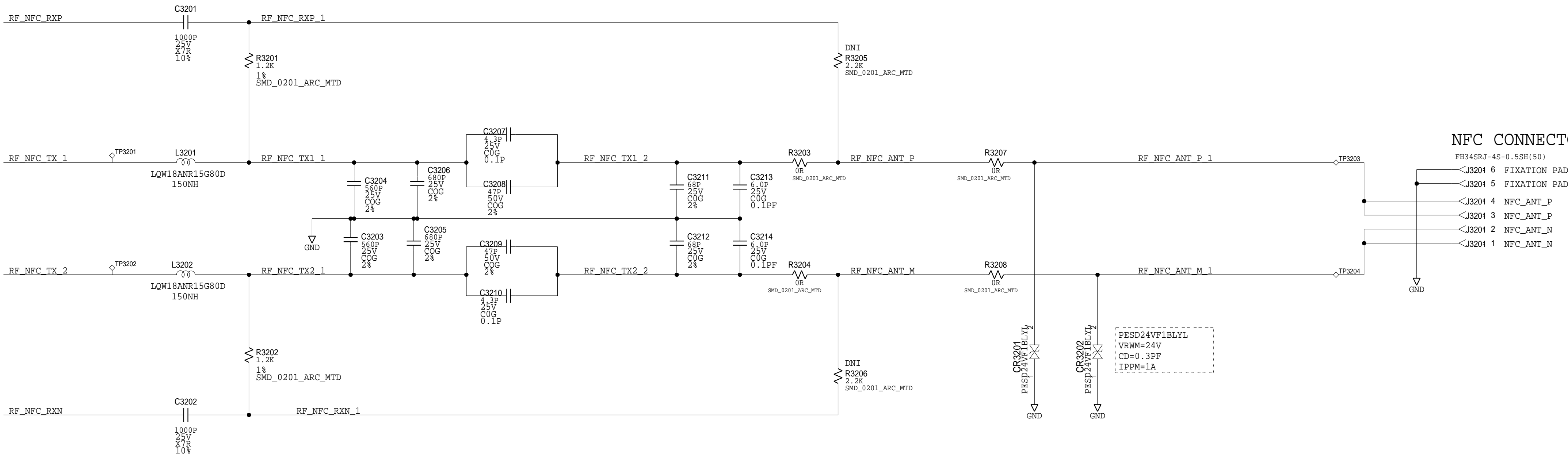
**\*NOTE3**

UICC NOT USED, MOUNT R3121, R3123  
UICC ARE USED, DNI R3121, R3123



NFC ANTENNA (M5 )

REVISIONS							
REV	ZONE	No.	DESCRIPTION			E.C.	BY
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NFC CONNECTOR


- PH34SRJ-4S-0.5SH(50)
- <J3201 6 FIXATION PAD
- <J3201 5 FIXATION PAD
- <J3201 4 NFC\_ANT\_P
- <J3201 3 NFC\_ANT\_P
- <J3201 2 NFC\_ANT\_N
- <J3201 1 NFC\_ANT\_N

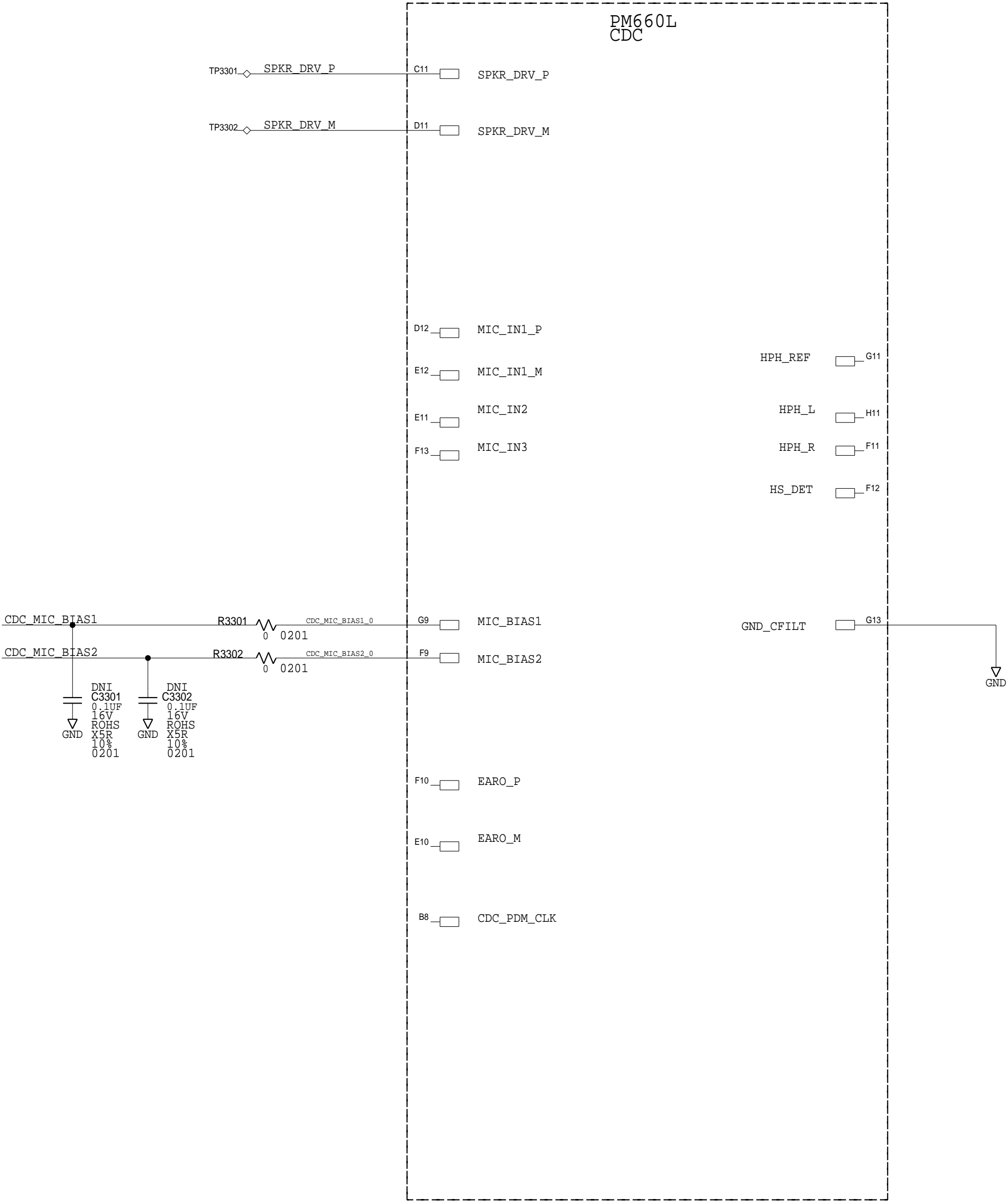
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SIZE	DWG. NO.	REV
D		V1D
Wed Apr 17 12:57:45 2019		SHEET 32 OF 45

PM660L CODEC

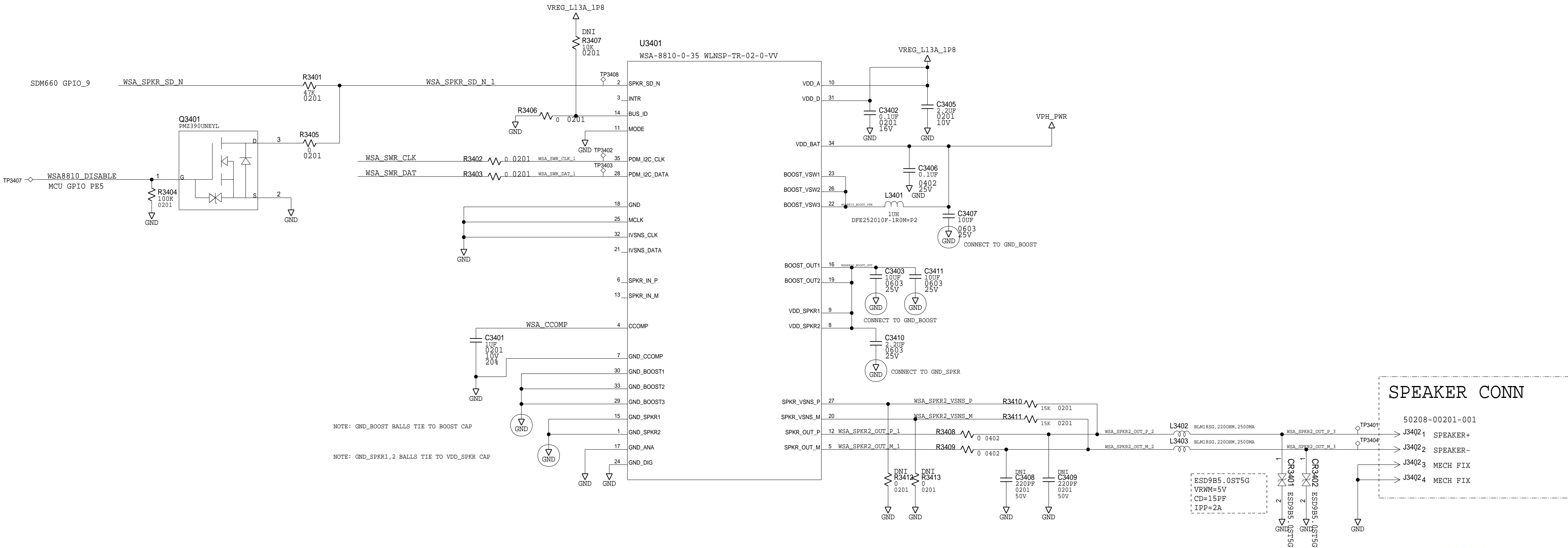
REVISIONS							
REV	ZONE		DESCRIPTION	E.C.	BY	APVD.	DATE
			SEE SHEET 1				



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Tue Apr 16 11:28:53 2019		SHEET 33 OF 45	

WSA8810 FOR SPEAKER(M9)

REVISIONS							
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							DATE



SPEAKER CONN

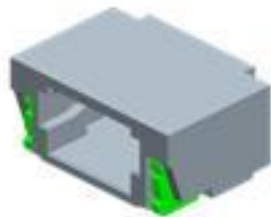
50208-00201-001

J3402\_1 SPEAKER+

J3402\_2 SPEAKER-

J3402\_3 MECH FIX

J3402\_4 MECH FIX



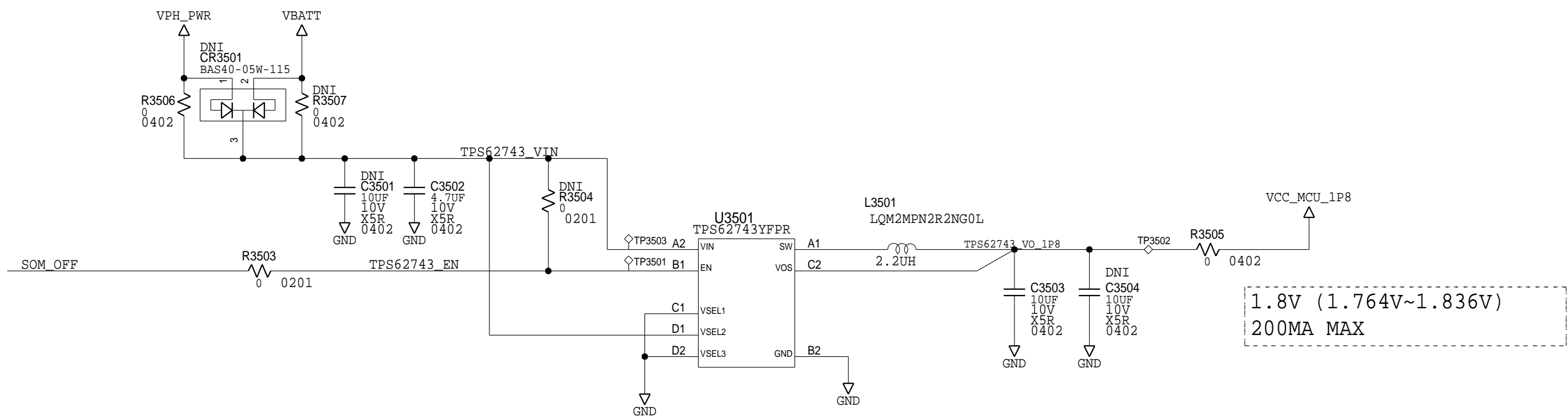
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D		V1D
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MCU 1P8 POWER

REVISIONS							
REV	ZONE	△No.	DESCRIPTION			E.C.	BY
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							DATE

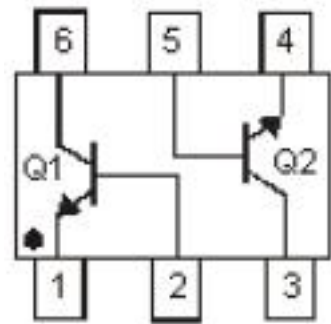
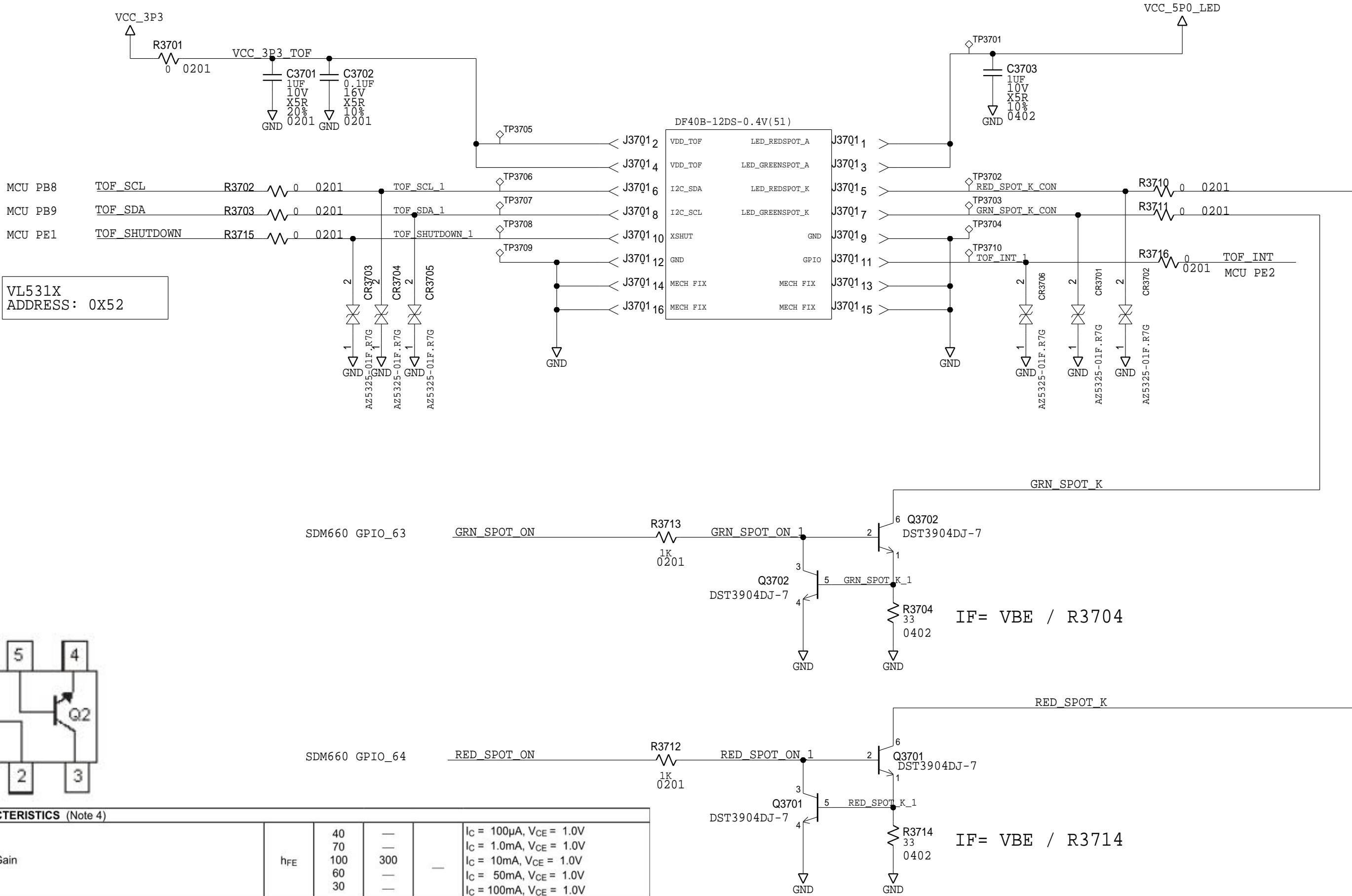
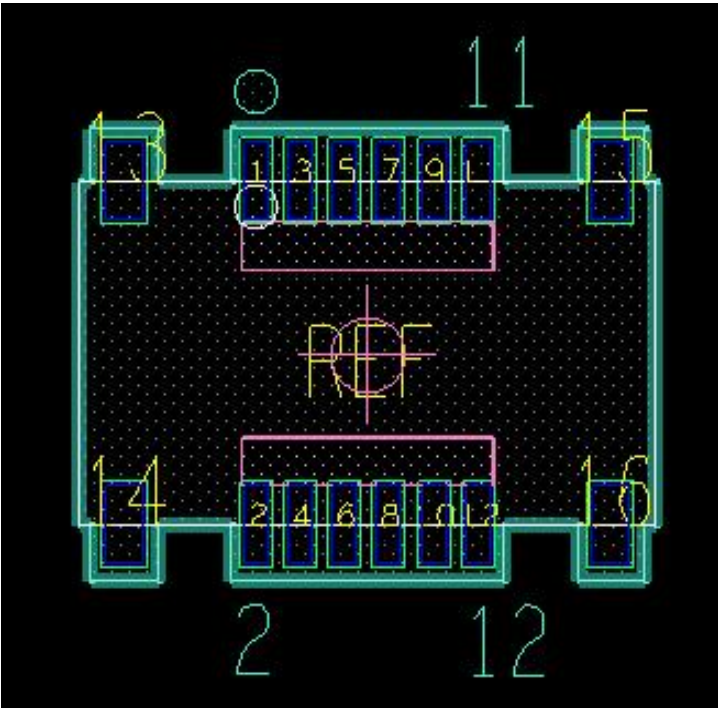
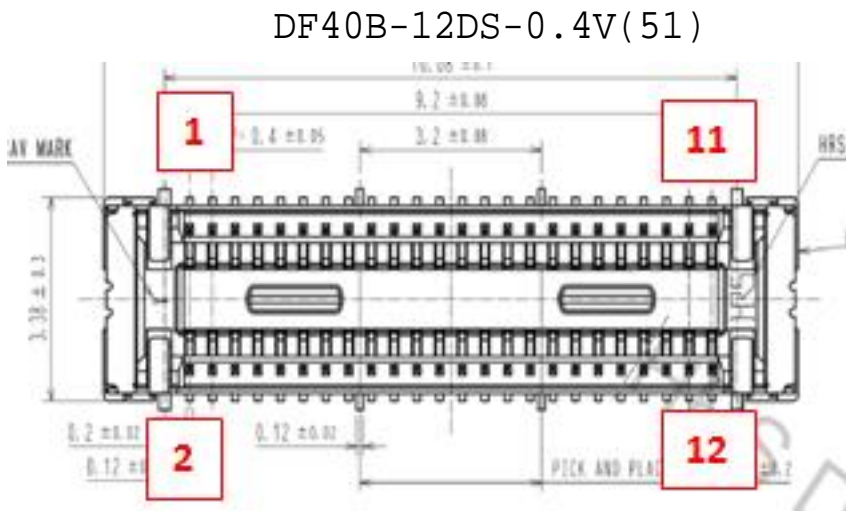


Output voltage setting V <sub>OUT</sub> [V]		VSEL setting		
TPS62743	TPS627431	VSEL3	VSEL2	VSEL1
1.2	1.3	0	0	0
1.5	1.4	0	0	1
1.8	1.6	0	1	0
2.1	1.7	0	1	1
2.5	1.9	1	0	0
2.8	2.0	1	0	1
3.0	2.9	1	1	0
3.3	3.1	1	1	1





TOF & SPOT LED(M19)



ON CHARACTERISTICS (Note 4)					
DC Current Gain	$h_{FE}$	40	—	—	$I_C = 100\mu A, V_{CE} = 1.0V$
		70	—	—	$I_C = 1.0mA, V_{CE} = 1.0V$
		100	300	—	$I_C = 10mA, V_{CE} = 1.0V$
		60	—	—	$I_C = 50mA, V_{CE} = 1.0V$
		30	—	—	$I_C = 100mA, V_{CE} = 1.0V$
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	—	0.20	V	$I_C = 10mA, I_B = 1.0mA$
		—	0.30	V	$I_C = 50mA, I_B = 5.0mA$
Base-Emitter Saturation Voltage	$V_{BE(SAT)}$	0.65	0.85	V	$I_C = 10mA, I_B = 1.0mA$
		—	0.95	V	$I_C = 50mA, I_B = 5.0mA$

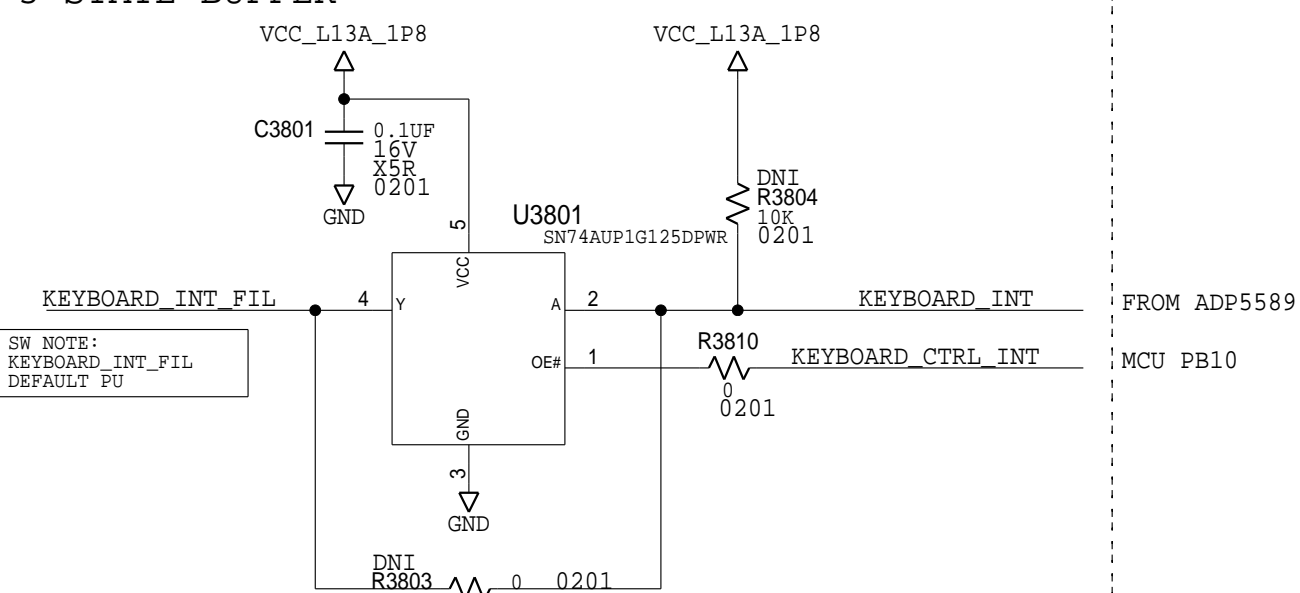


## AUX BOARD CONNECTOR (M15)

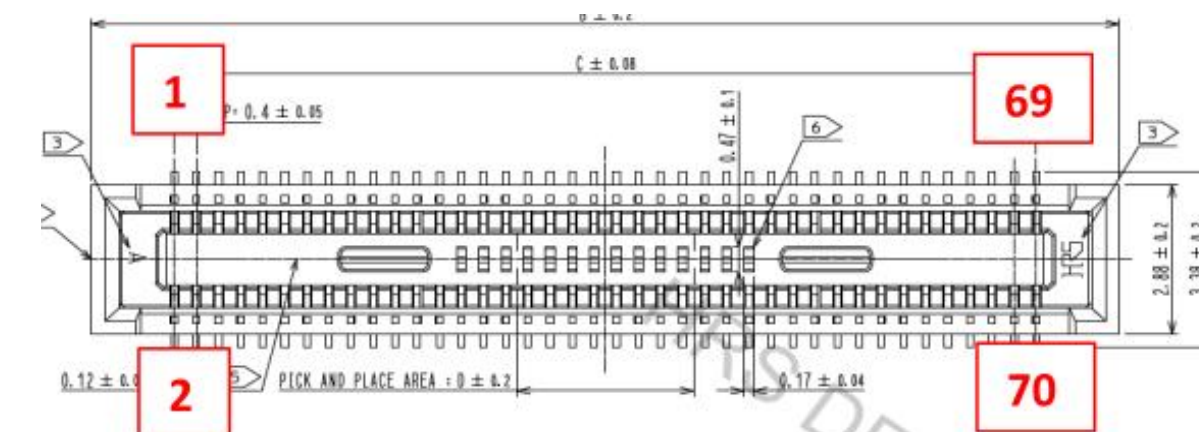
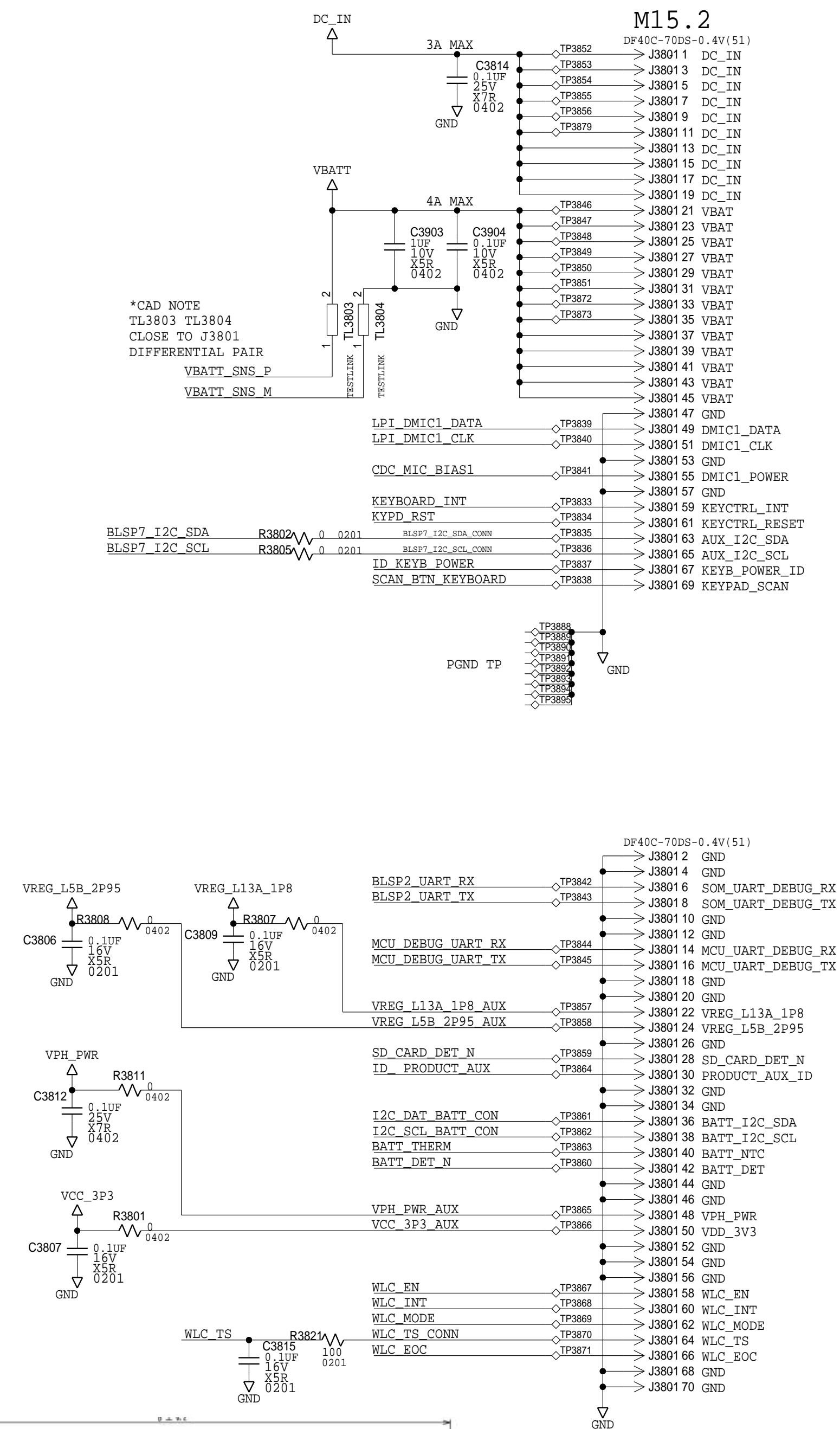
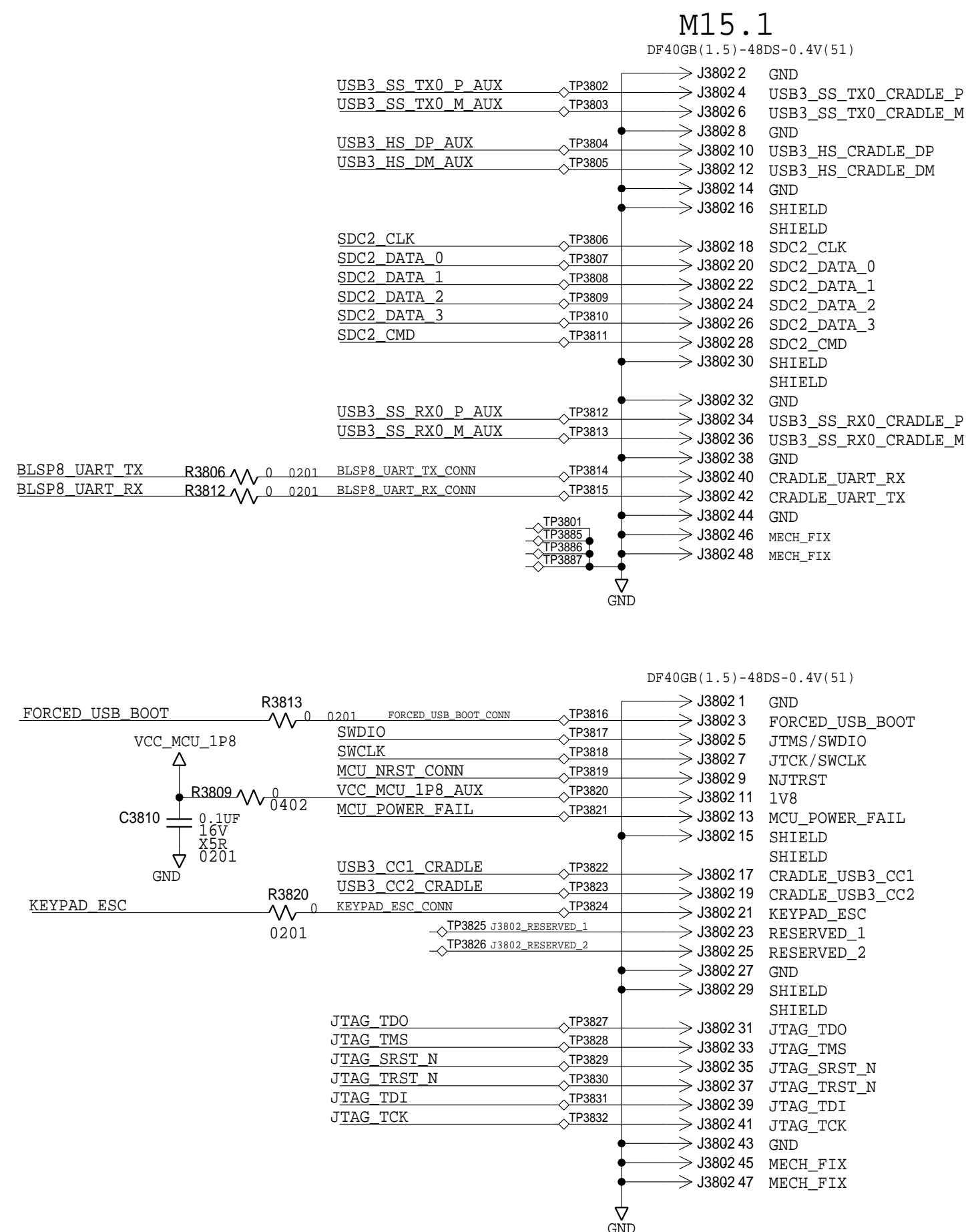
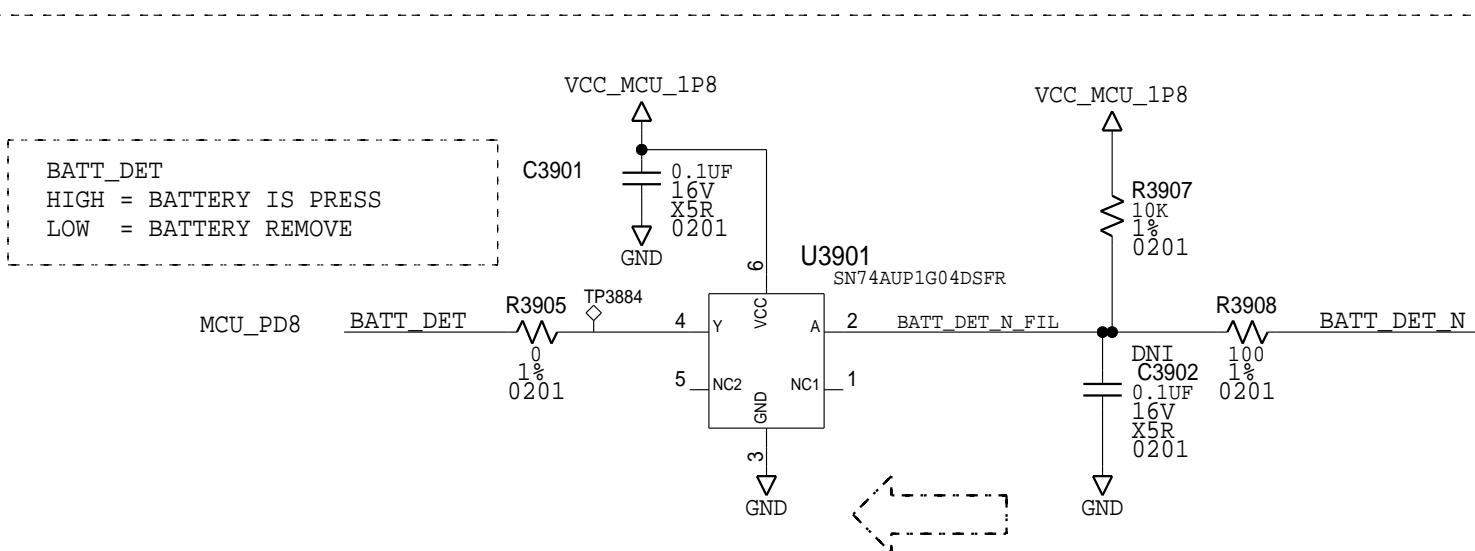
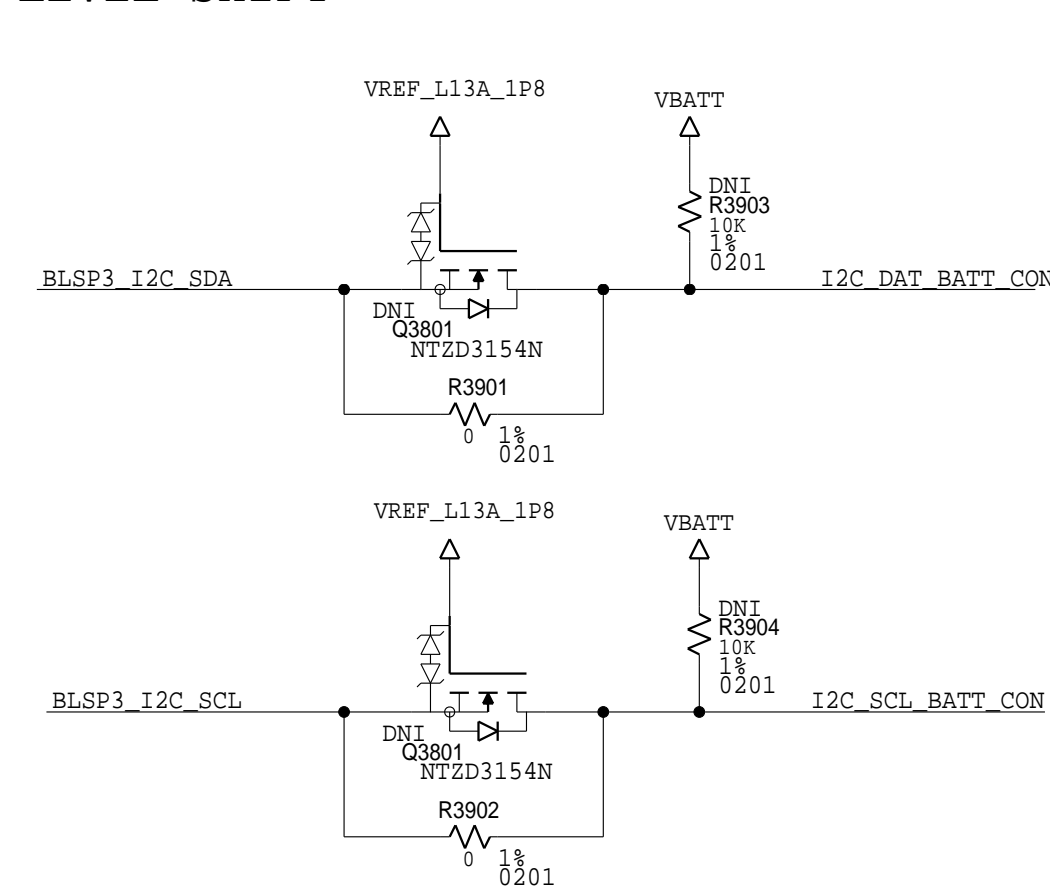
**SN74AUP1G125 Table 1. Function Table**

INPUTS		OUTPUT
OE	A	Y
L	H	H
L	L	L
H	X	Hi-Z

### 3-STATE BUFFER



# LEVEL SHIFT

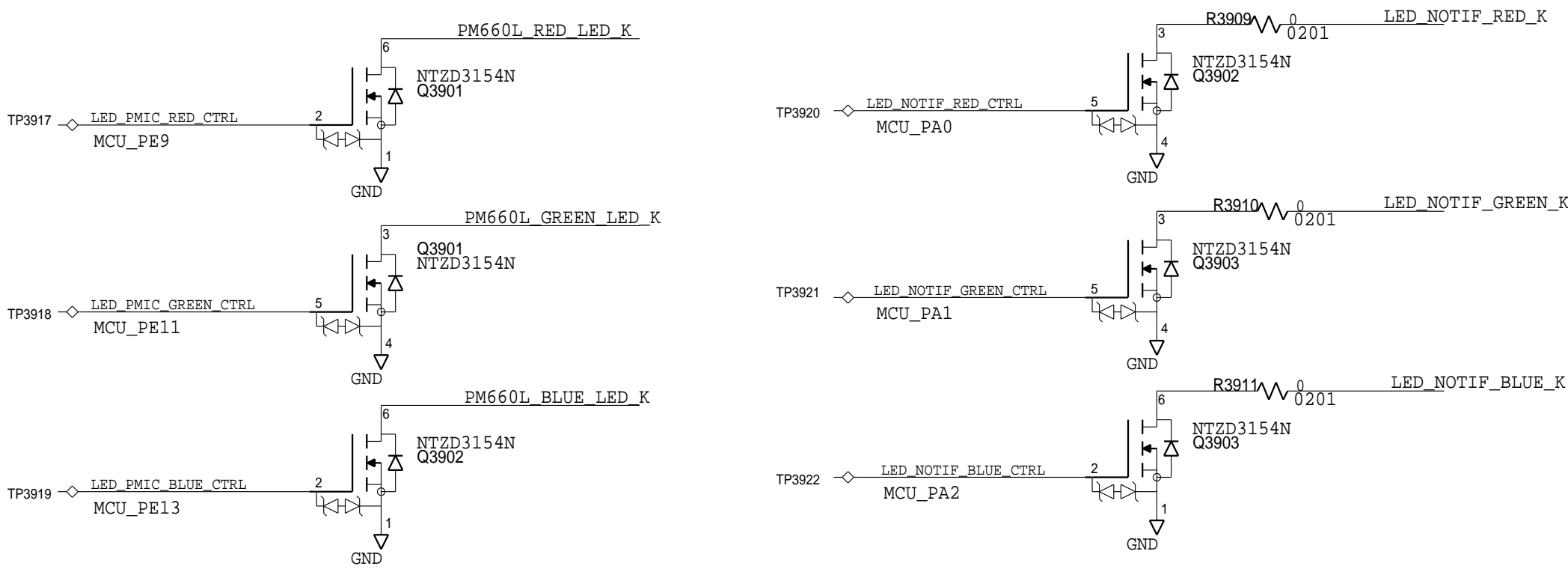


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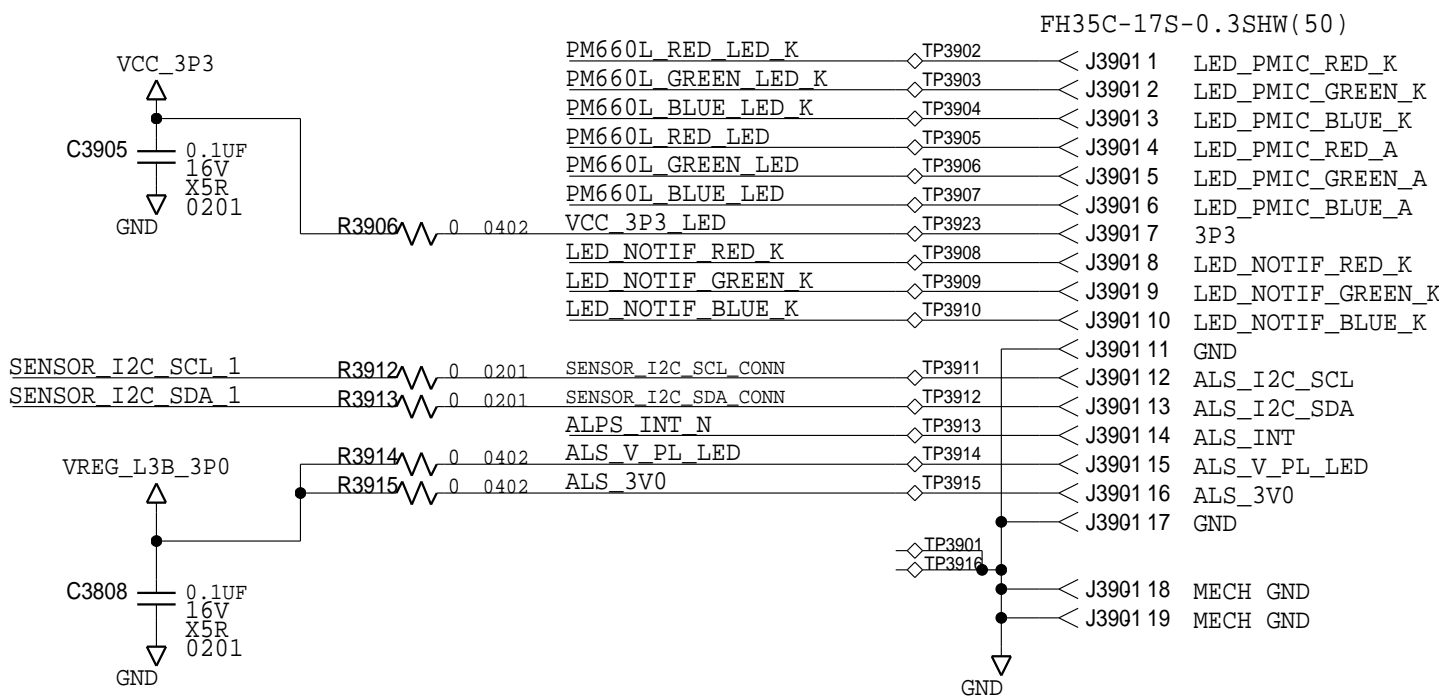
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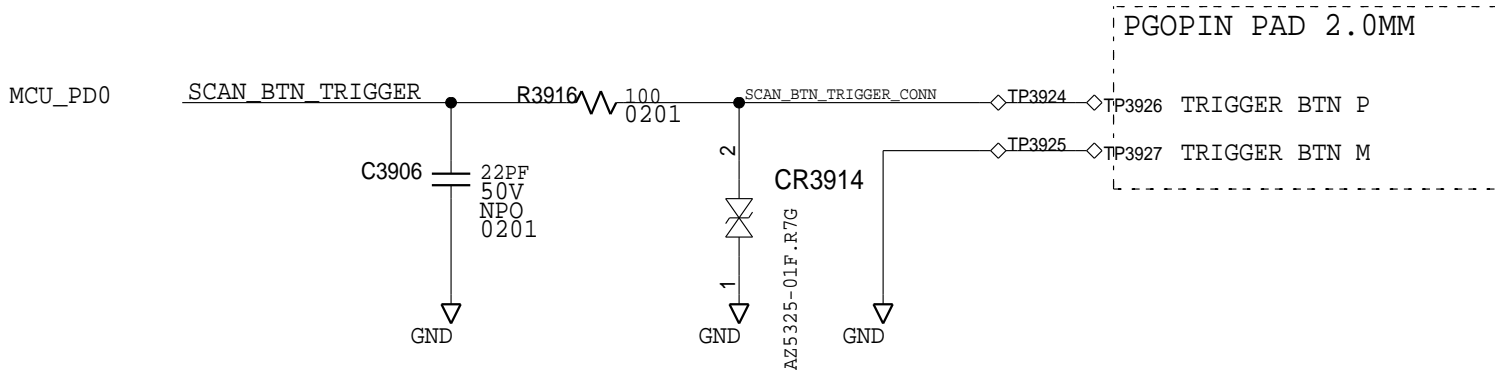
ALS & LED (M20)



PM660L_RED_LED_K	CR3902	2	1	A25325-01F.R7G
PM660L_GREEN_LED_K	CR3903	2	1	A25325-01F.R7G
PM660L_BLUE_LED_K	CR3904	2	1	A25325-01F.R7G
PM660L_RED_LED	CR3905	2	1	A25325-01F.R7G
PM660L_GREEN_LED	CR3906	2	1	A25325-01F.R7G
PM660L_BLUE_LED	CR3907	2	1	A25325-01F.R7G
LED_NOTIF_RED_K	CR3908	2	1	A25325-01F.R7G
LED_NOTIF_GREEN_K	CR3909	2	1	A25325-01F.R7G
LED_NOTIF_BLUE_K	CR3910	2	1	A25325-01F.R7G
SENSOR_I2C_SCL_CONN	CR3911	2	1	A25325-01F.R7G
SENSOR_I2C_SDA_CONN	CR3912	2	1	A25325-01F.R7G
ALPS_INT_N	CR3913	2	1	A25325-01F.R7G



SX5 SCAN TRIGGER(M16)



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Thu May 02 20:05:02 2019		SHEET	39 OF 45

RESERVE

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REV	ZONE	△No.	DESCRIPTION			E.C.	BY
			SEE SHEET 1				APVD.
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D						V1D
Mon Feb 25 20:58:31 2019					SHEET	40 OF 45



RESERVE

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REV	ZONE	△No.	DESCRIPTION			E.C.	BY
			SEE SHEET 1				APVD.
							DATE

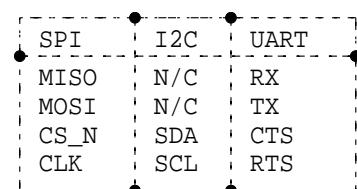
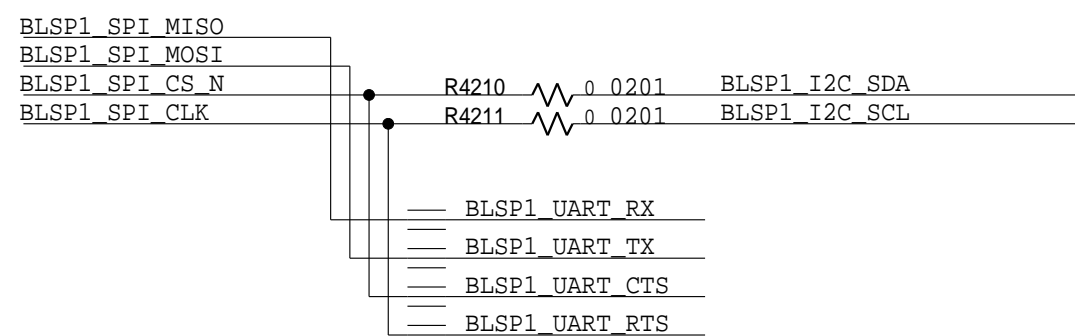
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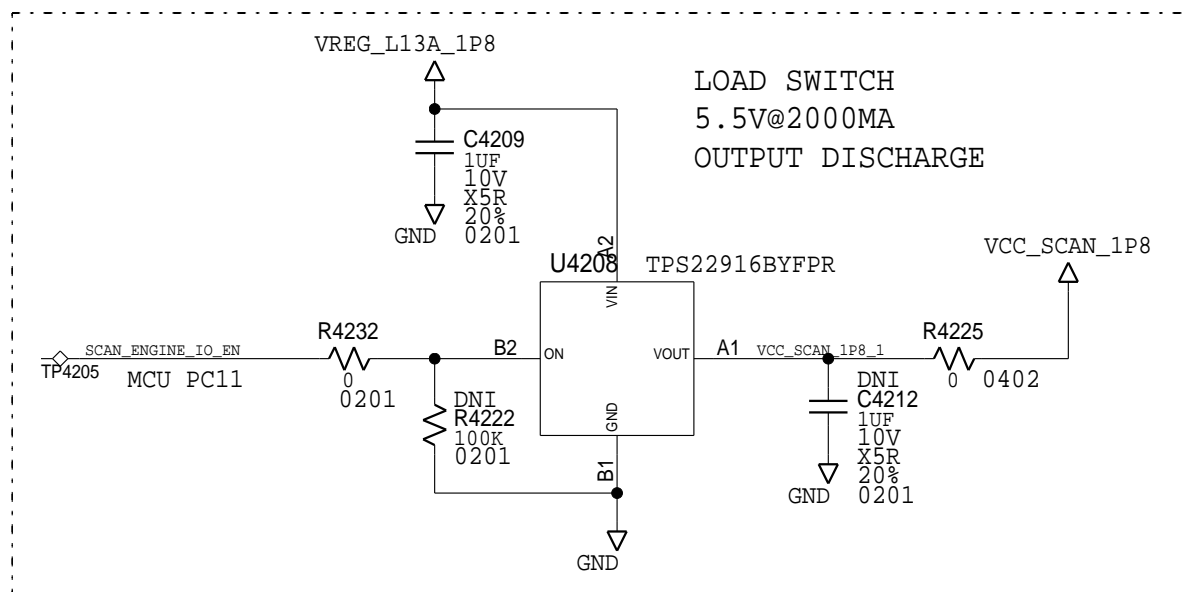
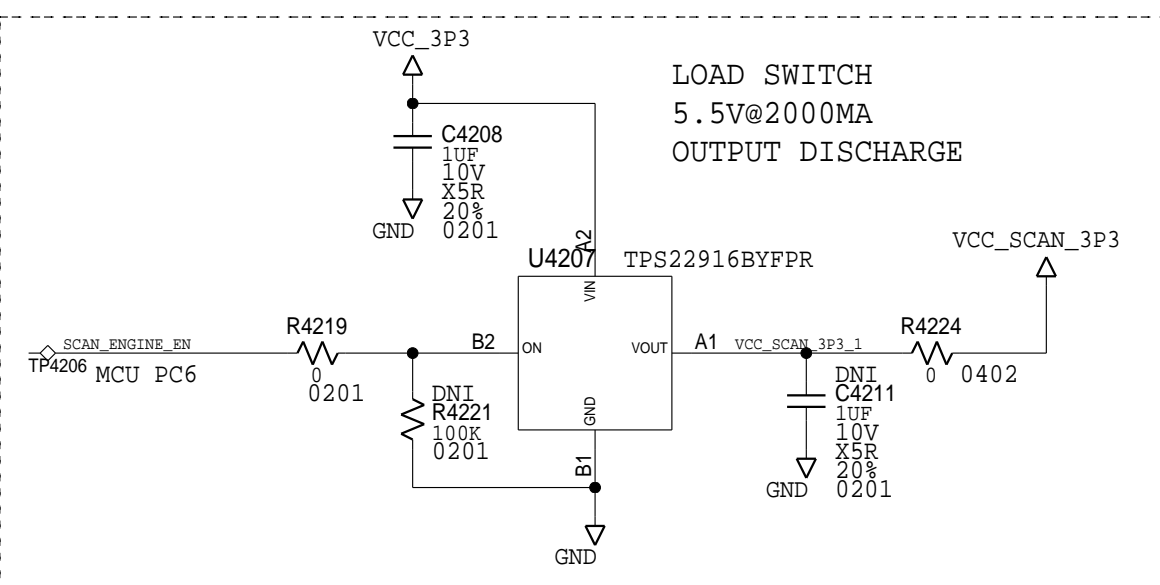
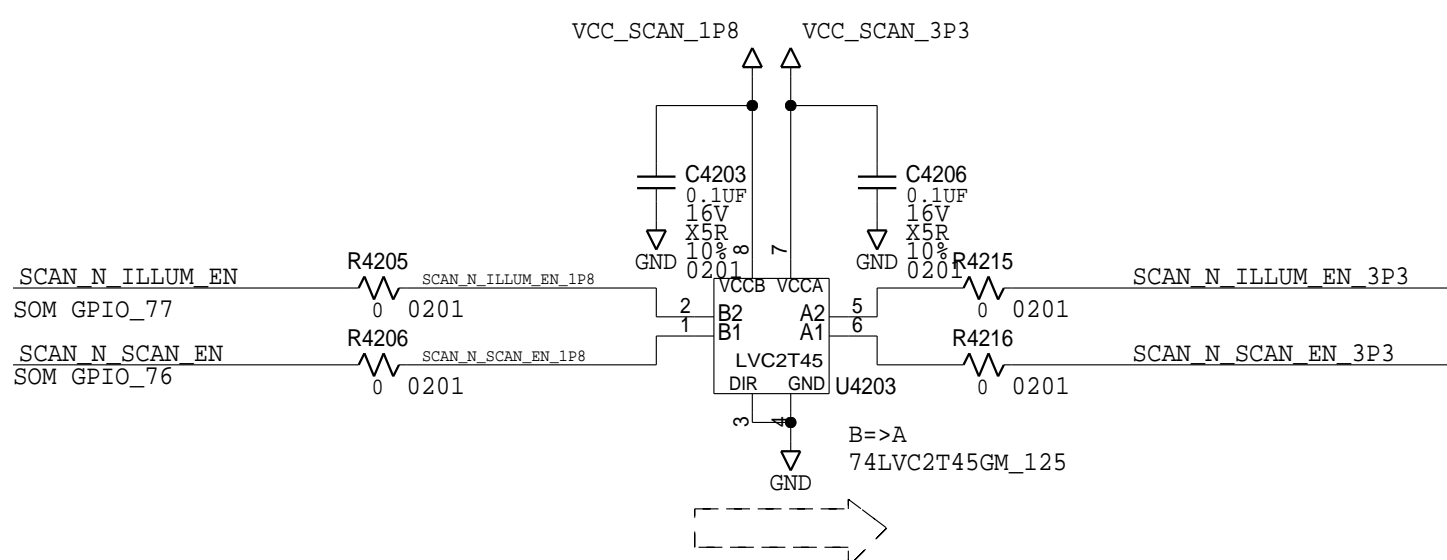
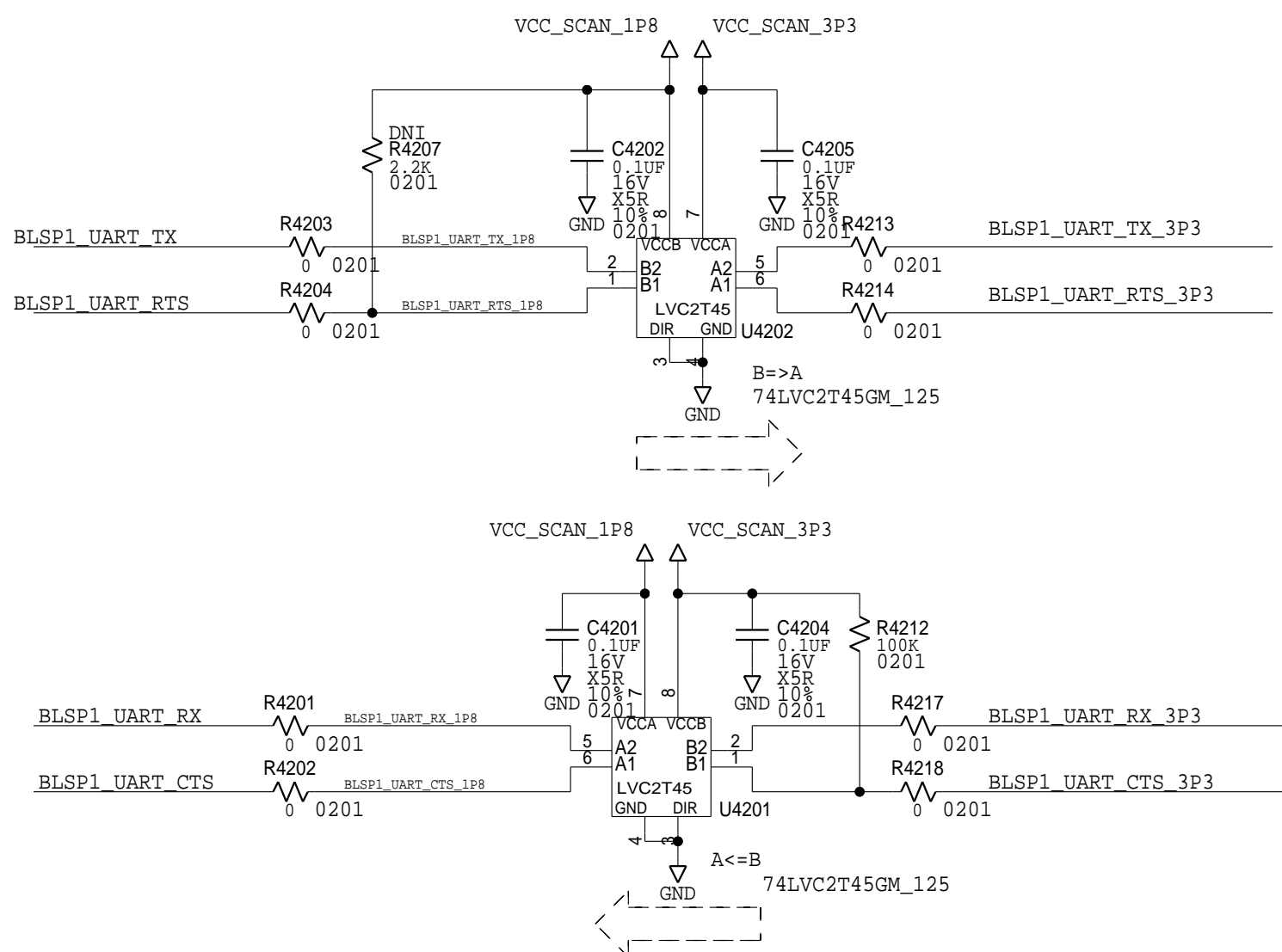
SIZE	DWG. NO.					REV
D						V1D
Mon Mar 18 10:43:35 2019					SHEET	41 OF 45

# SCANNER& FLASH& DMIC(M10)

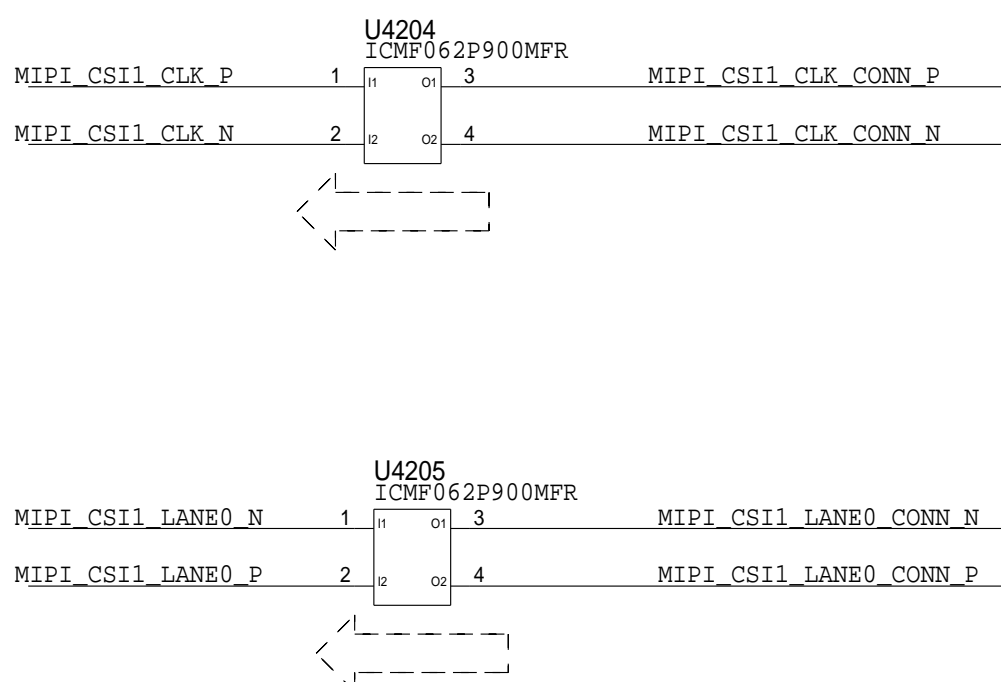
SPI, I2C, UART



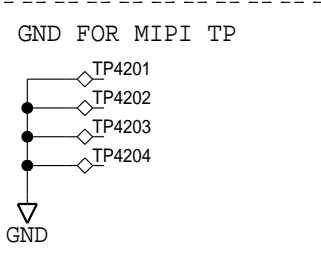
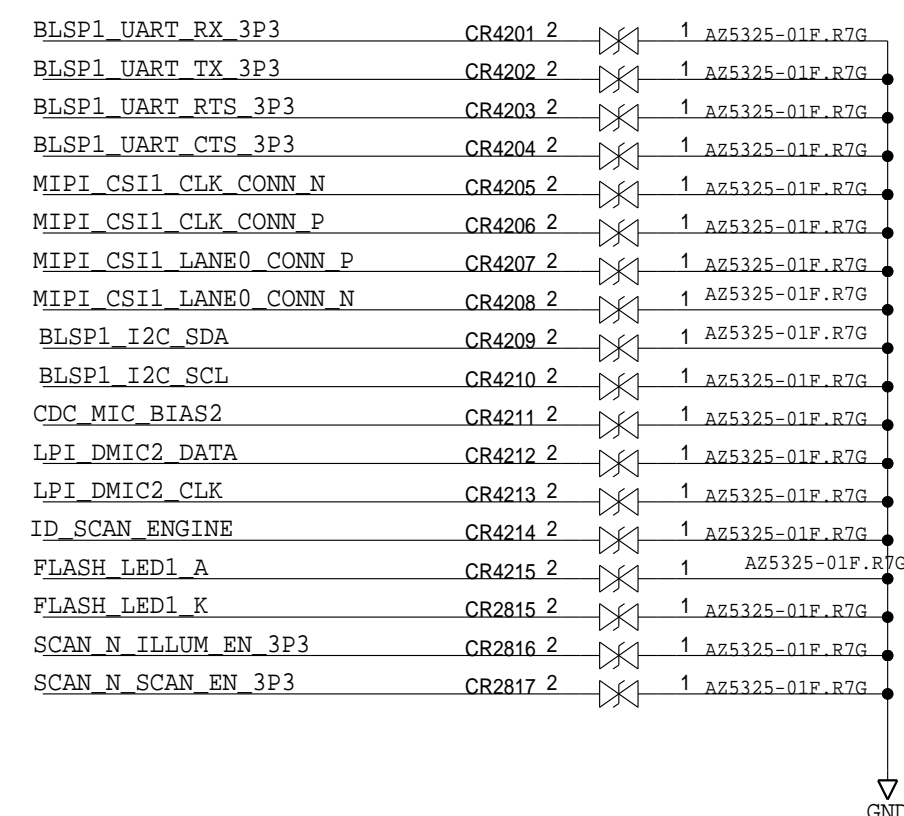
## DE1011 LEVEL SHIFT



## MIPI FILTER



## ESD DIODE



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D		V1D
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REVISIONS							
REV	ZONE	No.	DESCRIPTION			E.C.	BY
			SEE SHEET 1				APVD.
							DATE

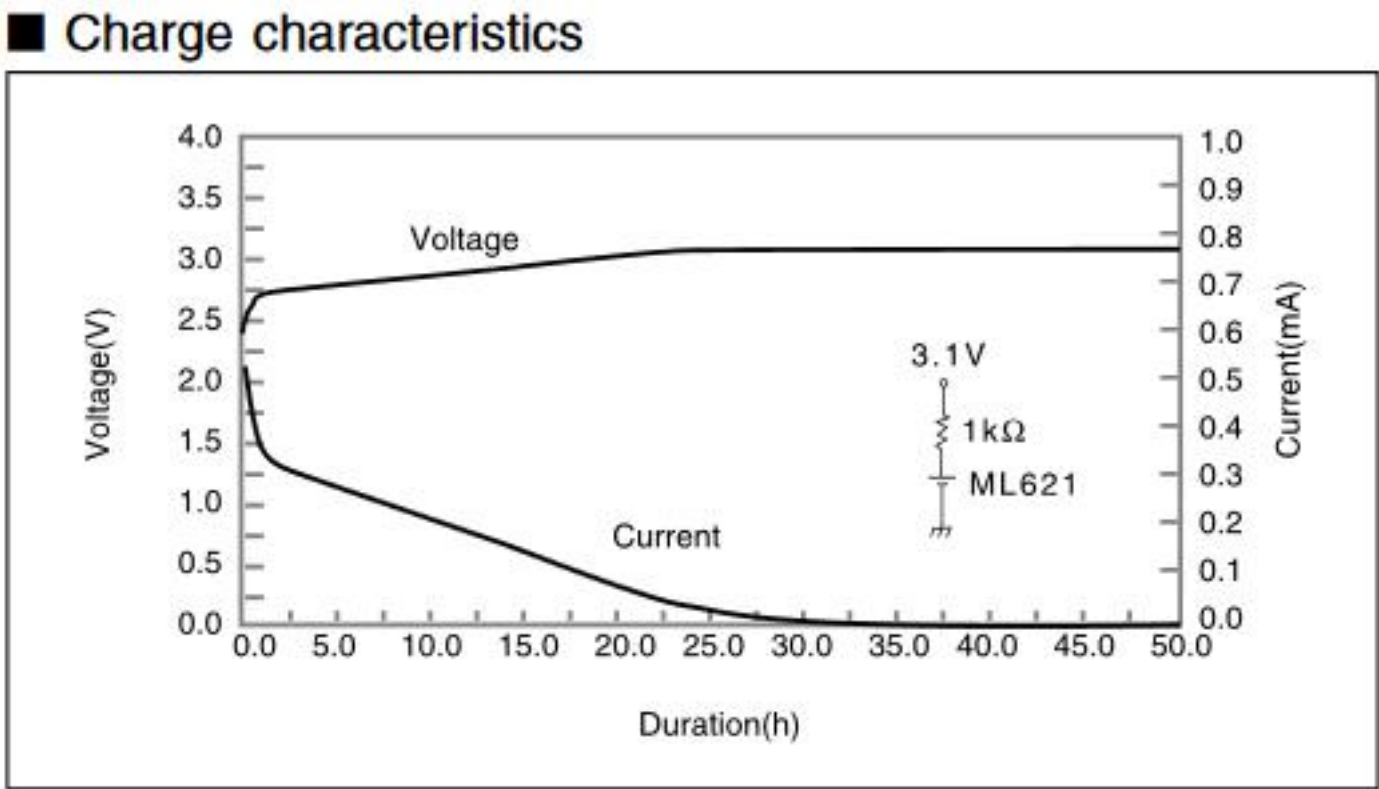
# RTC BATTERY CONN

PANASONIC ML-621S/DN



■ Specification

Nominal voltage(V)	3
Nominal capacity(mAh)	5
Continuous drain(mA)	0.01
Operating temperature(°C)	-20 to +60

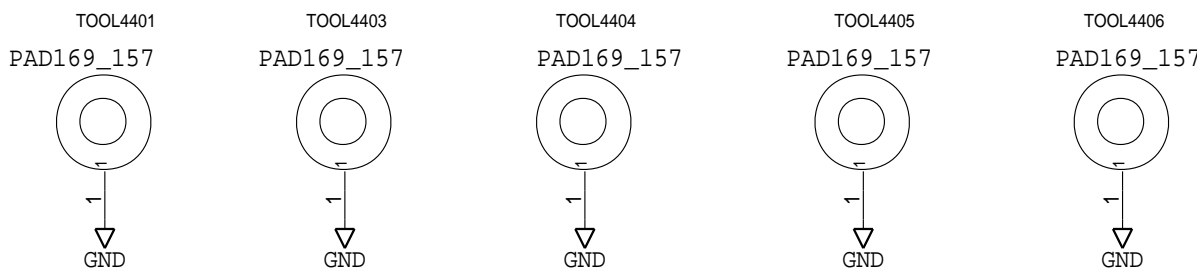


WHEN THE MAIN BATTERY IS CONNECTED TO THE PHONE WHILE A RESIDUAL VOLTAGE IS ON VCOIN, PHONES MAY NOT POWER ON.  
THIS CAN OCCUR IN THE FACTORY OR WHEN A NEND USER RECONNECTS A BATTERY TO THE PHONE  
DETAIL REF TO QUALCOMM KBA-170615054152

DRILLS

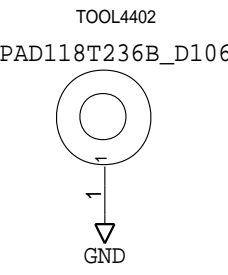
EE NOTE: FOOTPRINT TO BE UPDATED

DRILL B

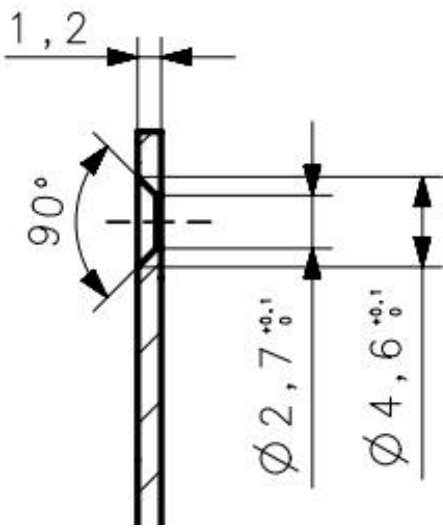


PTH DRILL=4MM  
TOP PAD = BOTTOM PAD = 4MM

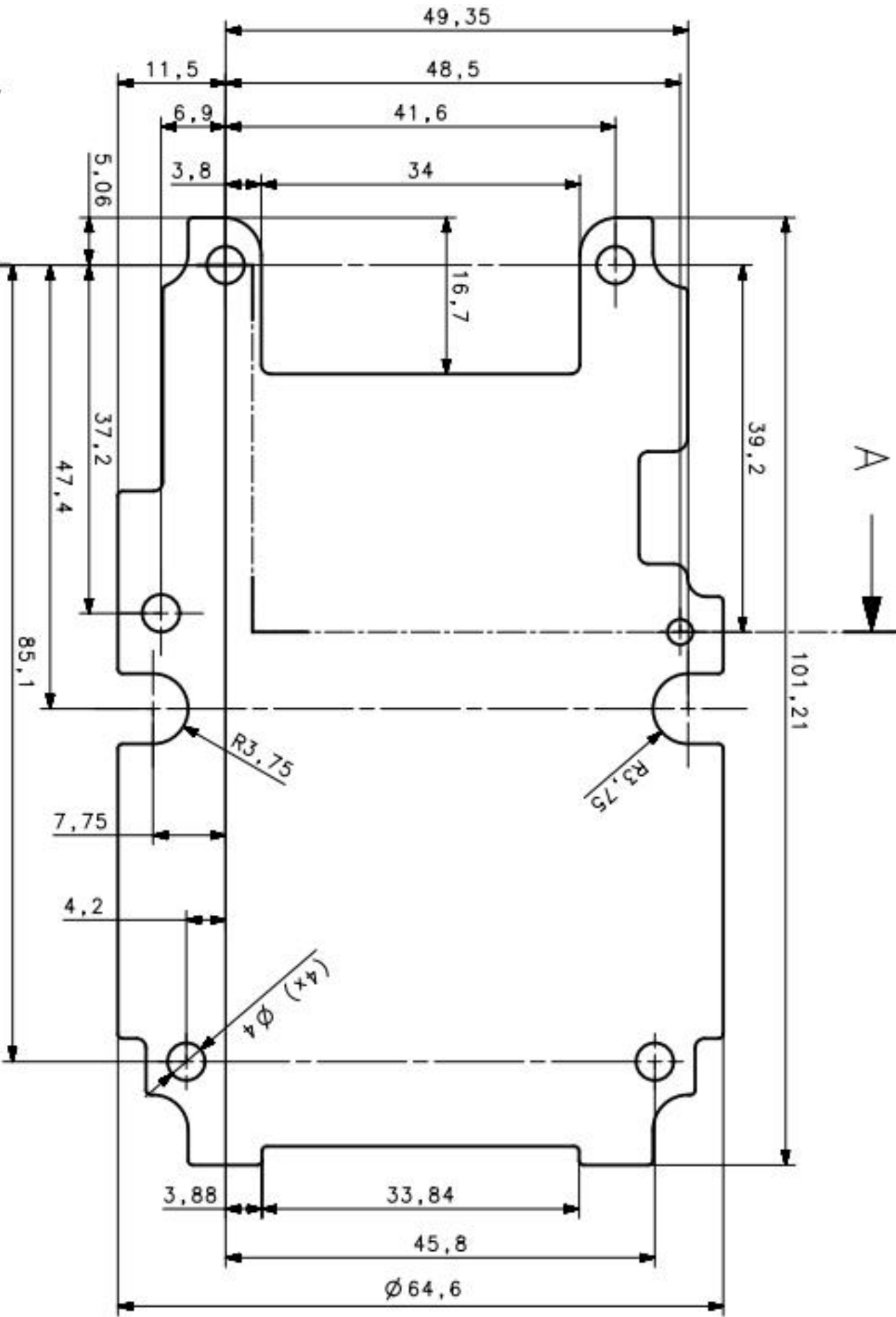
COUNTERSINK DRILL A



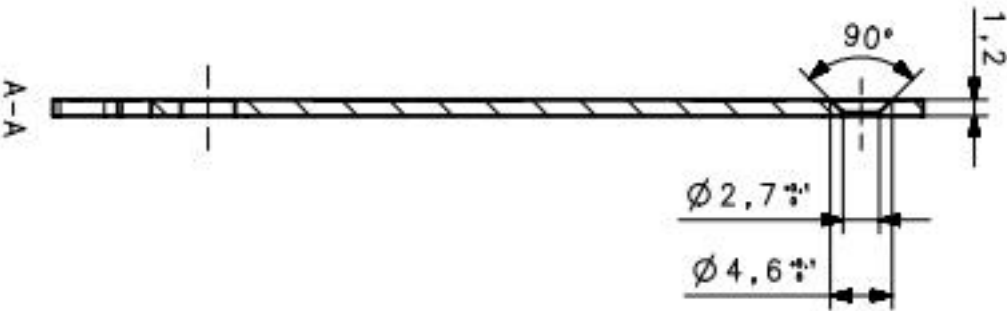
PTH DRILL= 2.7MM  
BOTTOM COUNTERSINK DRILL 4.6MM 90°X  
TOP PAD=2.7MM, BOTTOM PAD=6.0MM



TOP VIEW



BOTTOM PCB SIDE



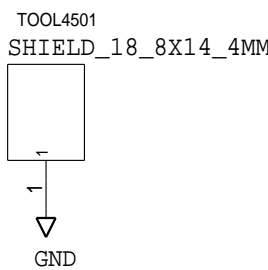
TOP PCB SIDE (DISPLAY)

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			SEE SHEET 1				

# SHIELDING CAN

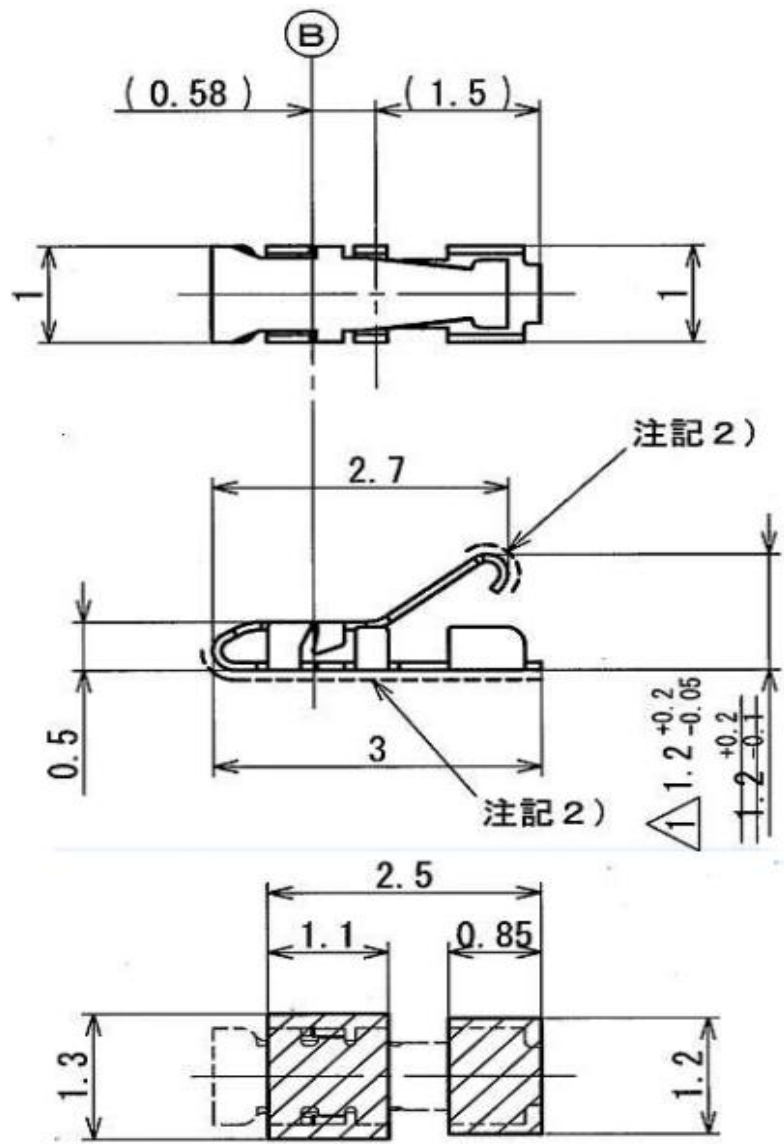
## NFC SHIELDING



NFC SHIELD FRAME FOOTPRINT  
DIMENSION=18.8X14.4X2.25MM

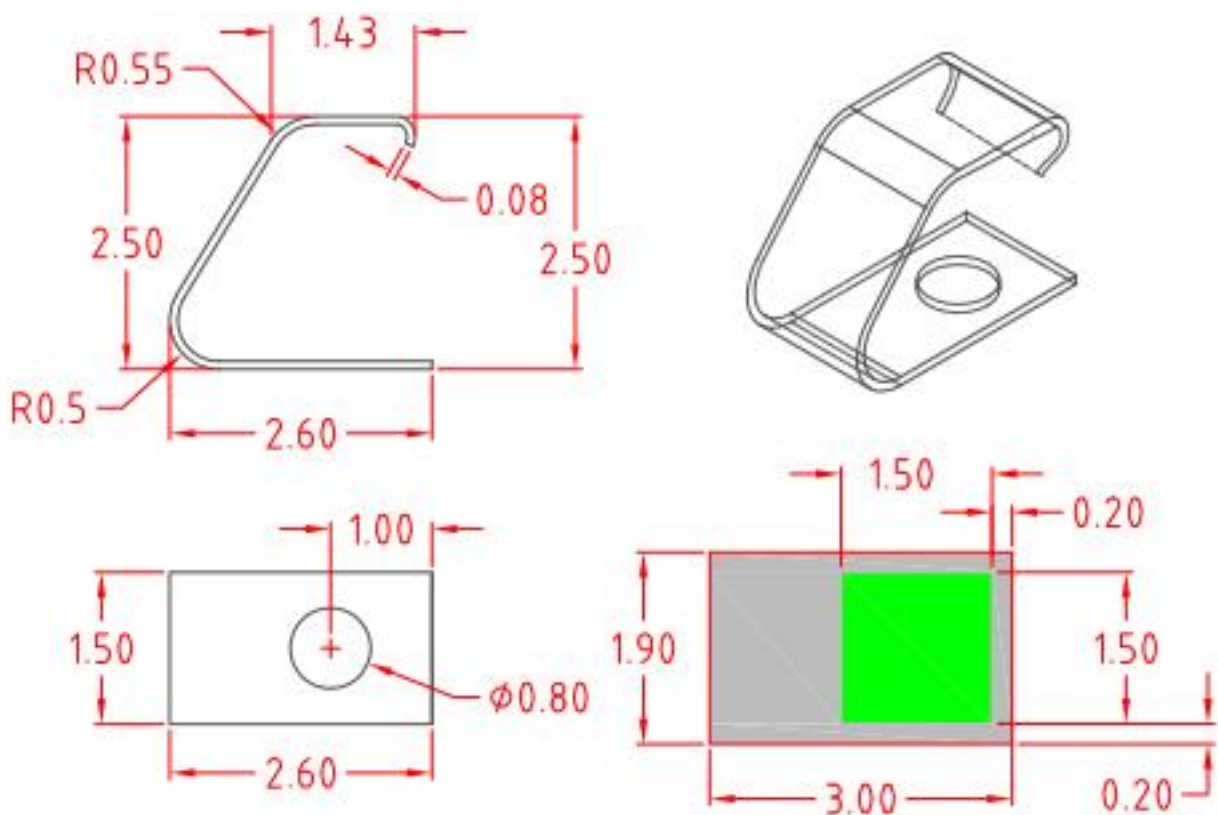
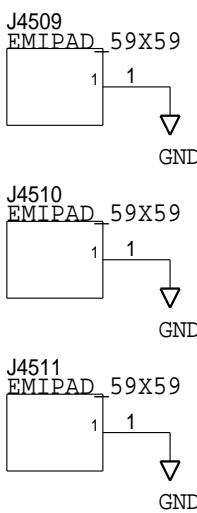
# GND SPRING

## TOP GND SRPING



推奨パッド寸法  
RECOMMENDED PAD DIMENSION

## BOTTOM GND SRPING



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